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MARLOW INDUSTRIES INC GARLAND TEX
HIGH EFFICIENCY, LOW POWER THERMOELECTRIC COOLERS. (U)
1979

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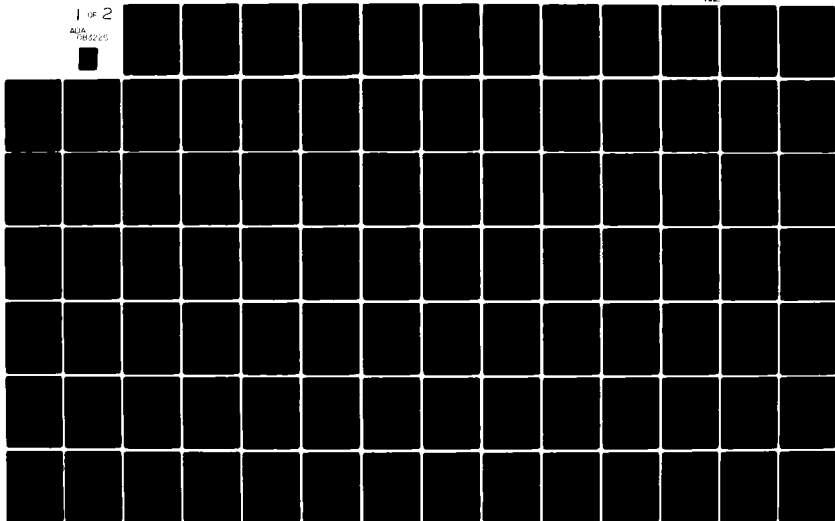
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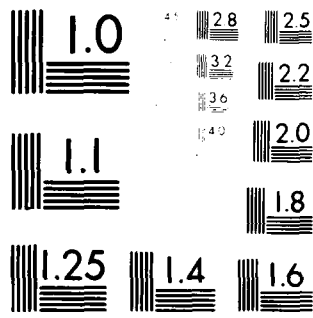
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HIGH EFFICIENCY,
LOW POWER
THERMOELECTRIC COOLERS

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FINAL REPORT
CONTRACT NO. DAAK79-78-C0016

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HIGH EFFICIENCY,
LOW POWER
THERMOELECTRIC COOLERS •

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FINAL REPORT
CONTRACT NO. DAAK78-78-C0016 ^{NEW}
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	<u>PAGE</u>
I. ABSTRACT	1
II. PURPOSE	2
III. NARRATIVE	3
A. THERMOELECTRIC COOLER DESIGN, FABRICATION AND TESTING	
1. STRESS TESTING OF GFE COOLER	
2. COOLER DESIGN	
3. COOLER FABRICATION	
4. COOLER TESTING	
B. THERMOELECTRIC MATERIAL DEVELOPMENT	
1. INTRODUCTION	
2. PROCESS	
IV. DISCUSSION OF RESULTS	46
A. THERMOELECTRIC COOLERS	
B. THERMOELECTRIC MATERIAL	
V. CONCLUSIONS	57
VI. RECOMMENDATIONS FOR FURTHER DEVELOPMENT	60

APPENDIX

Accession For	
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Project	
Approved	
Initials	
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LIST OF FIGURES

	<u>PAGE</u>
1. Average of n- and p-type commercially available TE material parameters	7
2. SP 1102 Cooler Design Curves	10
3. SP 1103 Cooler Design Curves	11
4. SP 1104 Cooler Design Curves	12
5. P-type material parameters (P298)	14
6. N-type material parameters (N295)	15
7. SP 1102 Cooler Predicted Performance Curves	17
8. SP 1103 Cooler Predicted Performance Curves	18
9. SP 1104 Cooler Predicted Performance Curves	19
10. Performance Curves for 3 Types	49
11. Performance Curves for SP 1102-2	52
12. Performance Curves for SP 1103-4	53
13. Performance Curves for SP 1104-4	54
14. Average Resistivity vs. Dopant Level for Eight n-type ingots	58

LIST OF TABLES

	<u>PAGE</u>
1. Shock and Vibration Levels	4
2. Measurements Before and After Shock and Vibration Stress Testing	5
3. Cooler Specification	6
4. Cooler Specification, Design and Predicted Performance	16
5. Initial Test Data	22
6. Post test data after shock and vibration	24
7. Post 85°C bake data	25
8. Post -60°C storage test	26
9. Cold Stress Test	27
10. COP Test data	28
11. COP Calculations, SP 1102	29
12. COP Calculations, SP 1103	30
13. COP Calculations, SP 1104	31
14. Cooler Characteristics with heat load, SP 1102 and SP 1103	33
15. Cooler Characteristics with heat load, SP 1104	34
16. Cooler performance with radiation shield	35
17. Final cooler test data	36
18. MI 1060 material combinations	41
19. Comparison of material analysis using Electron Microprobe	43
20. P-type material measurement (from local laboratory)	44
21. N-type material measurement (from local laboratory)	45
22. COP, nominal heat load	48
23. Comparison of cooler calculations and measured performance	51

I. ABSTRACT

This report describes the work performed on a 15 month development program. The purpose of this program was the development of a high performance, multi-stage thermoelectric (TE) cooler which would operate satisfactorily under extreme military environments. Five coolers each of three types (various heat loads), were designed and fabricated. Detailed environmental and performance tests were performed on these coolers. The electrical tests included measurement of COP/stage and performance under various heat loads on each type of cooler. The effect of adding radiation shielding to each type was also determined. All of the coolers performed satisfactorily after environmental and performance testing. Performance data, predicted from design calculations and computerized material parameter measurements, showed excellent correlation with measured test data.

A TE material development and evaluation program was conducted in conjunction with the cooler design and fabrication effort. P-type TE material was produced which was comparable to that commercially available. Advanced computerized TE material evaluation techniques developed by Marlow Industries were used to evaluate α , ρ , κ , and Z for a particular lot of material toward the end of the program.

α , ρ , κ , and Z
alpha, rho, kappa, Z

II. PURPOSE

The purpose of this program was the development of a family of ruggedized, high efficiency TE coolers. These coolers were to have low power inputs and various heat load capacities to meet different requirements for the second generation FLIRS. These objectives were to be achieved through improved design techniques, better fabrication methods and/or improved low temperature TE materials.

III. NARRATIVE

A. Cooler Design, Fabrication and Testing

1. Stress Testing of GFE Cooler

In the early phases of the development program, a GFE cooler manufactured in 1975 by Marlow Industries for the Night Vision Laboratory was subjected to a shock and vibration testing sequence. The purpose of these series of tests was to evaluate the stress limitations of the present cooler design and fabrication process. Results obtained were to be used in determining what changes in design and construction might be needed to improve the cooler mechanical environmental performance.

Six GFE coolers were received for use in the test program. These units were performance tested to establish reference data prior to environmental testing. One of the units, S/N IA-018 was found to be open. Test data for the other five units is shown in Table 1 of the Appendix.

One cooler, S/N IA-034, was selected at random from the GFE units and subjected to the following series of stress tests:

a. The unit was vibration stressed per MIL-STD-810C, method 514.2, over a frequency range from 10 hertz to 3500 hertz. A resonant search sweep was made over the frequency range with each sweep having 20 minutes duration. Nine sweeps were made in the horizontal axis for a total stress period of six hours. During the testing period, an AC milliohmeter was used to monitor an intermittent or permanent change in the cooler resistance. No resonances or changes in the cooler characteristics were noted during the testing and no damage to the cooler was found after test completion.

The cooler was then restressed in the same manner with an applied force of 50 g's for two hours and, again no change in cooler characteristics or physical damage was noted.

b. The cooler was then shock-tested per MIL-STD-883A, method 2002.1, test condition A (Half sine wave 500 g's, 1 ms duration pulse) with the exception that the number of impacts was six in each of 3 mutually perpendicular axes for a total of 36 impacts. An AC milliohmmeter was used to monitor the cooler resistance during the shock testing. No variation in the cooler resistance or physical damage to the cooler was noted.

The cooler was then shock-tested per MIL-STD-810C, method 516.2, procedure IV with a shock pulse of 125 g's amplitude and 10 ms duration. No damage to the cooler or change in resistance was noted.

The cooler was then shock-tested in the same manner as the first shock test at a level of 3300 g's for a duration of 0.5 millisecond. Two shocks were applied in each direction along each of 3 mutually perpendicular axes for a total of 12 shocks. The above shock level represented the maximum level available from the test equipment. No variation in the cooler resistance or physical damage was detected after the completion of this test. The vendor's Component Evaluation Report is listed in the Appendix. After the completion of the vibration and shock testing, shown in Table 1 the test cooler was given a resistance check and a performance test with the results listed in Table 2. No measureable change was noted in the operating characteristics of the test cooler.

TABLE 1
Shock and Vibration Levels

	SHOCK		VIBRATION	
	AMPLITUDE	DURATION	AMPLITUDE	FREQUENCY RANGE
Specification	500 g's	0.3 ms	2.5 g's	10Hz to 3500Hz
Test	3300 g's	0.5 ms	50 g's	10Hz to 3500Hz

TABLE 2
Cooler S/N IA-034

Measurements Before and After Shock and Vibration Stress Testing

<u>Performance Test</u>	<u>Before</u>	<u>After</u>
Voltage (Volts)	6.0	6.0
Current (Amps)	.864	.864
T _H (°C)	26.9	26.4
T _C (°C)	-78.7	-79.1
<u>Resistance Check</u>		
First Stage (Ω)	5.8	6.0
Second Stage (Ω)	2.37	2.38
Third Stage (Ω)	.95	.95
Fourth Stage (Ω)	.32	.32

The results of the shock and vibration testing as shown in Table 2 demonstrates that TE coolers which have been manufactured using these materials and fabrication methods can be stressed at levels much higher than that specified in the contract with no degradation in performance or physical damage to the coolers.

The GFE multi-stage coolers, that were furnished for this environmental testing were fabricated from the basic "unitary" design, i.e., with only one ceramic between each stage. No high-stress environmental test data is available for "modular" multi-stage TE coolers which are assembled by cascading individual single-stage cooler units. Thus, in view of the satisfactory test results described above, no change in the basic "unitary" multi-stage cooler design is recommended.

2. Cooler Designs

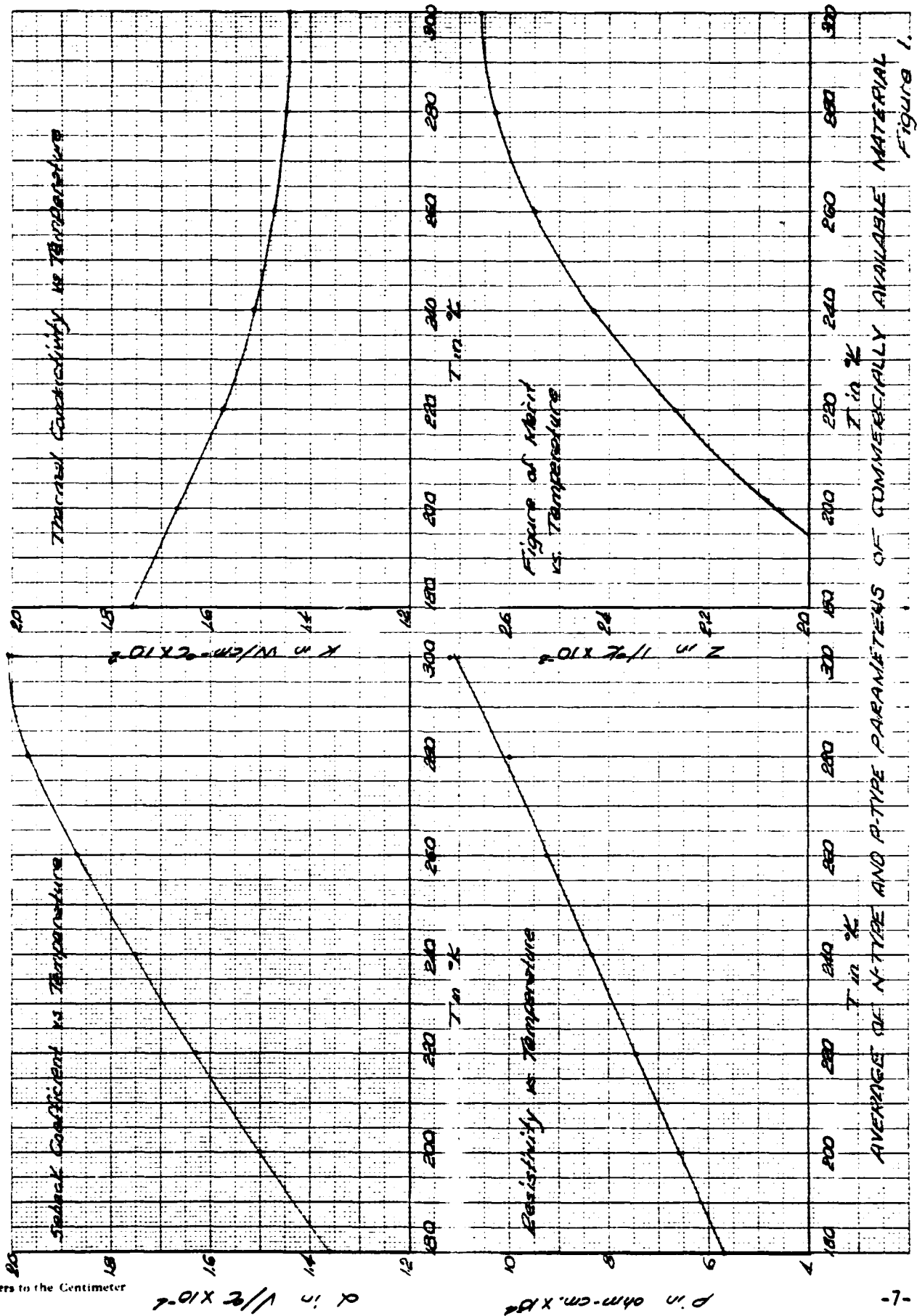
2.1 The coolers to be delivered under this program were to have physical and electrical characteristics as shown in Table 3.

TABLE 3
Cooler Specification Data
Cooler Type

<u>Characteristic</u>	<u>I - A</u>	<u>I - B</u>	<u>II</u>
Top Stage (in.)	0.20 X 0.20	0.20 X 0.20	0.40 X 0.40
Centering (in.)	0.010	0.010	0.010
Parallelism (in.)	0.005	0.005	0.005
Input Voltage (Volts)	6.00 \pm 0.01	6.00 \pm 0.01	6.00 \pm 0.01
Input Power (watts)	3.5	7.0	10.5
Heat Load (mw)	30	60	150
T _H (°K)	298	298	298
T _C (°K)	193	193	193
Cool-down Time (min.)	2	2	2

2.2 The development of thermoelectric materials with improved low temperature characteristics was undertaken in order to achieve the goal of high cooler efficiencies at temperatures of 193°K. Additionally, the incorporation of radiation shielding and similar techniques together with further cooler design effort was studied to fully exploit these non-power consuming factors.

The characteristics of commercially available TE materials are generally optimized for operation at room temperature (27°C). This fact is illustrated in Figure 1 where the figure of merit (Z) is substantially lower at 193°K than at 300°K. The material characteristics shown in Figure 1 are the average of the n- and p-type parameters. During the materials effort



portion of the program, substantial quantities of p-type and n-type thermoelectric materials were produced and evaluated. The thermoelectric characteristics of the p-type material were comparable with those of commercially available TE material. However, the TE characteristics of the n-type material, while substantially more uniform with temperature than commercially available TE material, were lower in overall performance. For this reason, the TE elements in the coolers, were processed from commercial material.

- 2.3 Thermoelectric material ingot Nos. N295 and P298 were used to fabricate the TE coolers which were built and tested for delivery on this program. The parameter values for the TE material which were used in the cooler design calculations were based on published data for the material. As mentioned previously the average TE material parameters for an n-p couple are plotted over the cooler operating temperature range in Figure 1. This data was utilized by the computer program design technology developed at Marlow Industries to obtain the cooler design information. From this, the number of stages, the number of couples per stage, the TE element dimensions and the overall cooler dimensions for each type of cooler were determined. Table 4 lists the Specification, Design, and Predicted Performance for each type of cooler. The Specification data was obtained from the Contract. The Design data was calculated using data published for commercially available material. The Predicted Performance was calculated using material parameters (of commercially available material) measured by Marlow Industries.

It should be noted that the theoretical COP is independent of cooler heat load. The specified COP for the Type I coolers was .0086 which is achievable with commercial material. The specified COP for Type II was .0143 which was not achievable with commercially available materials.

Consequently, the power consumption for the design and predicted performance values for the Type II cooler was increased somewhat over that given in the specification. This was done in order to achieve the specified cold side temperature defined in the specification.

The design curves for each type of cooler together with the effects of active heat loading are shown in Figures 2 to 4. It should be noted that the design point exceeds the cold side temperature specification for each of the three cooler types using the published data for commercial material.

At the time that the fabrication of the coolers was essentially completed, a capability was developed at Marlow Industries which made possible for the direct measurement of α , ρ , κ and Z over a wide temperature range for samples from TE material ingots. A sample of material, is cut from a wafer located at a representative section of an ingot. End caps containing thermocouples are attached to the ends of the sample. One end cap of the sample is attached to a TE cooler which, in vacuum, is capable of maintaining any desired temperature under heat load from approximately 190°K to 345°K. Through computer derived measurements α , ρ , κ and Z are determined for the number of points required to define these parameters over the above temperature range. This data is curve-fit using a second order polynomial least squares process

Measurements of α , ρ , κ and Z were made on samples from ingot Nos. N295 and P298 and are shown in Tables 2 and 3 in the Appendix. Resultant curve-fit parameters together with extrapolated values from 60°K to 400°K are shown in Tables 4 and 5 in the Appendix.

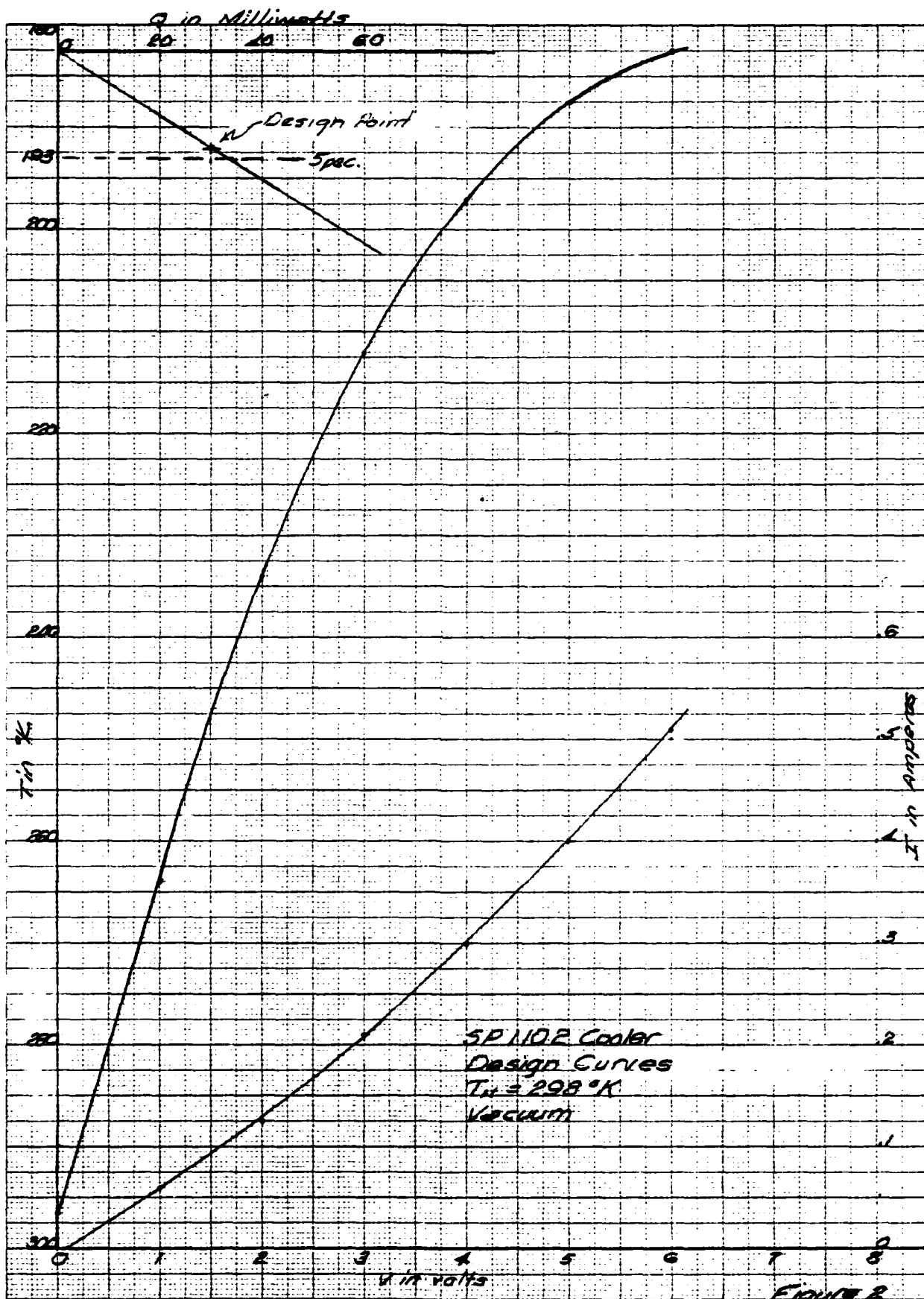
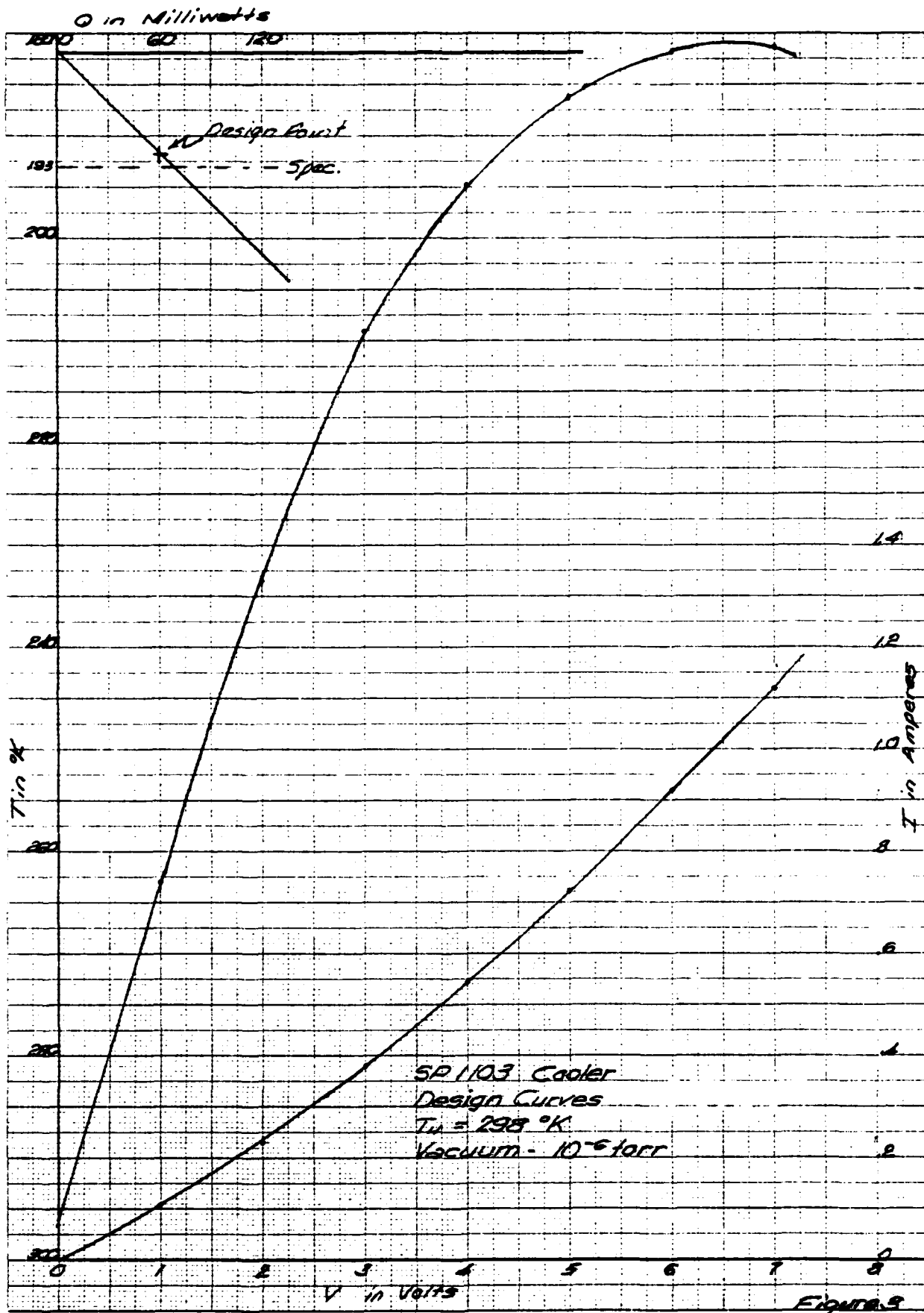
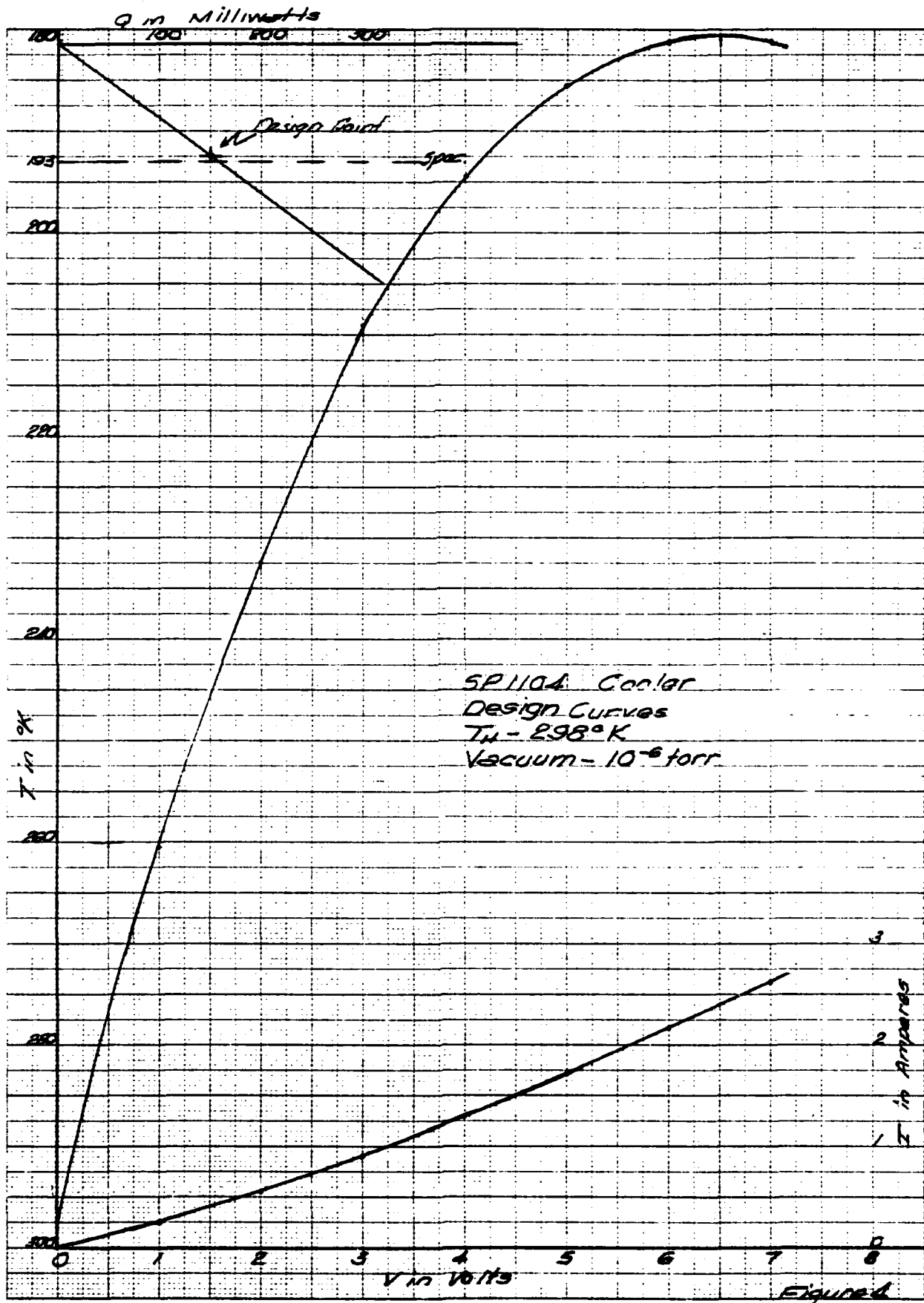


FIGURE 2

10 Millimeters to the Centimeter



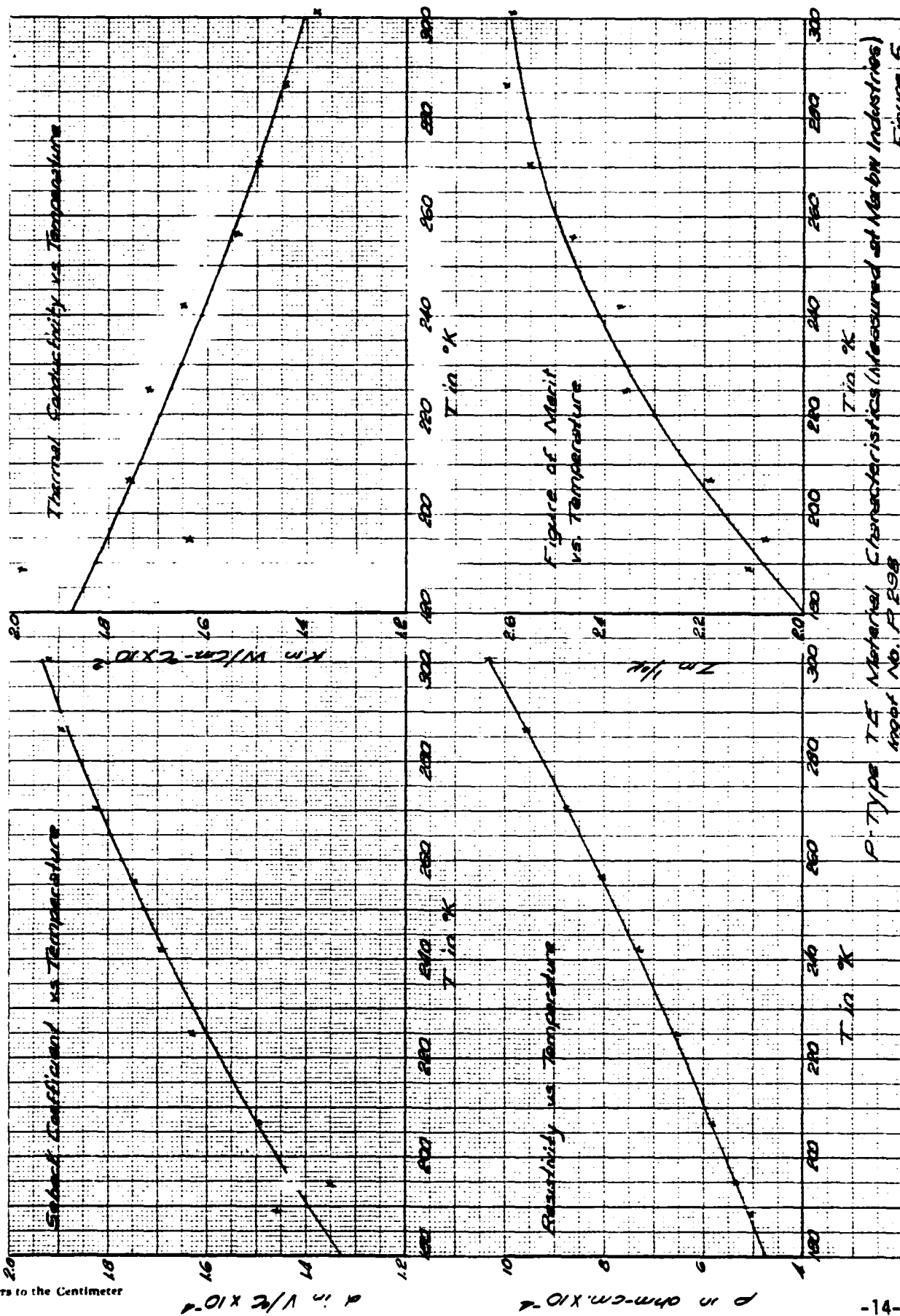


The measured TE material parameters over the cooler operating temperature range are plotted in Figures 5 and 6 for p-type and n-type respectively. This data was utilized by the computer design technology to obtain calculated cooler performance data for the TE coolers which had been fabricated under the program. These predicted performance characteristics based on these measurements are listed in Table 4. It can be seen that the measured material parameters in Figures 5 and 6 differ substantially from those used in the design (Figure 1) and the result is the predicted performance is not as good as the design. It will be noted under the section "Discussion of Results" that the cooler performance test data and the predicted performance data calculated from measured parameters agree well within testing error. The predicted performance curves determined from measured material parameters for each type of cooler are shown in Figures 7 to 9. The performance calculations from which the above curves are derived are given in Tables 6-8 in the Appendix.

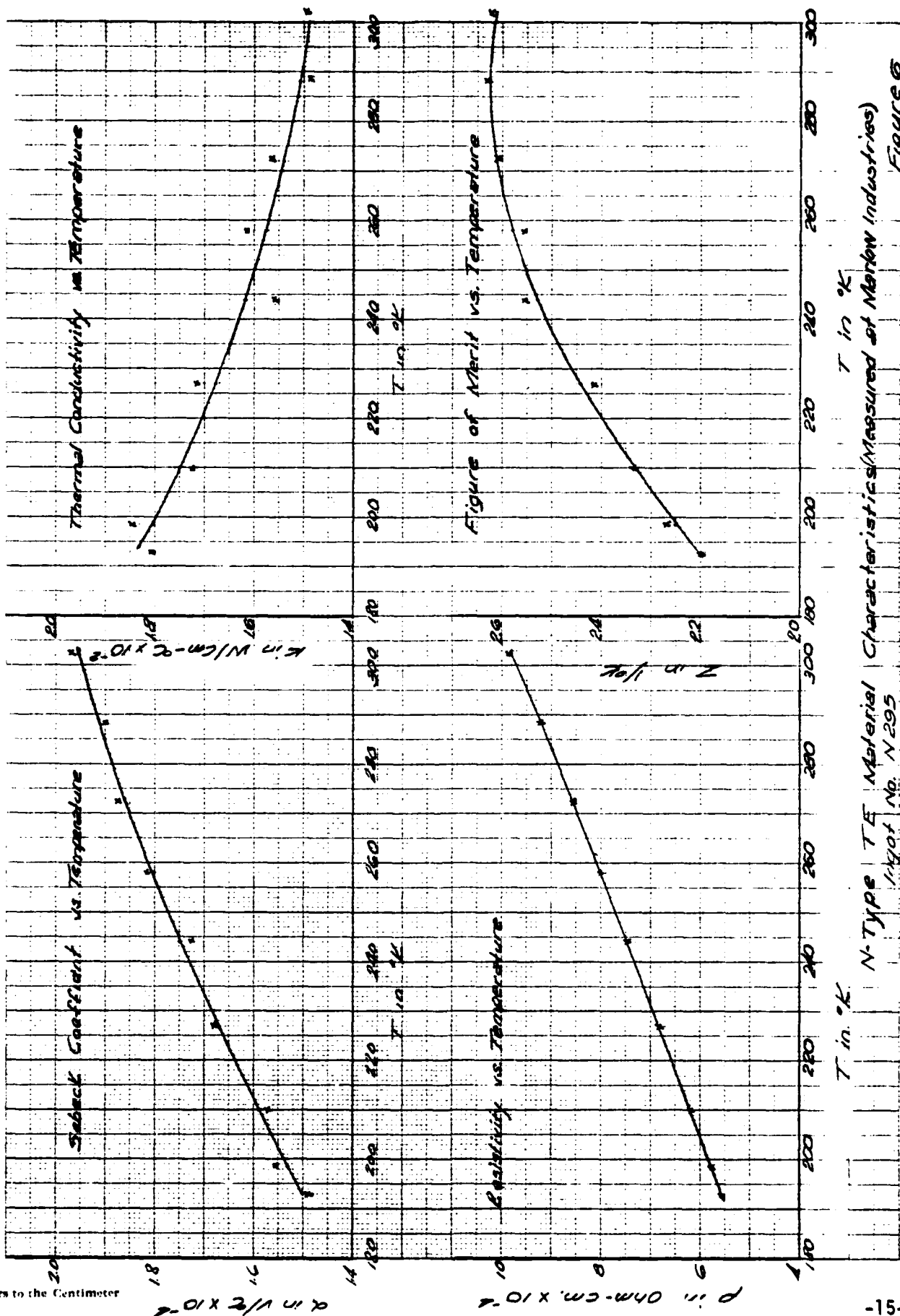
2.4

Two thermocouples were attached to each cooler assembly. A .001" copper-constantan thermocouple was attached to the cold plate and a .003" copper-constantan thermocouple was attached to the cooler base. This type of thermocouple was used rather than that originally specified because of its greater accuracy over the temperature range. The use of .001" wires attached to the cold plate reduced the conductive heat loss to a negligible value as compared to .003" thermocouple wire.

Radiation shields were designed and fabricated for each of the three cooler types. The material used was gold-plated bronze. Drawings of the radiation shields are shown in MI Dwg. Nos. 2798, 2799, and 2800 in the Appendix.



P-Type TE Material Characteristics (Measured at Marlow Industries)
 Model No. P-158
 Figure 5



N-Type TE Material Characteristics (Measured at Markon Industries)
Lot No. N295

Figure 6

10 Millimeters to the Centimeter

Cooler Specification, Design, and Predicted Performance Data Table 4

	Type IA-SP1102		Type IB-SP1103		Type II-SP1104	
	Spec.	Design	Prod. Perf.	Spec.	Design	Prod. Perf.
No. of Stages	4	4		4	4	4
Top Plate	.80"x.80"	.20"x.80"		.20"x.20"	.40"x.40"	.40"x.40"
Bottom Plate		.52"x.68"			.52"x.68"	.56"x.11"
Height		.470"			.40"	.649"
Centering	.010"	.010"		.010"	.010"	.010"
Parallelism	.005"	.006"		.005"	.005"	.005"
Element, L/A		162.5/in.		81.3/in.		330/in.
Element Dimensions		.020x.020x.065"		.025x.025x.050"		.051x.051x.086"
No. of Couplers, N ₁		64		64	64	
N ₂		26		26	26	
N ₃		11		11	11	
N ₄		5		5	5	
Base Temperature	298°K	298°K	298°K	298°K	298°K	298°K
Cold Temp w/o H.L.		182.6°K	191.4°K		181.1°K	181.5°K
Cold Temp. w/ H.L.	193°K	192.0°K	202.4°K	193°K	191.7°K	192.5°K
Active Heat Load	30 mW	30 mW	30 mW	60 mW	60 mW	150 mW
Passive Heat Load		19 mW	19 mW	18 mW	18 mW	63 mW
Total Heat Load		49 mW	49 mW	78 mW	78 mW	213 mW
C.O.P. (Active Q)	.0086	.0098	.0117	.0086	.0109	.0115
C.O.P. (Total Q)		.0159	.0191		.0141	.0164
Voltage	6.00 V.	6.00 V.	6.00 V.	6.00 V.	6.00 V.	6.00 V.
Current	≤ 1.589 A.	.51 A.	.427 A.	≤ 1.167 A.	.92 A.	≤ 1.75 A.
Power	≤ 3.5 W.	3.06 W	2.56 W	≤ 7.0 W.	5.52 W.	≤ 10.5 W.
Cooler Resistance			13.5 Ω		6.7 Ω	
① Design data calculated using published material parameters						
② Predicted performance data calculated using material parameters measured by NIST Ind.						
③ Without radiation shield						

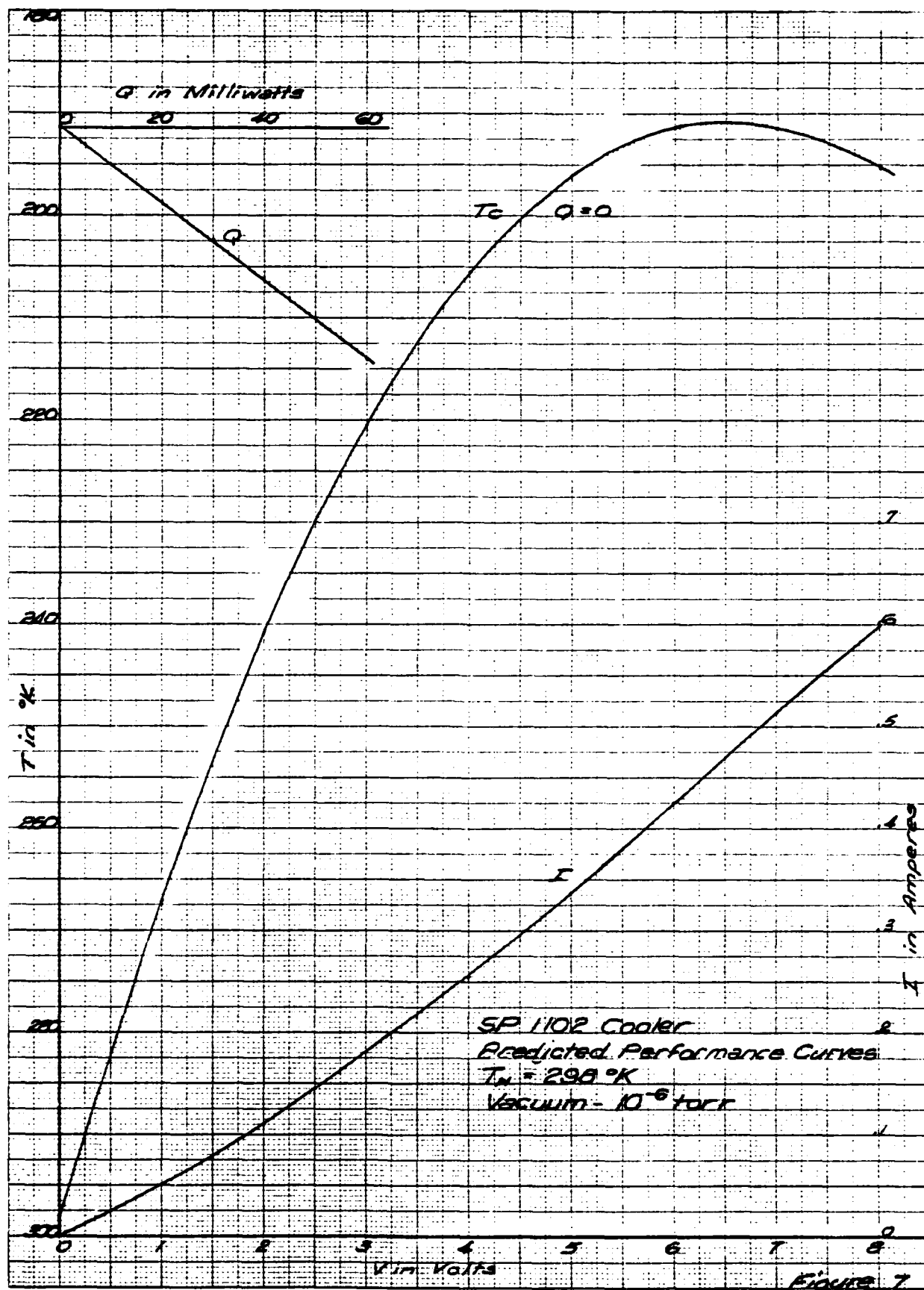


Figure 7

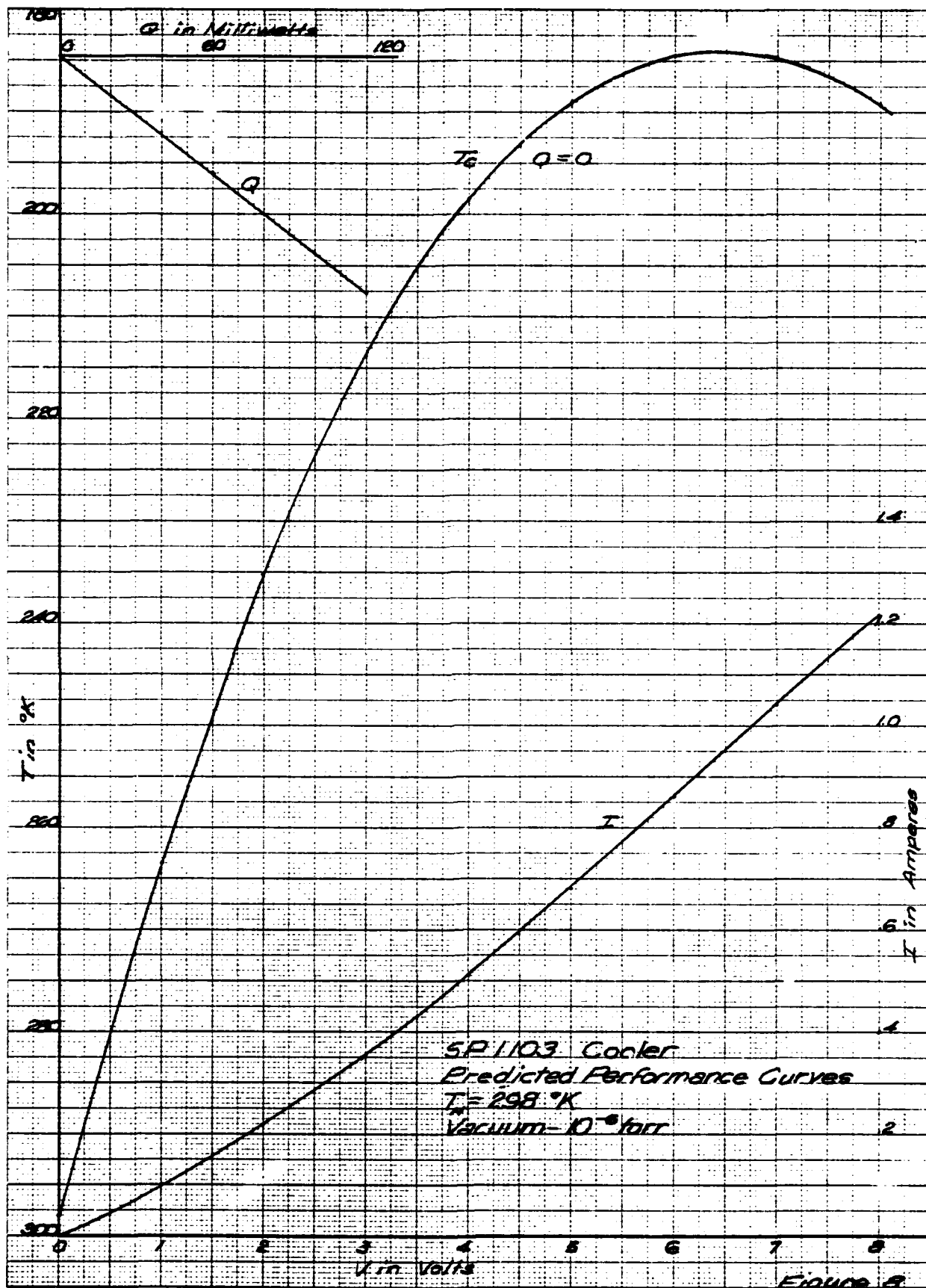


Figure 8

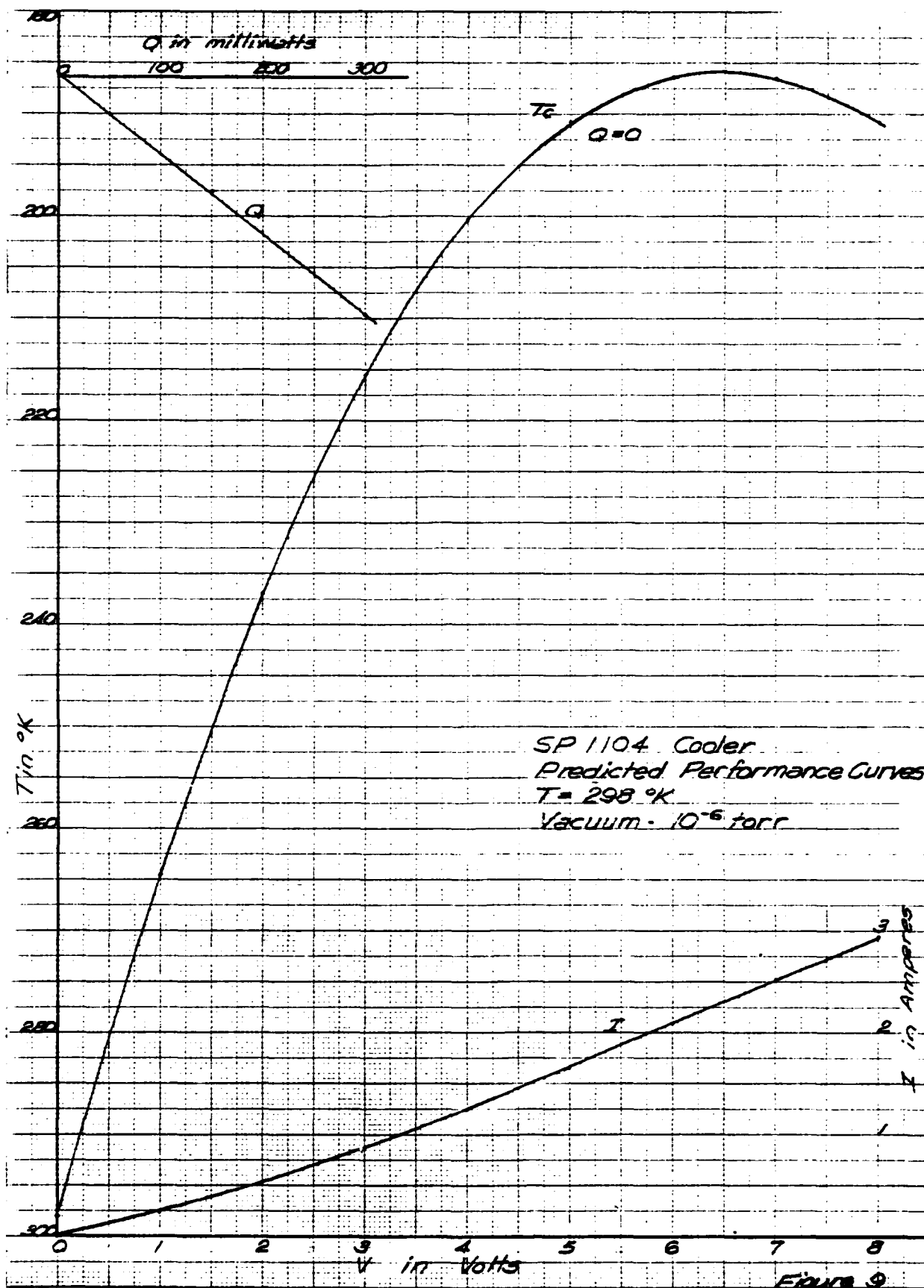


Figure 9

The dimensions of the copper test bases are 1-1/2" X 1-3/4" X 1/4". Each test base has 8 insulated standoff terminals. The size of the test base was increased slightly to allow space for the terminals without requiring the power leads to be bent sharply. The thickness of the base was made 1/4" in order to accomodate the terminal mounting studs.

3.0 Cooler Fabrication

Five TE coolers of each of Type I-A, Type I-B and Type II were fabricated in accordance with Marlow Industries standard process specifications. Detailed product specifications for these coolers, which are designated Models SP 1102, SP 1103 and SP 1104 respectively, are shown in the Appendix. No problems were encountered in assembling the coolers.

After assembly, each cooler was mounted onto a copper test base using 96°C solder. The copper test base had eight insulated terminals to accomodate the two power leads, four thermocouple leads and two heat load resistor leads. Four through-holes were provided for mounting the cooler-test base assembly on the cooler vacuum test fixture.

A .001" copper-constantan thermocouple was mounted onto the cold plate of each cooler and connected to a pair of copper test base terminals. A .003" copper-constantan thermocouple was mounted onto the copper test base and connected to another pair of terminals. The cooler input power leads were attached to a third pair of terminals. After completion of the vibration and shock tests, a heat load resistor was mounted onto each cooler with 96°C solder. The power leads to the resistor were attached to the fourth pair of terminals. A radiation shield was mounted onto one cooler of each type with 96°C solder.

4.0 Cooler Testing

Each of the cooler-test base assemblies was subjected to performance and environmental testing. Selected units were given additional testing to further evaluate detailed cooler characteristics. Details of the testing operations are given in Operational and Environmental Test Procedure MI Dwg. No. 2898 in the Appendix.

The AC resistance and the Hy-Pot resistance of each cooler was measured and recorded. Each unit was then performance tested in the test console vacuum. The initial test data is given in Table 5.

The units were mounted on an adapter test plate and tested under the following conditions:

Vibration Test

- Frequency Range - 10 - 3000 Hz
- Amplitude - 2.5 g peak
- Sweep Rate - Logarithmic sweep from 10 Hz to 3000 Hz and back to 10 Hz within a 30 minute period
- Axes - 3 orthogonal, one sweep per minute

Shock Test

- No. of Impacts - 6 in each direction and amplitude
- Axes - 3 orthogonal, both directions
- Amplitudes - half sine wave pulses, of 500 g's peak value with a minimum duration of 0.3 millisecond measured between the 10% value of peak amplitude. Half sine wave pulses of 140 ± 10 g's peak value with a duration of 9 milliseconds $\pm 10\%$.

A component evaluation report is shown in the Appendix.

1017121 Test Data

11/19/74

Cooler No.	AC Btu. hr.	44.81 Btu. hr.	V 1017s	I amps	T _{in}		T _e		Head Loss mm	Time sec	Vacuum in. H ₂ O
					°C	°K	°C	°K			
SP1102-1	13.6	✓	5.999	0.409	23.4	296.4	-80.5	192.5			✓
-2	13.5	✓	5.998	.416	23.4	296.4	-80.4	192.6			✓
-3	14.2	✓	6.001	.403	23.2	296.2	-78.9	194.1			✓
-4	12.8	✓	6.006	.437	24.4	297.4	-79.9	193.1			✓
-5	14.3	✓	6.000	.392	24.0	297.0	-76.7	196.3			✓
SP1103-1	7.2	✓	6.000	0.768	23.9	296.9	-86.0	187.0			✓
-2	7.4	✓	5.999	.775	24.0	297.0	-85.5	187.5			✓
-3	6.9	✓	6.003	.835	23.8	296.8	-84.6	188.4			✓
-4	2.3	✓	6.000	.765	23.6	296.6	-86.7	186.3			✓
-5	7.35	✓	6.000	.763	22.7	295.7	-86.4	186.6			✓
SP1104-1	3.0	✓	6.001	1.892	24.2	297.2	-87.4	185.6			✓
-2	3.1	✓	6.004	1.875	24.0	297.0	-88.6	184.4			✓
-3	3.1	✓	6.001	1.865	23.4	296.4	-87.6	185.4			✓
-4	3.1	✓	5.999	1.879	23.5	296.5	-86.8	186.2			✓
-5	3.1	✓	6.003	1.867	24.1	297.1	-88.8	184.2			✓

After completion of the vibration and shock testing, the units were tested again. The post test data (Table 6) indicated that two of the Type II units had degraded somewhat in performance. However, the units were cleaned prior to the 85°C bake tests, subjected to the bake cycle and tested again. These test results indicated that the apparent subpar performance was the result of oil on the cooler that was received during the shock and vibration testing. The equipment used to conduct the shock and vibration testing has a considerable amount of oil associated with it and it is believed that the oil got onto the coolers during the handling and/or testing operations.

The component evaluation report is shown in the Appendix.

No degradation in operating characteristics occurred during the 48 hour, 85°C bake cycle as shown by the test results in Table 7.

Three coolers of each type were subjected to storage at -60°C for 24 hours. A heat load resistor was mounted on one unit of each type. These units were operated with the normal heat load at -40°C during the cold stress test. No degradation of cooler performance was noted as a result of either of these tests. Test data is given in Tables 8 and 9.

Heat load resistors were mounted on the cold plates of two coolers of each type. Voltage leads and thermocouples were mounted on each stage of one cooler of each type equipped with a heat load resistor. These coolers were operated at nominal voltage and heat load, and data was recorded to determine the power input and temperature for each stage. Similar data was taken for conditions of zero heat load and 200% nominal heat load. The test data and calculations for the COP's for each type of cooler was given in Tables 10-13.

Post 85°C Boile Test Data 130-31/79 Table 7

Cooler No.	AC Bus. Ω	Ap. At Bus. V	I amps	T _h		T _e		Head Loss mm	Time sec	Vacuum mm Hg
				°C	°K	°C	°K			
SP1102-1		6.000	0.403	23.1	296.4	-81.1	191.9			
-2		6.001	.407	26.3	299.3	-80.5	192.5			
-3		6.000	.394	25.5	298.5	-78.4	194.6			
-4		6.000	.433	21.7	297.7	-81.8	191.2			
-5		5.998	.391	24.1	297.1	-76.6	196.4			
SP1103-1		5.998	0.768	23.6	296.6	-86.0	187.0			
-2		6.001	.770	23.3	296.3	-85.8	187.2			
-3		6.000	.821	25.3	298.3	-82.4	188.6			
-4		6.000	.754	21.9	297.9	-86.4	186.6			
-5		6.000	.748	24.2	297.2	-87.2	185.8			
SP1104-1		6.002	1.903	24.2	297.2	-86.4	186.6			
-2		6.000	1.864	24.7	297.7	-84.8	188.2			
-3		6.000	1.864	23.5	296.5	-87.6	185.4			
-4		6.000	1.853	26.1	299.1	-86.9	186.1			
-5		6.002	1.878	23.5	296.5	-88.3	184.7			

Part -60°C Storage Test Data

3/1/79

Table 8

Cooler No.	AC Bus. -R	V _{100MA} >100MA	V	I amps	T _H		T _E		Hard Load mm	Time sec	Vacuum ≤ 0.2	Humidity K.2
					°C	°K	°C	°K				
SP1102-1												
-2												
-3			6.00	0.395	29.6	296.6	-19.1	193.9	-		✓	218.8
-4												
-5			6.00	.394	25.1	298.1	-25.5	197.5	-		✓	
SP1103-1												
-2			6.00	0.257	24.8	297.8	-24.4	188.6	-		✓	394.9
-3			6.00	.811	25.0	298.0	-23.9	189.1	-		✓	380.0
-4												
-5												
SP1104-1												
-2			6.00	1.829	25.9	298.9	-27.8	185.2	-		✓	441.6
-3			6.00	1.815	25.4	298.4	-26.9	186.1	-		✓	416.8
-4												
-5												

Cold Stress Test Data

2/28/79 Table 9

Cooler No.	AC Bus. -R	44.61 kPa -100MMg	V volts	I amps	T _N		T _E		Hard Load MW	Time sec	Vacuum in. Hg
					°C	°K	°C	°K			
SP1102-1			6.00	0.582	-40.0	233.0	-85.2	187.8	30		± 50μ
-2											
-3											
-4											
-5											
SP1103-1			6.00	1.150	-40.0	233.0	-84.4	188.6	60		± 50μ
-2											
-3											
-4											
-5											
SP1104-1			6.00	2.626	-40.0	233.0	-102.9	170.1	150		± 50μ
-2											
-3											
-4											
-5											

COP Test Data

Table 10

Cooler No.	V volts	I amps	Heat Load mw	V ₁ volts	V ₂ volts	V ₃ volts	V ₄ volts	V ₅ volts	V ₆ volts	T ₁ °C	T ₂ °C	T ₃ °C	T ₄ °C	T ₅ °C	T ₆ °C
SP1102-4	6.000	.427	0	.1826	1.973	.646			6.000	-78.6	-34.4	-57.0		-9.4	25
2/16/79	6.001	.428	30	.183	1.971	.644			6.001	-68.9	-32.6	-52.6		-8.9	25
	6.001	.429	60	.180	1.969	.642			6.001	-59.2	-31.1	-48.4		-8.5	25
SP1103-5	6.013	.749	0	.205	1.989	.675			6.000	-84.2	-36.6	-58.9		-11.8	25
2/12/79	6.012	.751	60	.205	1.990	.677			5.999	-72.4	-34.3	-53.7		-11.0	25
	6.011	.753	120	.207	1.989	.674			5.998	-60.1	-32.3	-48.4		-10.4	25
SP1104-5	6.000	1.825	0	.176	1.978	.654			6.000	-86.0	-39.1	-62.9		-12.4	25
2/18/79	5.999	1.840	150	.176	1.978	.654			5.999	-74.4	-37.0	-57.8		-11.7	25
	6.000	1.846	300	.176	1.977	.653			6.000	-63.1	-35.0	-52.8		-11.1	25

COF Calculations, SP 1103

219952 6/10/5

219951

Cooler No.	Stage No.	✓	I amps	Win watts	COP	ΔT °C	W _L mW	T _C °K	T _C * °K
5P1103-2 T _a = 298°K	4	1.205	749	154	—	25.3	0	188.8	185.8
	3	1.470		352	438	22.3			(184.5)
	2	1.314		984	514	24.8			
	1	4.011		3.004	496	36.8			
Total		6.000		4.494		109.2			
T _a = 298°K	4	2.06	750	154	390	18.7	60	200.6	197.6
	3	1.467		354	604	19.4			(196.2)
	2	1.315		986	574	23.3			
	1	4.009		3.007	516	36.0			
Total		5.997		4.501		97.4			
T _a = 298°K	4	2.07	753	156	769	11.7	120	212.9	209.9
	3	1.467		352	784	16.1			(207.6)
	2	1.315		990	634	21.9			
	1	4.009		3.019	536	35.4			
Total		5.998		4.517		85.1			
() Calculated performance									
* Corrected for test connection loading									

2/19/70 File 13

Coker No.	Stage No.	V		I Amps	Win mths	COP	ΔT °C	W _h mm	T _c °K	T _c °K
		Volts	Volts							
SP 1104-S	4	1.176	1.835	323	—	—	23.1	0	187.0	184.7
	3	1.478		877	.368		23.8			(86.3)
	2	1.324		2,430	.494		26.7			
	1	4.022		7,380	.492		37.4			
	Total	6.000		11.01			111.0			
	4	1.176	1.840	324	.463		16.6	150	198.6	196.3
	3	1.478		880	.529		20.8			(97.5)
	2	1.324		2,436	.556		25.3			
	1	4.021		7,400	.512		36.7			
	Total	5.999		11.04			99.4			
	4	1.176	1.846	325	.923		10.3	300	209.9	207.6
	3	1.477		881	.709		17.8			(209.6)
	2	1.324		2,444	.616		23.9			
	1	4.023		7,426	.532		36.1			
	Total	6.000		11.08			88.1			
() Calculated performance										
* Corrected for test connection loading										

31

One cooler of each type with heat load resistor was tested to determine ΔT at a nominal voltage and heat loads of zero, nominal, and 200% nominal values. The variation of ΔT with voltage at nominal heat load was also determined. Radiation shields were mounted onto one each of the above coolers. One of the coolers, SP 1102-2, was damaged while mounting the radiation shield. This cooler was not repaired since it was felt that the cooler performance might be affected. Instead, a radiation shield was mounted on cooler, SP 1102-1, which had comparable performance characteristics (refer to Table 5) and this unit was used for subsequent testing with the radiation shield. The measurement of ΔT at nominal voltage and heat load was repeated for each cooler after installation of the radiation shields. Data for these tests is given in Tables 14-16.

The radiation (passive) heat load listed in Table 2 was calculated using the equation:

$$Q_r = \sigma \epsilon A (T_A^4 - T_c^4)$$

$$\sigma = 3.549 \times 10^{-11} \text{ (watts/in}^2 \text{ } ^\circ\text{K}^4\text{)}$$

$$\epsilon = \text{effective emissivity, 0.8}$$

$$A = \text{surface area (in}^2\text{)}$$

$$T_A = \text{ambient temperature (}^\circ\text{K)}$$

$$T_c = \text{cold surface temperature (}^\circ\text{K)}$$

The final tabulated test data for each cooler is given in Table 17.

B. Thermoelectric Material Development

1.0 Introduction

The operating range of multi-stage thermoelectric coolers has been extended to temperatures of 193°K and lower. Consequently, a need exists for thermoelectric materials with a high figure of merit, Z , particularly at these lower temperatures. The figure of merit is defined by the equation, $Z = \alpha^2/\rho\kappa$, where α is the Seebeck coefficient, ρ is the electrical resistivity and κ is the thermal conductivity.

Cooler Characteristics w/ Head Load

Table 12

Cooler No.	AC Bus. R	44.0 A/B >100MA	V volts	I amps	T _{in}		T _e		Head Load MW	Time sec	Room temp °C	T _e °K
					°C	°K	°C	°K				
SR1102-2			6.00	.411	23.2	296.2	-66.9	206.1	30	179	-	205.0
			6.00	.409	23.2	296.2	-77.0	196.0	0		-	192.5
			6.00	.411	23.2	296.2	-57.7	215.3	60		-	212.5
			1.00	.053	23.7	296.7	0.7	279.7	30		-	279.0
			2.00	.110	23.5	296.5	-18.4	254.6			-	253.1
			3.00	.176	23.6	296.6	-37.6	235.4			-	233.3
			4.00	.249	23.8	296.8	-52.2	220.8			-	218.2
			5.00	.327	24.0	297.0	-61.7	211.3			-	208.4
			6.00	.408	24.2	297.2	-67.0	206.0			-	202.9
			7.00	.488	24.3	297.3	-69.1	203.9			-	200.8
SR1103-4			8.00	.564	24.6	297.6	-68.4	201.6			-	201.5
			6.00	.753	24.7	297.7	-72.9	200.1	60	141	-	198.8
			6.00	.741	26.0	299.0	-84.9	188.1	0		-	186.6
			6.00	.753	25.2	298.2	-60.7	212.3	120		-	211.1
			1.00	.095	24.6	297.6	7.1	280.1	60		-	277.8
			2.00	.197	24.5	297.5	-21.0	252.0			-	251.1
			3.00	.320	24.4	297.4	-42.5	230.5			-	229.6
			4.00	.456	24.5	297.5	-51.8	215.1			-	214.0
			5.00	.602	24.6	297.6	-67.7	205.3			-	204.0
			6.00	.753	24.8	297.8	-72.9	200.1			-	198.8
			7.00	.902	25.3	298.3	-73.9	199.1			-	197.7
			8.00	1.042	25.7	298.7	-71.5	201.5			-	200.2
* Connected for fast connection loading												

Final Cooler Test Data

Table 1

Cooler No.	AC Res. Ω	AC Res. Ω	V	I	T _{in}		T _e		Heat Load MW	Time sec	Vacuum μ
					°C	°K	°C	°K			
SP1102-1	140	>100M Ω	6.00	0.399	24.8	297.8	-79.8	193.2	-		-
-2	138	"	6.00	.409	23.2	296.2	-77.0	196.0	-		-
-3	142	"	6.00	.395	23.6	296.6	-79.1	193.9	-		-
-4	131	"	6.00	.427	25	298	-78.6	194.4	-		-
-5	144	"	6.00	.384	25.1	298.1	-75.5	197.5	-		-
SP1103-1	145	"	6.00	0.768	23.6	296.6	-86.0	187.0	-		-
-2	140	"	6.00	.757	24.8	297.8	-84.4	188.6	-		-
-3	122	"	6.00	.811	25.0	298.0	-83.9	189.1	-		-
-4	145	"	6.00	.741	26.0	299.0	-81.9	188.1	-		-
-5	147	"	6.00	.749	25	298	-84.2	188.8	-		-
SP1104-1	298	"	6.00	1.903	24.2	297.2	-86.4	186.6	-		-
-2	302	"	6.00	1.829	25.9	298.9	-87.8	185.2	-		-
-3	308	"	6.00	1.815	25.4	298.4	-86.9	186.1	-		-
-4	306	"	6.00	1.828	26.5	299.5	-84.2	188.8	-		-
-5	305	"	6.00	1.835	25	298	-86.0	187.0	-		-
① Thermocouples on each stage and heat load resistor ② Heat load resistor ③ Radiation shield and heat load resistor * Cooler No. SP-1102-2 was damaged during this collection of reduction shield. This cooler was not required.											

In examining the parameters for presently available TE materials, the electrical resistivity (ρ) decreases with decreasing temperature while the thermal conductivity (κ) increases. TE materials can be produced for which the product of ρ and κ decreases as the temperature is reduced, thus tending to improve the figure of merit. However, the Seebeck coefficient (α) invariably decreases with a decrease in temperature for high Z materials. The net effect is a reduction in the figure of merit, particularly at temperatures below about 225°K. The investigation of TE material characteristics at lower temperatures was one of the objectives of this program.

2.0 Process

In the early phases of the program, an extensive literature survey was conducted in the field of thermoelectric materials. Most of the present TE materials are composed of Bi_2Te_3 - Sb_2Te_3 - Sb_2Se_3 alloys in various concentrations with added dopants to form p-type or n-type material. The TE material is composed of crystallographically oriented polycrystals usually in the form of an ingot 10-20 mm in diameter and several centimeters long.

A common method for forming the polycrystalline material is the utilization of the vertical Bridgman technique. This technique produces the TE material by the slow solidification of a molten ingot of the material over a sharp temperature gradient. Other methods employ zone leveling and sintering techniques but these methods have not been evaluated under the present program.

The detailed Thermoelectric Material Growth Procedure, MI Dwg. No. 2454 is listed in the Appendix. A description of the materials, equipment, processing methods and evaluation techniques follows.

The raw materials needed for the process are bismuth, tellurium, antimony, selenium, and the n-type dopant, antimony iodide. High purity material was purchased in shot or powder form. The source and purity of all starting materials is listed in Table 9 of the Appendix. The materials were carefully weighed on a Model 1202 Sartorius balance, to the corresponding stoichiometric values required for the particular type of material. The molar ratio of the starting materials for some of the p- and n-type ingots produced under this program are listed in Table 10 and 11 of the Appendix. After the materials have been weighed they are placed in a cone tipped quartz tube. The tube is prepared by washing with hydrofluoric acid, rinsing with deionized water, and sealing one end so that the sides of the tube converge at an approximate thirty degree angle. A small diameter tube is used to conserve material and allow for a more orderly formation of the crystals. These quartz tubes are cleaned one at a time and used immediately when dry to minimize exposure to atmosphere and surface contaminants.

The tube containing the raw materials is connected to the vacuum system and evacuated for an hour. The raw material is then compacted by slowly melting the material with a torch. This compacting serves to reduce surface area and thus decrease oxidation. The tube is evacuated for an extended period of time and then sealed with the torch under a vacuum. The vacuum of the sealed tube is checked by visual examination of the tube. The quartz capsule is then placed in the alloy oven and melted again. This time the molten material is gently rocked to help in the mixing process, and increase the homogeneity of the material. It is removed from the oven and allowed to solidify. The material at this point is a mass conglomerate of the pseudo-ternary alloys bismuth telluride, antimony telluride, and antimony selenide.

The next step in the process involves the Bridgeman Technique. The ingot of material is slowly passed through a two zone resistance furnace.

The first zone the material passes through operates at an elevated temperature which causes the material to become molten. The second zone is substantially cooler therefore, causing a steep temperature gradient for solidification. The cone-shaped end is the first section of the quartz crucible to leave the molten zone and initiate the solidification process. The cone acts as a seed to start the orderly formation of the crystalline structure. The temperatures the ingot experiences are recorded by a Omegaline Model # 0-5237-55 recorder. Two thermocouples at different positions on the ingot allow for dual temperature measurement which are simultaneously measured by the recorder. This generates a full furnace profile on every production run as well as data for thermoelectric material characterization. A typical furnace profile is shown in the TE Material Growth Procedure MI Dwg. No. 2454 in the Appendix.

After removal from the furnace the quartz tube contains the final thermoelectric material. The tube is carefully broken from around the material. The ingot is now ready for characterization. With a Keithly 503 milliohmmeter the resistivity is measured down the length of the ingot at evenly spaced intervals using a special two point probe. This procedure is repeated on three sides of the ingot. An average resistivity is calculated from this data using the equation

$$\rho = \frac{RA}{L}$$

where ρ is the electrical resistivity, R is the measured resistance, A is the cross-sectional area, and L is the distance between the probes of the special two point probe. All data is

recorded on the electrical resistivity record shown at the back of the Thermoelectric Growth Procedure, Dwg. No. 2454.

The Seebeck coefficient is calculated by using a simple galvanometer, a hot probe, and a cold probe. The measurements are made in much the same manner as the resistivity measurement. Galvanometer readings are taken at evenly spaced intervals down the length of the ingot on three different sides. Calculations use the equation

$$V_{OC} = \alpha \Delta T$$

where V_{OC} is the open circuit voltage, α is the Seebeck coefficient, and ΔT is the difference in temperature between the hot and cold probes. The calculations depend on the very important assumption that ΔT remains constant throughout the test and the use of a standard ingot of material for comparison. The standard ingot of material was an ingot selected from commercially available n- and p-type material. The parameters of the standard ingots were determined by building test coolers and calculating the value of σ from AC resistance and cooler performance measurements. The data is recorded on the Seebeck coefficient record shown in the Material Growth Procedure, Dwg. No. 2454. These two measurements, electrical resistivity and Seebeck coefficient give a quick reference as to the quality of the thermoelectric material.

To further test the material, selected ingots were cut in one inch pieces. Single couple coolers were built from these one inch sections and tested. A typical set of material parameters for a single couple is presented in Table 12 of the Appendix and Figures 1 and 2.

When a particular set of ingots exhibits good material properties, the one inch sections are set aside for MI 1060 cooler fabrication. A combination of the ingot with good parameters and the commercial ingot are used for cooler construction. The combinations are listed in Table 18.

TABLE 18
MI 1060 Material Combinations

Cooler	P	N
#1	MI	MI
#2	MI	Std.
#3	Std.	MI
#4	Std.	Std.

A typical set of MI 1060 material parameters derived from test data are given in Figures 3, 4 and 5 of the Appendix. Typical performance of an MI 1060 is shown in Table 13 of the Appendix.

There are two disadvantages associated with this system of material analysis. The process of building special coolers for material evaluation is costly and involves a period of several days. Thus, considerable time is required to generate data by analysis of the test coolers and to feed back this information into the material production process. In addition, this data is based on the cooler performance rather than the basic material parameters and includes production and testing variables. At best, the data reflects the average parameters for the n-type and p-type materials used in constructing the test coolers.

For these reasons two different approaches to material evaluation were considered. Both of these characterization techniques are still under development. One type of analysis is compositional characterization. The electron microprobe was the instrument chosen for the analysis. An adequate

analysis was not obtained with this technique during initial trials. Verification of the basic chemical components was required to be done at NVL on the samples tested since the values generated by a local vendor did not correspond with the expected values. The results of the initial composition analysis by the local vendor compared with the NVL analysis are shown in Table 19. Later analysis done by a local laboratory using the electron microprobe technique confirmed the measurements made by NVL and expected by Marlow Industries. The analysis from the local laboratory is shown in Tables 20 and 21. Although the quantity of the dopant (Iodine) was not evaluated, the major compositional quantities correlated very closely and the analysis supported our hypothesis of hydrocarbon contamination due to oil backstreaming associated with mechanical pumps. Further work on the development of the methods to measure halogen concentration is desired in order to measure n-type dopant levels. A typical data analysis summary is shown for several samples in Table 14 of the Appendix.

The other type of evaluation required is α , ρ , κ characterization. The capability to obtain α , ρ , κ characterization of entire ingots was still being developed at program end. However, samples of thermoelectric material ingots were analyzed over a temperature range of 180°K to 350°K using a computerized characterization method unique to Marlow Industries. These results were extrapolated to cover the range from 60°K to 400°K by computer statistically data analysis.

TABLE 19

Comparison of Material Analysis using Electron Microprobe

Atomic Percent

	<u>P-Type Material</u>			<u>N-Type Material</u>		
	Raw Material	Local Vendor	NVL	Raw Material	Local Vendor	NVL
Bismuth	8.558	52.83	9.62	35.630	54.38	38.87
Tellurium	50.661	43.74	59.05	56.385	42.67	55.83
Antimony	39.738	---	28.51	1.923	---	1.40
Selenium	1.014	3.41	2.82	6.046	2.95	3.90

TABLE 20

P-Type Material Composition (from local laboratory)
Electron Microprobe Analysis

Molar ratio of final compounds

Sample	Bi	Te	Sb	Se
XP015	9.662	58.518	29.848	1.972
XP022	10.150	59.067	28.750	2.032
XP024	6.203	58.498	32.772	2.527
XP027	10.197	58.655	29.257	1.891
XP028	9.222	61.190	27.711	1.876

These values conform to expected results very closely.

TABLE 21

N-Type Material Composition (from local laboratory)
Electron Microprobe Analysis

Molar ratio of final compounds

Sample	Bi	Te	Sb	Se
XN008	37.772	49.875	2.012	10.341
XN012	35.384	56.345	4.327	3.944
XN021	35.501	56.983	3.762	3.754
XN022	34.438	57.025	4.570	3.967
XN029	36.312	55.645	4.240	3.803
XN030B	35.443	56.443	4.229	3.885
XN030T	37.525	54.878	3.824	3.773
XN032	35.970	56.567	3.774	3.688

The computerized material characterization technique produced absolute values for the material parameters as compared to previous systems where standards were required and the data obtained is only relative to these standards. This system of α , ρ , κ measurement is invaluable to a materials research program. Data generated by this technique is shown in Tables 15-18 in the Appendix and Figures 6 and 7 of the Appendix.

IV. DISCUSSION OF RESULTS

A. Thermoelectric Coolers

A GFE multi-stage cooler was subjected to severe mechanical stress testing as described in Section III - A. 1. of this report. A performance test made after completion of the stress tests showed no measureable change in the operating characteristics of the cooler. Also, no visible damage to the cooler was noted. As a result of this testing, it is felt that the basic "unitary" design configuration, i.e., with only one ceramic between each stage, provides a completely satisfactory cooler that will meet all military environmental requirements.

Three types of coolers were designed and fabricated for use with 30, 60 and 150 mw active heat loads and designated SP 1102, SP 1103 and SP 1104 respectively.

Five coolers of each of the three types were acceptance tested with satisfactory results. All of the coolers were subjected to the shock and vibration testing as called out in the "Operational and Environmental Test Procedure". No performance degradation or mechanical damage resulted from this testing. The Component Evaluation Report is given in the Appendix and

the test data are listed in Table 2 . All of the units were baked at 85°C for 48 hours. The post-bake test data listed in Table 7 showed no change in operating characteristics.

Three TE coolers of each type were stored at -60°C for over 24 hours. One unit of each type was operated at -40°C under nominal heat load conditions. The test data recorded for the tests is shown in Tables 8 and 9 and indicated all operations were normal.

The Coefficient of Performance calculated for each cooler based on test data is shown in Tables 10-13. A summary of the COP data for nominal heat loading is given in Table 22. Performance curves for the three cooler types are shown in Figure 10.

As discussed previously the overall COP design values for the SP 1102 and SP 1103 type coolers were selected to achieve the goal of reduced power consumptions. Based on published material parameters, it was originally felt that the performance could be achieved using the selected COP value. Later, the actual material parameters were measured using computer techniques. These measured quantities were used to determine the coolers predicted performance and the calculated values for T_c with nominal heat loads are listed in the "predicted performance" column of Table 4. However, the cooler designs had been frozen and fabrication of the test coolers was essentially completed by the time the measurements were made. If the measured material parameter values had been available, a lower design figure for COP would have been chosen in order to meet the 193°K specification.

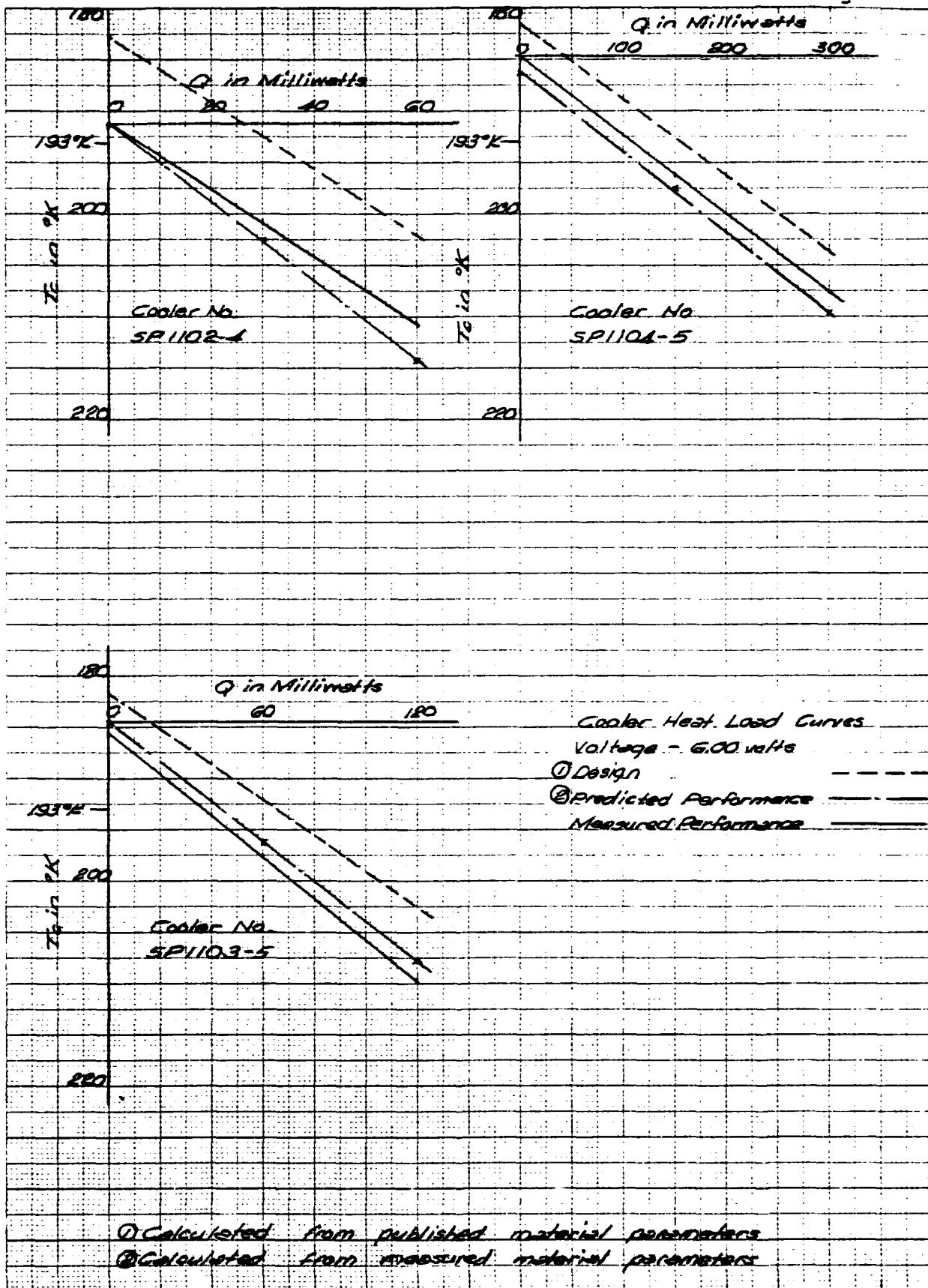
COP - Nominal Heat Load

Table E2

Cooler No.	Stage No.	C.O.P.				AT °C	Active Heat Load kW	T _e in °K			
		Spec.	Design	① Predicted	② Actual			Spec.	Design	③ Predicted	④ Actual
SP1102-4 T _{in} = 29.8 °K	1				.385	16.3	30	193	192.0	202	200.9
	2				.548	20.0					
	3				.537	23.7					
	4				.506	33.9					
	Total	.0086	.0098	.0117	.0117	93.9					
SP1103-5 T _{in} = 29.8 °K	1				.390	18.7	60	193	191.7	195.9	197.6
	2				.604	19.4					
	3				.574	23.3					
	4				.516	36.0					
	Total	.0086	.0109	.0116	.0133	97.4					
SP1104-5 T _{in} = 29.8 °K	1				.463	16.6	150	193	192.5	197.6	196.3
	2				.539	20.8					
	3				.556	25.3					
	4				.512	36.7					
	Total	.0143	.0115	.0120	.0136	99.4					
① Calculated		from published material parameters									
② Calculated		from measured material parameters									
③ Actual test data											

48

Figure 10



Because of the higher COP specification for the SP 1104 type cooler, a somewhat lower design value was used in order to fill the 193°K performance as specified. As above, it was later determined that the measured material parameters, when used to calculate the cooler predicted performance, indicated that the coolers predicted performance would be somewhat lower than that determined from published TE material parameters.

It can be seen that the coolers predicted performance calculations that were based on measured material parameters using the computer technique agree very closely with the measured performance on the test coolers. The comparison is shown in Table 23. The variations are well within those to be expected from manufacturing tolerances and test measurement errors.

A cooler of each type was tested to determine its heat load characteristics and voltage-performance data. The data from these tests is shown in Tables 14 and 15. A radiation shield was mounted onto each of these coolers and the heat load characteristics of the cooler/radiation shield assembly was measured. The data from these tests is given in Table 16.

The measured performance data and the heat load characteristics for the coolers without and with the heat shields are plotted in Figures 11-13. It can be seen that excellent correlation exists between the measured performance data and the predicted performance values determined from computer characterized material parameters and thermoelectric computer modeling techniques.

The measured performance of the SP 1102 and SP 1104 coolers showed an improvement after installation of radiation shielding. However, the improvement was less than anticipated and the SP 1103 cooler showed very little measured performance improvement after the radiation shield was mounted. Only one radiation shield design was investigated.

TABLE 23

Comparison of Cooler Calculations and Measured Performance

	<u>SPEC.</u>	<u>DESIGN</u>	<u>PREDICTED PERFORMANCE</u>	<u>MEASURED PERFORMANCE</u>
1102-4	193	192.0	202.5	200.9
1103-5	193	191.7	195.9	197.6
1104-5	193	192.5	197.6	196.3

Figure 11

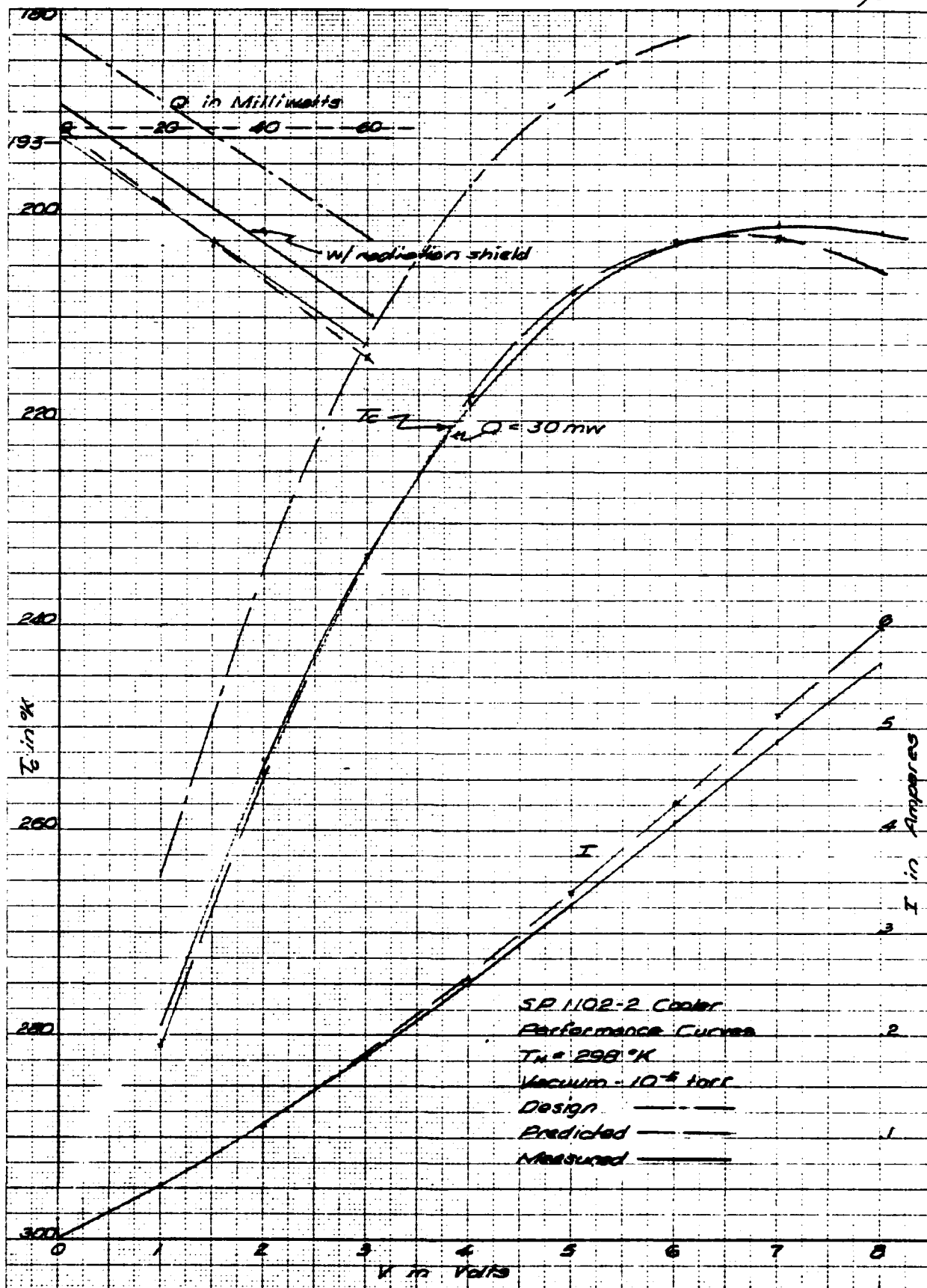


Figure 12

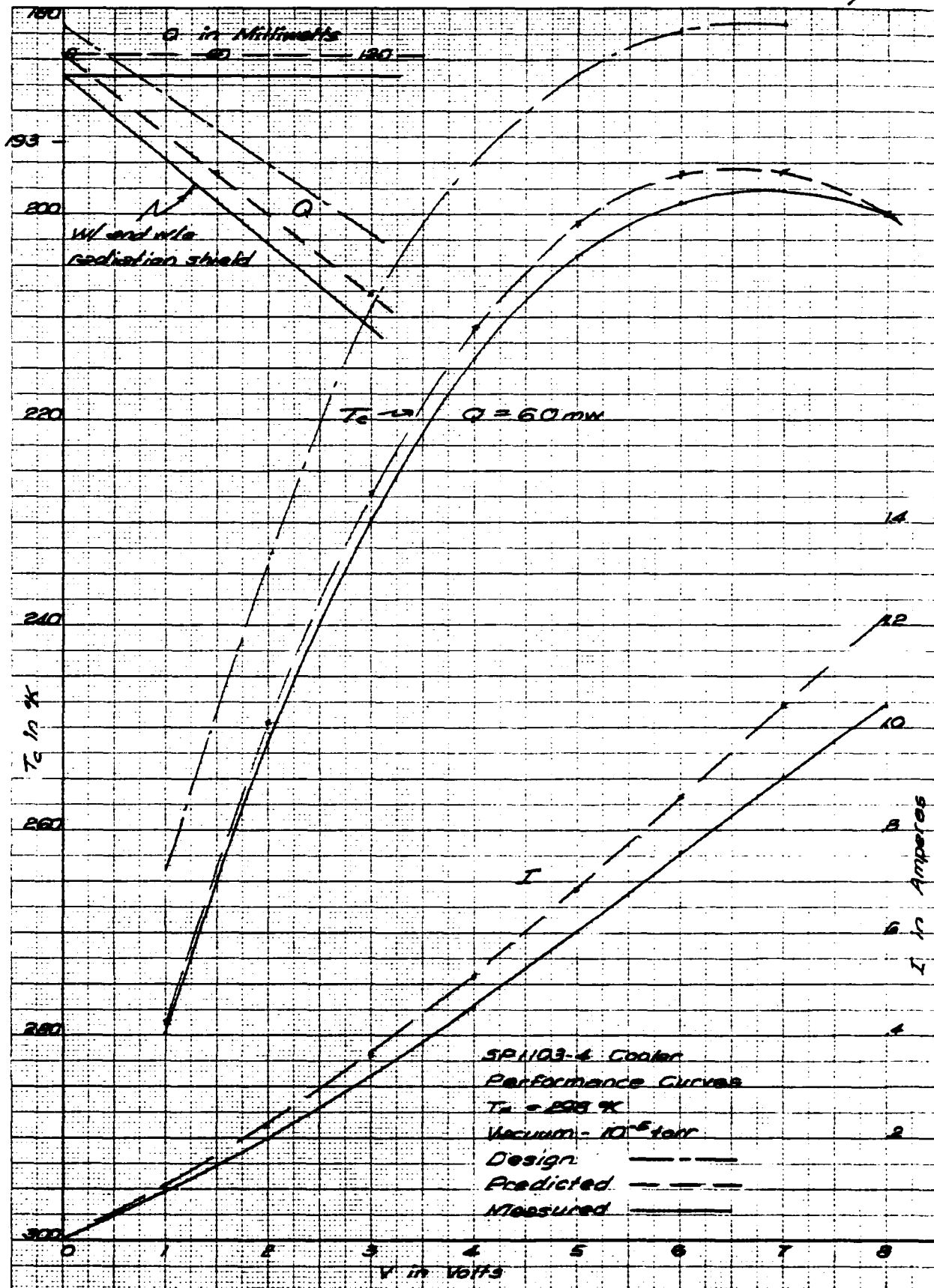
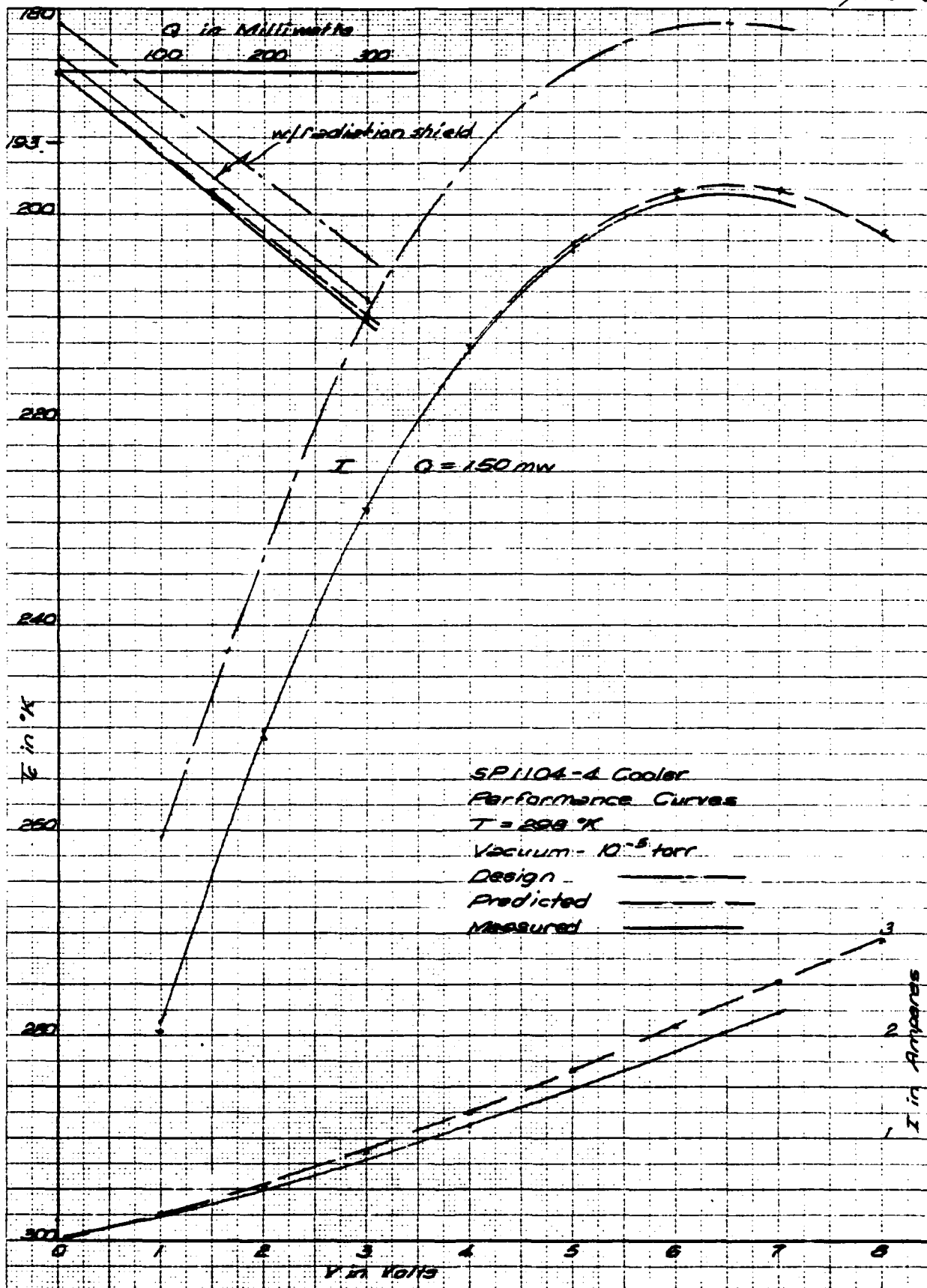


Figure 13



Although beyond the scope of this program, it is felt that further investigation of various shield designs, measurement of the emissivity of materials and finishes, etc., will result in substantial improvement in performance through the use of radiation shielding.

B. Thermoelectric Materials

A total of 48 ingots of TE material were grown during the course of the program. There were 21 p-type ingots and 27 n-type ingots produced. The evaluation of the p-type TE material by parameter measurements and sample cooler performance indicates that it is comparable to commercially available material. However, the n-type material evaluation based on similar measurements shows that it is of somewhat lower quality in performance.

There were a number of problems which arose during the course of the program. All of these problem areas were resolved or solutions developed during the latter phases of the work.

The initial procedure for evaluating the material parameters consisted of the following steps:

- (1) Measurement of the resistivity at 3 equally spaced radii at intervals along the surface of the ingot and averaging the individual values.
- (2) Measurement of the Seebeck coefficient (α) with a heated probe and galvanometer. The output of the sample is compared with that of a standard ingot for which α has been determined.
- (3) Measurement of the characteristics (α , ρ and Z) of a single couple cooler with 1" long elements of n-type and p-type ingots.

- (4) Fabrication of a seven-couple cooler from these materials and determination of α , ρ and Z from cooler performance test data.

With the exception of the resistivity measurements, the techniques described are subject to appreciable measurement error, involve a considerable amount of effort and do not directly measure thermal conductivity (κ). In addition the resulting time delays prevent quick feedback of information for constructive changes in material processing factors.

Computerized measurement techniques were recently developed at Matlow Industries to provide the simultaneous evaluation of the individual quantities α , ρ , and κ on a TE material sample .15" square and .19" long. These quantities can be measured over a temperature range from 190°K to 340°K. Thus, it is possible to provide the basic information for use in material evaluation studies or TE cooler design within a matter of hours after the material is available. In addition, all parameters including thermal conductivity are measured with an accuracy equal to or greater than the previous methods.

Early in the program, arrangements were made with a local vendor to perform chemical analyses on the TE material ingots. The test results appeared to be subject to considerable error and this assumption was verified by NVL laboratory testing. Later, a local laboratory was used to perform the chemical analyses. The analysis data furnished by the latter laboratory and the data from NVL both agreed very closely with that expected from the material quantities used in preparing the TE material samples.

The TE material chemical analyses and parameter measurements indicate the following factors contributed to lower material quality, particularly in the n-type.

(1) Evidence was obtained indicating lack of control of the dopant which was present in the ingot. This was indicated by the wide range of resistivity measurements shown in Figure 14.

(2) Contaminants such as carbon and chlorine were detected through the chemical analyses. These degrade both p-type and n-type TE material.

(3) Measurements indicated that the material was non-uniform from one section of an ingot to the other. These factors have been studied and proposed solutions to each problem area have been generated. These solutions will be evaluated in future experimentation.

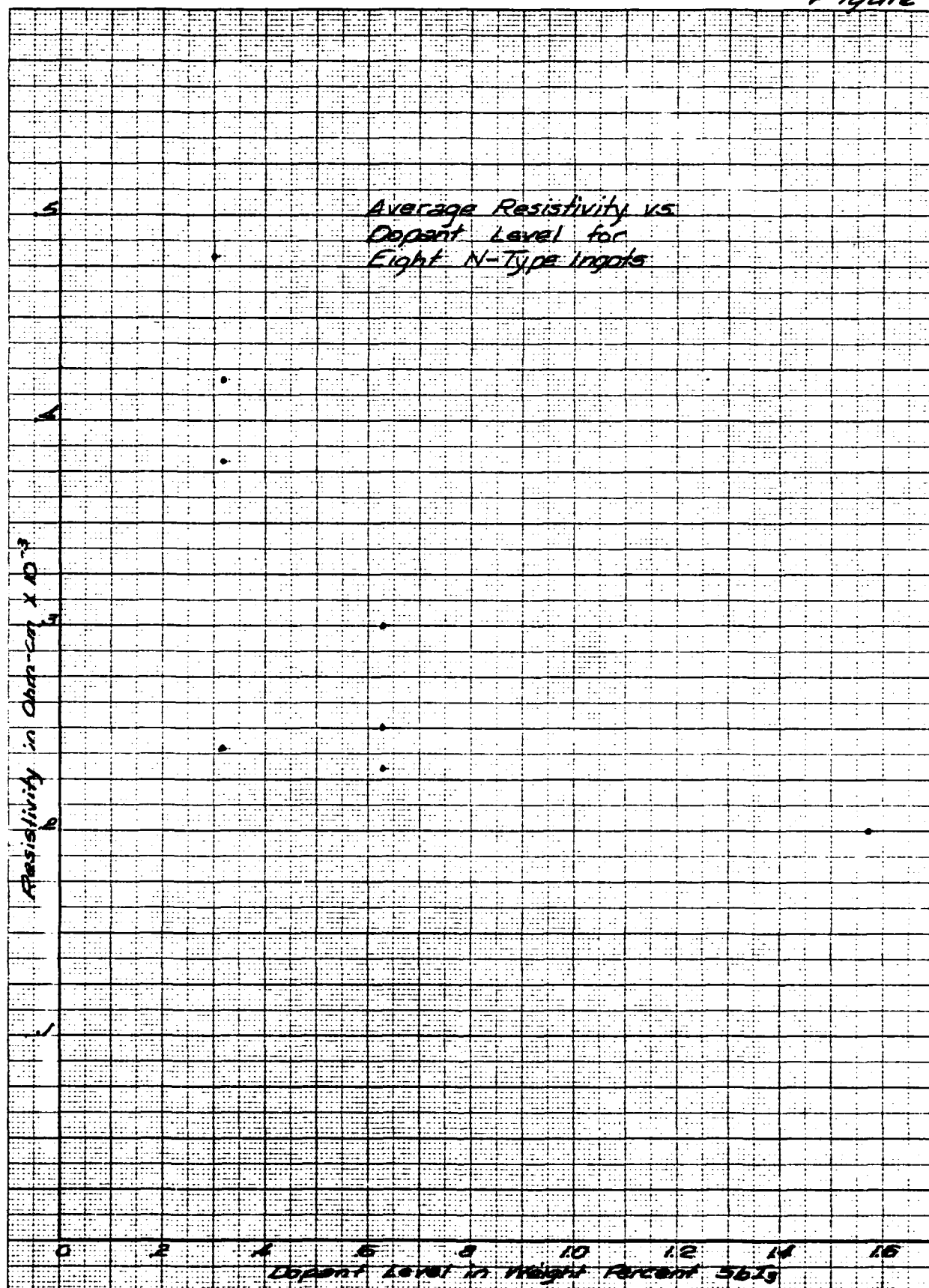
V. CONCLUSIONS

A. Thermoelectric Coolers

1. Test thermoelectric coolers have been fabricated using design and assembly procedures developed at Marlow Industries. Tests on these coolers demonstrate their ability to satisfactorily meet military environmental requirements.

2. Using computer techniques developed by Marlow Industries, α , ρ , κ and Z can now be measured over a temperature range from 190°K to 350°K and will be of major importance on future programs. Extrapolated values of these parameters can be determined over the temperature range from 60°K to 400°K with this technique.

Figure 14



3. The material parameter data, as determined in 2. above, can be utilized by the computer program design technology developed at Marlow Industries to determine all essential cooler design information.

4. The results of testing the coolers designed and fabricated on this program show that the correlation between the measured performance data and the coolers predicted performance is well within manufacturing tolerance and testing variances.

5. The use of radiation shielding enhances thermoelectric cooler performance.

6. P-type TE material was produced which is comparable to commercially available material.

7. Computerized techniques have been developed that will measure directly and simultaneously the TE material parameters (α , ρ , and κ) of a small bulk sample over a wide temperature range.

8. Chemical analyses have confirmed that ingot compositions conform to that of the basic ingredients and that some contaminants were present.

9. Improved processing techniques have been determined that will improve the characteristics of both material types.

VI. RECOMMENDATIONS FOR FURTHER DEVELOPMENT

1. Implement the process improvements that will bring the quality of the n-type material up to that of the p-type and will further improve both types of material.
2. Evaluate TE material processing methods which utilize zone leveling techniques and sintered materials.
3. Investigate the properties (α , ρ and κ) of selected materials at temperatures below 240°K using the recently developed, computerized parameter measurement techniques described previously. This information will be used to optimize thermoelectric materials specifically for use at low temperatures.
4. Utilize a recently expanded facility which provides room for a laboratory specifically designed for thermoelectric material production.
5. Utilize a transient thermal model program that was developed for designing coolers, determining performance capabilities, and overall analysis of integrated systems variables.
6. Utilize Marlow Industries capability to produce its own patterned ceramics which allows full flexibility to utilize to the fullest extent design and material improvements.

APPENDIX

APPENDIX

Table 1	GFE Cooler Test Data
Table 2	TE Material Data, N295
Table 3	TE Material Data, P298
Table 4	TE Material Curve-Fitted Data, N295
Table 5	TE Material Curve-Fitted Data, P298
Table 6	Performance Calculations, SP 1102
Table 7	Performance Calculations, SP 1103
Table 8	Performance Calculations, SP 1104
Table 9	Source and Purity of all Starting Materials
Table 10	P-Type Material Analysis
Table 11	N-Type Material Analysis
Table 12	TE Materials For Single Cooler
Table 13	TE Single Couple Cooler Test Data
Table 14	Microprobe Analysis of Several Ingots
Table 15	TE Material Data, BTXP027
Table 16	TE Material Data, XN008
Table 17	TE Material Curve-Fitted Data, BTXP027
Table 18	TE Material Curve-Fitted Data, XN008

Figure 1	TE Material Characteristics, XN008
Figure 2	TE Material Characteristics, XP027
Figure 3	TE Cooler Performance, No. 2
Figure 4	TE Cooler Performance, No. 3
Figure 5	TE Cooler Performance, No. 4
Figure 6	TE Material Characteristics, BTXP027
Figure 7	TE Material Characteristics, XN008

Shield, MI Dwg. No. 2798
Shield, MI Dwg. No. 2799
Shield, MI Dwg. No. 2800
Product Specification for SP 1102
Product Specification for SP 1103
Product Specification for SP 1104
Operational and Environmental Test Procedure, Dwg. NO. 2898
Component Evaluation Reports (2)
Thermoelectric Material Growth Procedure, MI Dwg. No. 2454

TE Material Data

20102

MARLOW INDUSTRIES

DATE 12:09:78

SAMPLE NAME	SER #	FILE #	DATA POINTS	DATE TESTED
N295BOT	4.1	3.0	12.12	11:08:78/19:44

SO,KO,RO	S1,K1,R1	S2,K2,R2	A,K,R,Z	D,C,V
2.7922E-06	-1.0324E-06	1.2490E-09	-194.535	69.2648
3.5086E-02	-1.2231E-04	1.8359E-07	14.918	-50.9797
-3.4896E-05	2.5718E-06	2.5809E-09	9.689	-0.1099
			2.618	

TEMP K	ALPHA (V/DEG C)	KAPPA (W/CM*DEG C)	RHO (OHM/CM)	Z (/DEG K)
345.24	-2.0433E-04	1.4944E-02	1.1565E-03	2.4157E-03
	-2.0478E-04	1.4744E-02	1.1606E-03	2.4508E-03
	-0.223	1.357	-0.352	-1.432
331.82	-2.0317E-04	1.4619E-02	1.1049E-03	2.5558E-03
	-2.0228E-04	1.4717E-02	1.1026E-03	2.5214E-03
	0.443	-0.668	0.202	1.362
318.41	-1.9792E-04	1.4518E-02	1.0456E-03	2.5806E-03
	-1.9932E-04	1.4756E-02	1.0456E-03	2.5749E-03
	-0.704	-1.615	-0.005	0.221
302.73	-1.9665E-04	1.4963E-02	9.8399E-04	2.6264E-03
	-1.9530E-04	1.4886E-02	9.8018E-04	2.6141E-03
	0.690	0.516	0.389	0.474
288.28	-1.8994E-04	1.4895E-02	9.2069E-04	2.6307E-03
	-1.9105E-04	1.5085E-02	9.2098E-04	2.6271E-03
	-0.579	-1.262	-0.032	0.139
272.28	-1.8740E-04	1.5724E-02	8.5639E-04	2.6080E-03
	-1.8573E-04	1.5396E-02	8.5670E-04	2.6154E-03
	0.900	2.134	-0.036	-0.284
258.04	-1.8162E-04	1.6143E-02	7.9968E-04	2.5552E-03
	-1.8046E-04	1.5751E-02	8.0056E-04	2.5825E-03
	0.645	2.489	-0.109	-1.057
243.92	-1.7241E-04	1.5573E-02	7.4655E-04	2.5569E-03
	-1.7473E-04	1.6176E-02	7.4598E-04	2.5301E-03
	-1.327	-3.731	0.077	1.059
227.09	-1.6802E-04	1.7147E-02	6.8194E-04	2.4144E-03
	-1.6726E-04	1.6780E-02	6.8224E-04	2.4438E-03
	0.457	2.190	-0.043	-1.203
210.14	-1.5705E-04	1.7271E-02	6.1783E-04	2.3115E-03
	-1.5901E-04	1.7492E-02	6.1952E-04	2.3334E-03
	-1.235	-1.262	-0.273	-0.938
198.57	-1.5551E-04	1.8454E-02	5.7679E-04	2.2720E-03
	-1.5298E-04	1.8039E-02	5.7756E-04	2.2461E-03
	1.656	2.301	-0.133	1.149
192.85	-1.4906E-04	1.8046E-02	5.5889E-04	2.2031E-03
	-1.4987E-04	1.8327E-02	5.5707E-04	2.1999E-03
	-0.537	-1.536	0.327	0.146

TE Material Data

MARLOW INDUSTRIES

DATE

Table 3

12:09:78

SAMPLE NAME	SER #	FILE #	DATA POINTS	DATE TESTED
P298 BOT	2.1	7.0	12.12	11:13:78/13:56

SO,KO,RO	S1,K1,R1	S2,K2,R2	A,K,R,Z	D,C,V
-2.6875E-05	1.1227E-06	-1.2956E-09	193.336	67.8562
2.9469E-02	7.2232E-05	6.9207E-08	14.028	49.1680
5.5395E-05	9.7876E-07	7.5521E-09	10.287	0.1081
			2.590	

TEMP K	ALPHA (V/DEG C)	KAPPA (W/CM*DEG C)	RHO (OHM/CM)	Z (/DEG K)
342.28	2.0682E-04 2.0562E-04 0.583	1.2929E-02 1.2853E-02 0.590	1.2713E-03 1.2752E-03 -0.307	2.6024E-03 2.5796E-03 0.885
328.99	2.0149E-04 2.0226E-04 -0.379	1.3421E-02 1.3196E-02 1.709	1.1953E-03 1.1948E-03 0.036	2.5309E-03 2.5947E-03 -2.459
315.86	1.9799E-04 1.9849E-04 -0.251	1.3311E-02 1.3558E-02 -1.821	1.1177E-03 1.1180E-03 -0.029	2.6348E-03 2.5991E-03 1.374
300.56	1.9184E-04 1.9353E-04 -0.873	1.3772E-02 1.4011E-02 -1.706	1.0335E-03 1.0318E-03 0.163	2.5857E-03 2.5908E-03 -0.197
286.57	1.8960E-04 1.8846E-04 0.605	1.4416E-02 1.4453E-02 -0.257	9.5822E-04 9.5606E-04 0.226	2.6025E-03 2.5705E-03 1.245
270.60	1.8287E-04 1.8206E-04 0.445	1.4976E-02 1.4991E-02 -0.096	8.7584E-04 8.7322E-04 0.299	2.5496E-03 2.5321E-03 0.689
256.35	1.7486E-04 1.7579E-04 -0.529	1.5411E-02 1.5500E-02 -0.574	8.0454E-04 8.0258E-04 0.244	2.4660E-03 2.4841E-03 -0.727
242.02	1.6930E-04 1.6896E-04 0.201	1.6486E-02 1.6041E-02 2.771	7.3246E-04 7.3462E-04 -0.295	2.3736E-03 2.4224E-03 -2.016
224.99	1.6318E-04 1.6014E-04 1.896	1.7232E-02 1.6721E-02 3.057	6.5409E-04 6.5789E-04 -0.578	2.3623E-03 2.3313E-03 1.333
206.87	1.4960E-04 1.4994E-04 -0.227	1.7602E-02 1.7488E-02 0.650	5.8023E-04 5.8107E-04 -0.145	2.1912E-03 2.2123E-03 -0.953
194.76	1.3507E-04 1.4264E-04 -5.310	1.6406E-02 1.8026E-02 -8.987	5.3510E-04 5.3247E-04 0.494	2.0780E-03 2.1197E-03 -1.968
188.97	1.4602E-04 1.3902E-04 5.038	1.9805E-02 1.8291E-02 8.277	5.0959E-04 5.1004E-04 -0.088	2.1128E-03 2.0717E-03 1.986

TE Material Curve Fitted Data
MARLOW INDUSTRIES

T56k4
DATE 12:09:78

SAMPLE NAME	SER #	FILE #	DATA POINTS	DATE TESTED
N295BOT	4.1	3.0	12.12	11:08:78/19:44

SO,KO,RO	S1,K1,R1	S2,K2,R2	A,K,R,Z	D,C,V
2.7922E-06	-1.0324E-06	1.2490E-09	-194.535	69.2648
3.5086E-02	-1.2231E-04	1.8359E-07	14.918	-50.9797
-3.4896E-05	2.5718E-06	2.5809E-09	9.689	-0.1099
			2.618	

TEMP K	ALPHA (V/DEG C)	KAPPA (W/CM*DEG C)	RHO (OHM/CM)	Z (/DEG K)
400.00	-2.1035E-04	1.5538E-02	1.4068E-03	2.0243E-03
390.00	-2.0989E-04	1.5311E-02	1.3607E-03	2.1147E-03
380.00	-2.0919E-04	1.5120E-02	1.3151E-03	2.2007E-03
370.00	-2.0823E-04	1.4967E-02	1.2700E-03	2.2812E-03
360.00	-2.0702E-04	1.4849E-02	1.2254E-03	2.3553E-03
350.00	-2.0557E-04	1.4769E-02	1.1814E-03	2.4219E-03
340.00	-2.0386E-04	1.4725E-02	1.1379E-03	2.4803E-03
330.00	-2.0190E-04	1.4718E-02	1.0949E-03	2.5297E-03
320.00	-1.9970E-04	1.4748E-02	1.0524E-03	2.5695E-03
310.00	-1.9724E-04	1.4814E-02	1.0104E-03	2.5991E-03
300.00	-1.9453E-04	1.4918E-02	9.6892E-04	2.6182E-03
290.00	-1.9158E-04	1.5058E-02	9.2797E-04	2.6267E-03
280.00	-1.8837E-04	1.5234E-02	8.8755E-04	2.6244E-03
270.00	-1.8492E-04	1.5447E-02	8.4763E-04	2.6115E-03
260.00	-1.8121E-04	1.5697E-02	8.0824E-04	2.5883E-03
250.00	-1.7726E-04	1.5984E-02	7.6936E-04	2.5550E-03
240.00	-1.7305E-04	1.6308E-02	7.3099E-04	2.5122E-03
230.00	-1.6860E-04	1.6668E-02	6.9314E-04	2.4604E-03
220.00	-1.6390E-04	1.7065E-02	6.5581E-04	2.4002E-03
210.00	-1.5894E-04	1.7498E-02	6.1900E-04	2.3323E-03
200.00	-1.5374E-04	1.7969E-02	5.8270E-04	2.2574E-03
190.00	-1.4828E-04	1.8476E-02	5.4691E-04	2.1761E-03
180.00	-1.4258E-04	1.9020E-02	5.1165E-04	2.0891E-03
170.00	-1.3663E-04	1.9600E-02	4.7689E-04	1.9971E-03
160.00	-1.3043E-04	2.0217E-02	4.4266E-04	1.9008E-03
150.00	-1.2397E-04	2.0871E-02	4.0894E-04	1.8007E-03
140.00	-1.1727E-04	2.1562E-02	3.7574E-04	1.6975E-03
130.00	-1.1032E-04	2.2289E-02	3.4305E-04	1.5916E-03
120.00	-1.0312E-04	2.3053E-02	3.1088E-04	1.4836E-03
110.00	-9.5664E-05	2.3854E-02	2.7923E-04	1.3740E-03
100.00	-8.7963E-05	2.4692E-02	2.4809E-04	1.2631E-03
90.00	-8.0011E-05	2.5566E-02	2.1747E-04	1.1514E-03
80.00	-7.1810E-05	2.6477E-02	1.8736E-04	1.0395E-03
70.00	-6.3359E-05	2.7425E-02	1.5777E-04	9.2777E-04
60.00	-5.4658E-05	2.8409E-02	1.2870E-04	8.1709E-04

TE Material Curve Fitted Data

TE 6103

MARLOW INDUSTRIES

DATE 12:09:78

SAMPLE NAME	SER #	FILE #	DATA POINTS	DATE TESTED
P298BOT	2.1	7.0	12.12	11:13:78/13:56

SO,KO,RO	S1,K1,R1	S2,K2,R2	A,K,R,Z	D,C,V
-2.6875E-05	1.1227E-06	-1.2956E-09	193.336	67.8562
2.9469E-02	-7.2232E-05	6.9207E-08	14.028	49.1680
5.5395E-05	9.7876E-07	7.5521E-09	10.287	0.1081
			2.590	

TEMP K	ALPHA (V/DEG C)	KAPPA (W/CM*DEG C)	RHO (OHM/CM)	Z (/DEG K)
400.00	2.1492E-04	1.1649E-02	1.6552E-03	2.3954E-03
390.00	2.1392E-04	1.1825E-02	1.5658E-03	2.4405E-03
380.00	2.1267E-04	1.2014E-02	1.5179E-03	2.4803E-03
370.00	2.1116E-04	1.2218E-02	1.4514E-03	2.5145E-03
360.00	2.0939E-04	1.2435E-02	1.3865E-03	2.5431E-03
350.00	2.0736E-04	1.2666E-02	1.3231E-03	2.5660E-03
340.00	2.0508E-04	1.2910E-02	1.2612E-03	2.5829E-03
330.00	2.0253E-04	1.3169E-02	1.2008E-03	2.5939E-03
320.00	1.9973E-04	1.3442E-02	1.1419E-03	2.5988E-03
310.00	1.9666E-04	1.3728E-02	1.0846E-03	2.5976E-03
300.00	1.9334E-04	1.4028E-02	1.0287E-03	2.5902E-03
290.00	1.8975E-04	1.4342E-02	9.7437E-04	2.5766E-03
280.00	1.8591E-04	1.4670E-02	9.2154E-04	2.5567E-03
270.00	1.8181E-04	1.5012E-02	8.7021E-04	2.5304E-03
260.00	1.7745E-04	1.5367E-02	8.2040E-04	2.4977E-03
250.00	1.7283E-04	1.5736E-02	7.7209E-04	2.4584E-03
240.00	1.6795E-04	1.6120E-02	7.2530E-04	2.4126E-03
230.00	1.6281E-04	1.6517E-02	6.8002E-04	2.3601E-03
220.00	1.5742E-04	1.6928E-02	6.3625E-04	2.3008E-03
210.00	1.5176E-04	1.7352E-02	5.9398E-04	2.2345E-03
200.00	1.4584E-04	1.7791E-02	5.5323E-04	2.1611E-03
190.00	1.3967E-04	1.8243E-02	5.1399E-04	2.0804E-03
180.00	1.3324E-04	1.8710E-02	4.7626E-04	1.9922E-03
170.00	1.2654E-04	1.9190E-02	4.4004E-04	1.8964E-03
160.00	1.1959E-04	1.9684E-02	4.0533E-04	1.7927E-03
150.00	1.1238E-04	2.0191E-02	3.7213E-04	1.6809E-03
140.00	1.0491E-04	2.0713E-02	3.4044E-04	1.5609E-03
130.00	9.7183E-05	2.1248E-02	3.1026E-04	1.4326E-03
120.00	8.9195E-05	2.1798E-02	2.8160E-04	1.2961E-03
110.00	8.0947E-05	2.2361E-02	2.5444E-04	1.1517E-03
100.00	7.2441E-05	2.2938E-02	2.2879E-04	9.9994E-04
90.00	6.3676E-05	2.3529E-02	2.0466E-04	8.4202E-04
80.00	5.4651E-05	2.4133E-02	1.8203E-04	6.7988E-04
70.00	4.5367E-05	2.4752E-02	1.6091E-04	5.1675E-04
60.00	3.5824E-05	2.5384E-02	1.4131E-04	3.5778E-04

SP02T,DAT(50541,1)

17131 13-JAN-79

PAGE 1

PERFORMANCE CALCULATIONS GENERATED 13-JAN-79 17:05
 THERMAL MODEL GENERATED 13-JAN-79 17:03
 SP 1102 13-JAN-79 16:59

TH	TC	Q	I	V	P	COP
298.0	267.1	0.000	0.050	1.000	0.050	0.00000
298.0	281.1	0.030	0.054	1.000	0.054	0.56049
298.0	295.4	0.060	0.057	1.000	0.057	1.05649
298.0	240.9	0.000	0.110	2.000	0.219	0.00000
298.0	254.3	0.030	0.112	2.000	0.225	0.13342
298.0	268.2	0.060	0.116	2.000	0.231	0.25964
298.0	220.4	0.000	0.178	3.000	0.533	0.00000
298.0	233.1	0.030	0.180	3.000	0.541	0.05545
298.0	246.3	0.060	0.183	3.000	0.549	0.10920
298.0	205.5	0.000	0.255	4.000	1.018	0.00000
298.0	217.5	0.030	0.257	4.000	1.027	0.02922
298.0	230.1	0.060	0.259	4.000	1.036	0.05790
298.0	196.0	0.000	0.338	5.000	1.690	0.00000
298.0	207.4	0.030	0.340	5.000	1.698	0.01766
298.0	219.5	0.060	0.342	5.000	1.708	0.03513
298.0	191.4	0.000	0.425	6.000	2.553	0.00000
298.0	202.4	0.030	0.427	6.000	2.560	0.01172
298.0	214.0	0.060	0.428	6.000	2.568	0.02336
298.0	191.4	0.000	0.514	7.000	3.595	0.00000
298.0	202.0	0.030	0.514	7.000	3.600	0.00833
298.0	213.2	0.060	0.515	7.000	3.605	0.01664
298.0	195.3	0.000	0.599	8.000	4.791	0.00000
298.0	205.8	0.030	0.599	8.000	4.793	0.00626
298.0	216.7	0.060	0.599	8.000	4.794	0.01251
298.0	202.6	0.000	0.678	9.000	6.106	0.00000
298.0	213.3	0.030	0.678	9.000	6.103	0.00492
298.0	224.0	0.060	0.678	9.000	6.100	0.00984

SP03T,DAT(50541,1)

17:31 13-JAN-79

PAGE 1

PERFORMANCE CALCULATIONS GENERATED 13-JAN-79 17:15

THERMAL MODEL GENERATED 13-JAN-79 17:14

SP 1103 NO SHIELD 13-JAN-79 17:11

TH	TC	Q	I	V	P	COP
298.0	263.4	0.000	0.099	1.000	0.099	0.00000
298.0	278.6	0.060	0.106	1.000	0.106	0.56695
298.0	294.2	0.120	0.113	1.000	0.113	1.06059
298.0	235.2	0.000	0.217	2.000	0.434	0.00000
298.0	249.5	0.060	0.223	2.000	0.447	0.13437
298.0	264.1	0.120	0.230	2.000	0.460	0.26079
298.0	213.8	0.000	0.355	3.000	1.064	0.00000
298.0	227.1	0.060	0.360	3.000	1.081	0.05549
298.0	240.8	0.120	0.366	3.000	1.099	0.10916
298.0	198.5	0.000	0.511	4.000	2.044	0.00000
298.0	211.0	0.060	0.516	4.000	2.063	0.02908
298.0	223.9	0.120	0.521	4.000	2.083	0.05760
298.0	188.9	0.000	0.682	5.000	3.409	0.00000
298.0	200.8	0.060	0.685	5.000	3.427	0.01751
298.0	213.0	0.120	0.689	5.000	3.447	0.03481
298.0	184.5	0.000	0.861	6.000	5.167	0.00000
298.0	195.9	0.060	0.864	6.000	5.182	0.01158
298.0	207.6	0.120	0.866	6.000	5.199	0.02308
298.0	184.8	0.000	1.042	7.000	7.292	0.00000
298.0	195.8	0.060	1.043	7.000	7.302	0.00822
298.0	207.1	0.120	1.045	7.000	7.313	0.01641
298.0	189.2	0.000	1.216	8.000	9.732	0.00000
298.0	200.0	0.060	1.217	8.000	9.734	0.00616
298.0	211.1	0.120	1.217	8.000	9.737	0.01232
298.0	197.3	0.000	1.379	9.000	12.409	0.00000
298.0	208.1	0.060	1.378	9.000	12.401	0.00484
298.0	219.1	0.120	1.377	9.000	12.395	0.00968

SP04T,DAT[50541,1]

17131 13-JAN-79

PAGE 1

PERFORMANCE CALCULATIONS GENERATED 13-JAN-79 17125

THERMAL MODEL GENERATED 13-JAN-79 17123

SP 1104 NO SHIELD 13-JAN-79 17120

TH	TC	Q	I	V	P	COP
298.0	264.5	0.000	0.241	1.000	0.241	0.00000
298.0	279.5	0.150	0.257	1.000	0.257	0.58340
298.0	295.1	0.300	0.275	1.000	0.275	1.09142
298.0	236.8	0.000	0.527	2.000	1.053	0.00000
298.0	250.9	0.150	0.542	2.000	1.084	0.13839
298.0	265.8	0.300	0.559	2.000	1.117	0.26852
298.0	215.5	0.000	0.860	3.000	2.581	0.00000
298.0	228.8	0.150	0.874	3.000	2.622	0.05721
298.0	242.7	0.300	0.889	3.000	2.666	0.11251
298.0	200.3	0.000	1.238	4.000	4.954	0.00000
298.0	212.8	0.150	1.250	4.000	4.999	0.03001
298.0	226.0	0.300	1.262	4.000	5.049	0.05942
298.0	190.7	0.000	1.651	5.000	8.256	0.00000
298.0	202.6	0.150	1.660	5.000	8.299	0.01807
298.0	215.1	0.300	1.670	5.000	8.349	0.03593
298.0	186.3	0.000	2.084	6.000	12.506	0.00000
298.0	197.6	0.150	2.090	6.000	12.543	0.01196
298.0	209.7	0.300	2.097	6.000	12.584	0.02384
298.0	186.5	0.000	2.521	7.000	17.646	0.00000
298.0	197.5	0.150	2.524	7.000	17.670	0.00849
298.0	209.1	0.300	2.528	7.000	17.697	0.01695
298.0	190.8	0.000	2.943	8.000	23.542	0.00000
298.0	201.6	0.150	2.944	8.000	23.550	0.00637
298.0	213.0	0.300	2.945	8.000	23.557	0.01273
298.0	198.5	0.000	3.335	9.000	30.017	0.00000
298.0	209.7	0.150	3.333	9.000	29.998	0.00500
298.0	220.9	0.300	3.331	9.000	29.982	0.01001

TABLE 9

SOURCE AND PURITY OF ALL STARTING RAW MATERIALS

Source: Kawecki-Berylco Industries
P.O. Box 567
Boyertown, Pennsylvania 19512

Purity: Bismuth 5 9's i.e. 99.999
Tellurium 5 9's
Antimony 5 9's
Selenium 5 9's

Source: Alfa Division
Ventron Corporation
16207 So. Carmenita Road
Cerritos, California 90701

Purity: Antimony Iodide 99%

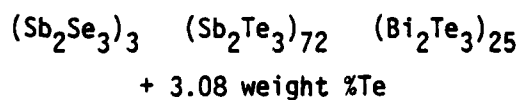
TABLE 10

P-Type Material Analysis

Molar ratio of starting compounds
(Calculated from weight data on material growth record)

Sample	Bi	Te	Sb	Se	Excess Te
XP015	9.942	58.484	29.800	1.774	
XP022	9.701	59.449	29.100	1.751	
XP024	5.874	61.066	30.261	2.798	
XP027	9.801	59.038	29.393	1.769	
XP028	9.701	59.449	29.100	1.751	

* These values basically conform to the formula:



Except sample XP024, which fits the formula:

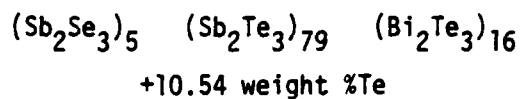
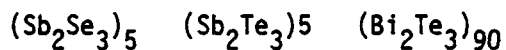


TABLE 11

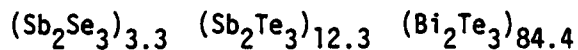
N-Type Material Analysis
Molar ratio of starting compounds
(Calculated from weight data on material growth record)

Sample	Bi	Te	Sb	Se	Excess Te
XN008	35.630	56.385	6.046	1.923	
XN012	35.994	57.009	3.977	3.088	
XN021	35.905	56.890	4.008	3.001	
XN022	35.948	56.923	3.997	3.033	
XN029	35.912	56.912	4.009	2.982	
XN030B	35.912	56.901	4.009	2.892	
XN030T	35.912	56.901	4.009	2.982	
XN032	35.968	56.970	4.014	3.049	

These values conform to the formula:



Except sample SN008, the corresponding formula is:



+3.92 weight % Bismuth

TABLE 12
TE MATERIAL PARAMETERS FOR SINGLE COUPLE

(Elements: 12mm diameter, 1 inch long)

XP007

Position	$\alpha \times 10^{-4}$ V/°C	$\rho \times 10^{-4}$ ohm cm	$Z \times 10^{-3}$ °K ⁻¹
1	1.675	19.5	0.959
2	2.050	18.0	1.556
3	1.675	17.0	1.100
4	1.675	17.0	1.100

XN008

Position	$\alpha \times 10^{-4}$ V/°C	$\rho \times 10^{-4}$ ohm cm	$Z \times 10^{-3}$ °K ⁻¹
1	0.775	9.0	0.444
2	1.25	7.5	1.388
3	0.575	7.75	0.284
4	0.250	6.75	0.062

SAMPLE NAME	SER #	FILE #	DATA POINTS	DATE TESTED
BTXP027	16.0	17.0	12.12	12:01:02:04:41

SO,KO,RO	S1,K1,R1	S2,K2,R2	A,K,R,Z	E,C,V
-1.4317E-04	1.8840E-06	-2.5617E-09	191.485	63.9368
8.2479E-03	7.9572E-05	-1.8744E-07	15.250	49.0889
5.8306E-05	4.9752E-07	9.2321E-09	10.384	0.1067
			2.315	

TEMP K	ALPHA (V/DEG C)	KAPPA (W/CM*DEG C)	RHO (OHM/CM)	Z (/DEG K)
340.33	2.0278E-04 2.0131E-04 0.727	1.3740E-02 1.3619E-02 0.890	1.2957E-03 1.2970E-03 -0.095	2.3096E-03 2.2945E-03 0.659
329.18	2.0027E-04 1.9943E-04 0.423	1.4342E-02 1.4131E-02 1.492	1.2206E-03 1.2224E-03 -0.151	2.2912E-03 2.3024E-03 -0.484
317.13	1.9470E-04 1.9668E-04 -1.004	1.4286E-02 1.4632E-02 -2.366	1.1465E-03 1.1446E-03 0.170	2.3146E-03 2.3098E-03 0.207
303.35	1.8959E-04 1.9262E-04 -1.570	1.4907E-02 1.5138E-02 -1.526	1.0603E-03 1.0588E-03 0.145	2.2742E-03 2.3149E-03 -1.757
290.17	1.8970E-04 1.8783E-04 0.997	1.5688E-02 1.5555E-02 0.855	9.8122E-04 9.8003E-04 0.122	2.3377E-03 2.3142E-03 1.016
275.22	1.8143E-04 1.8132E-04 0.065	1.5827E-02 1.5950E-02 -0.771	8.9403E-04 8.9455E-04 -0.058	2.3264E-03 2.3041E-03 0.966
261.54	1.7095E-04 1.7435E-04 -1.953	1.5607E-02 1.6238E-02 -3.887	8.1836E-04 8.1995E-04 -0.193	2.2800E-03 2.2832E-03 0.213
247.54	1.7315E-04 1.6623E-04 4.165	1.8171E-02 1.6460E-02 10.395	7.4659E-04 7.4715E-04 -0.075	2.2101E-03 2.2469E-03 -1.640
231.26	1.5742E-04 1.5553E-04 1.216	1.7182E-02 1.6625E-02 3.347	6.7058E-04 6.6712E-04 0.518	2.1503E-03 2.1810E-03 -1.383
214.63	1.3995E-04 1.4319E-04 -2.263	1.5866E-02 1.6692E-02 -4.948	5.8635E-04 5.9036E-04 -0.679	2.1053E-03 2.0806E-03 1.186
203.24	1.2911E-04 1.2392E-04 -3.597	1.5557E-02 1.6678E-02 -6.722	5.4200E-04 5.4076E-04 0.229	1.9769E-03 1.9887E-03 -0.595
197.54	1.3422E-04 1.2904E-04 4.018	1.8115E-02 1.6652E-02 8.782	5.1729E-04 5.1684E-04 0.087	1.9226E-03 1.9347E-03 -0.624

MARLOW INDUSTRIES

Table 16
DATE 12:09:78

SAMPLE NAME	SER #	FILE #	DATA POINTS	DATE TESTED
XN008	13.0	14.0	12.12	11:17:78/08:14
SO,KO,RO	S1,K1,R1	S2,K2,R2	A,K,R,Z	D,C,V
-5.1643E-05	-5.2514E-07	4.9999E-10	-164.185	48.7533
3.4656E-02	-8.8404E-05	9.9959E-08	17.131	-43.8167
6.9721E-05	2.1446E-06	3.2573E-09	10.063	-0.0950
			1.564	
TEMP K	ALPHA (V/DEG C)	KAPPA (W/CM*DEG C)	RHO (OHM/CM)	Z (/DEG K)
340.11	-1.7279E-04	1.7063E-02	1.1732E-03	1.4915E-03
	-1.7241E-04	1.6152E-02	1.1759E-03	1.5651E-03
	0.221	5.641	-0.229	-4.702
327.83	-1.6754E-04	1.5213E-02	1.1266E-03	1.6377E-03
	-1.7006E-04	1.6418E-02	1.1228E-03	1.5689E-03
	-1.485	-7.336	0.333	4.387
315.36	-1.7073E-04	1.7200E-02	1.0669E-03	1.5885E-03
	-1.6753E-04	1.6718E-02	1.0700E-03	1.5689E-03
	1.915	2.883	-0.292	1.252
301.36	-1.6290E-04	1.6887E-02	1.0156E-03	1.5473E-03
	-1.6449E-04	1.7093E-02	1.0118E-03	1.5644E-03
	-0.967	-1.205	0.370	-1.094
288.49	-1.6188E-04	1.7604E-02	9.5872E-04	1.5527E-03
	-1.6153E-04	1.7472E-02	9.5950E-04	1.5563E-03
	0.220	0.756	-0.081	-0.232
273.79	-1.5977E-04	1.8283E-02	9.0200E-04	1.5479E-03
	-1.5794E-04	1.7945E-02	9.0105E-04	1.5427E-03
	1.159	1.882	0.105	0.337
260.89	-1.5483E-04	1.8661E-02	8.4920E-04	1.5127E-03
	-1.5461E-04	1.8396E-02	8.5093E-04	1.5272E-03
	0.136	1.439	-0.204	-0.948
247.63	-1.5036E-04	1.8710E-02	8.0008E-04	1.5104E-03
	-1.5102E-04	1.8894E-02	8.0011E-04	1.5079E-03
	-0.436	-0.978	-0.054	0.162
231.87	-1.4438E-04	1.9031E-02	7.4251E-04	1.4752E-03
	-1.4652E-04	1.9532E-02	7.4211E-04	1.4812E-03
	-1.461	-2.565	0.055	-0.400
216.10	-1.4264E-04	2.0555E-02	6.8440E-04	1.4463E-03
	-1.4178E-04	2.0220E-02	6.8530E-04	1.4506E-03
	0.606	1.655	-0.132	-0.301
203.1	-1.3853E-04	2.1577E-02	6.5081E-04	1.3687E-03
	-1.3854E-04	2.0696E-02	6.4907E-04	1.4289E-03
	0.067	4.256	0.268	-4.211
	-1.3722E-04	2.0206E-02	6.3039E-04	1.4782E-03
	-1.3688E-04	2.0942E-02	6.3119E-04	1.4175E-03
	0.245	-3.515	-0.128	4.284

Table 17

MARLOW INDUSTRIES

DATE 12:09:78

SAMPLE NAME BTXP027 SER # 16.0 FILE # 17.0 DATA POINTS 12.12 DATE TESTED 12:01:02:04:41

SO,KO,RO	S1,K1,R1	S2,K2,R2	A,K,R,Z	D,C,V
-1.4317E-04	1.8840E-06	-2.5617E-09	191.485	63.9368
8.2479E-03	7.9572E-05	-1.8744E-07	15.250	49.0889
5.8306E-05	4.9752E-07	9.2321E-09	10.384	0.1067
			2.315	

TEMP K	ALPHA (V/DEG C)	KAPPA (W/CM*DEG C)	RHO (OHM/CM)	Z (/DEG K)
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400.00	2.0057E-04	1.0087E-02	1.7344E-03	2.2994E-03
390.00	2.0197E-04	1.0772E-02	1.6565E-03	2.2859E-03
380.00	2.0285E-04	1.1419E-02	1.5805E-03	2.2799E-03
370.00	2.0322E-04	1.2029E-02	1.5063E-03	2.2793E-03
360.00	2.0308E-04	1.2602E-02	1.4339E-03	2.2824E-03

350.00	2.0243E-04	1.3137E-02	1.3634E-03	2.2879E-03
340.00	2.0127E-04	1.3635E-02	1.2947E-03	2.2947E-03
330.00	1.9959E-04	1.4095E-02	1.2279E-03	2.3018E-03
320.00	1.9740E-04	1.4517E-02	1.1629E-03	2.3082E-03
310.00	1.9470E-04	1.4903E-02	1.0997E-03	2.3130E-03

300.00	1.9149E-04	1.5250E-02	1.0384E-03	2.3153E-03
290.00	1.8776E-04	1.5560E-02	9.7900E-04	2.3142E-03
280.00	1.8352E-04	1.5833E-02	9.2141E-04	2.3086E-03
270.00	1.7877E-04	1.6068E-02	8.6565E-04	2.2976E-03
260.00	1.7351E-04	1.6266E-02	8.1175E-04	2.2800E-03

250.00	1.6773E-04	1.6426E-02	7.5969E-04	2.2545E-03
240.00	1.6144E-04	1.6549E-02	7.0948E-04	2.2199E-03
230.00	1.5464E-04	1.6634E-02	6.6111E-04	2.1746E-03
220.00	1.4733E-04	1.6682E-02	6.1459E-04	2.1172E-03
210.00	1.3951E-04	1.6692E-02	5.6992E-04	2.0458E-03

200.00	1.3117E-04	1.6665E-02	5.2709E-04	1.9587E-03
190.00	1.2232E-04	1.6600E-02	4.8611E-04	1.8541E-03
180.00	1.1296E-04	1.6498E-02	4.4698E-04	1.7302E-03
170.00	1.0308E-04	1.6358E-02	4.0969E-04	1.5855E-03
160.00	9.2696E-05	1.6181E-02	3.7425E-04	1.4189E-03

150.00	8.1797E-05	1.5966E-02	3.4066E-04	1.2301E-03
140.00	7.0386E-05	1.5714E-02	3.0891E-04	1.0206E-03
130.00	5.8462E-05	1.5425E-02	2.7901E-04	7.9418E-04
120.00	4.6026E-05	1.5097E-02	2.5095E-04	5.5913E-04
110.00	3.3078E-05	1.4733E-02	2.2474E-04	3.3045E-04

100.00	1.9617E-05	1.4331E-02	2.0038E-04	1.3402E-04
90.00	5.6443E-06	1.3891E-02	1.7786E-04	1.2894E-05
80.00	-3.8409E-06	1.3414E-02	1.5719E-04	3.7068E-05
70.00	-2.3839E-05	1.2899E-02	1.3837E-04	3.1838E-04
60.00	-3.9348E-05	1.2347E-02	1.2139E-04	1.0330E-03

MARLOW INDUSTRIES

DATE 12:09:78

Table 18

SAMPLE NAME	SER #	FILE #	DATA POINTS	DATE TESTED
XN008	13.0	14.0	12.12	11:17:78/08:14

SO,KO,RO	S1,K1,R1	S2,K2,R2	A,K,R,Z	D,C,V
-5.1643E-05	-5.2514E-07	4.9999E-10	164.185	48.7533
3.4656E-02	-8.8404E-05	9.9959E-08	17.131	-43.8167
6.9721E-05	2.1446E-06	3.2573E-09	10.063	-0.0950
			1.564	

TEMP K	ALPHA (V/DEG C)	KAPPA (W/CM*DEG C)	RHO (OHM/CM)	Z (/DEG K)
400.00	-1.6170E-04	1.5288E-02	1.4487E-03	1.4906E-03
390.00	-1.8040E-04	1.5382E-02	1.4016E-03	1.5095E-03
380.00	-1.7900E-04	1.5497E-02	1.3550E-03	1.5258E-03
370.00	-1.7749E-04	1.5631E-02	1.3091E-03	1.5395E-03
360.00	-1.7589E-04	1.5785E-02	1.2639E-03	1.5507E-03
350.00	-1.7419E-04	1.5960E-02	1.2194E-03	1.5592E-03
340.00	-1.7239E-04	1.6154E-02	1.1754E-03	1.5651E-03
330.00	-1.7049E-04	1.6368E-02	1.1322E-03	1.5685E-03
320.00	-1.6849E-04	1.6603E-02	1.0895E-03	1.5693E-03
310.00	-1.6639E-04	1.6857E-02	1.0476E-03	1.5677E-03
300.00	-1.6418E-04	1.7131E-02	1.0063E-03	1.5637E-03
290.00	-1.6188E-04	1.7426E-02	9.6559E-04	1.5575E-03
280.00	-1.5948E-04	1.7740E-02	9.2558E-04	1.5490E-03
270.00	-1.5698E-04	1.8074E-02	8.8622E-04	1.5385E-03
260.00	-1.5438E-04	1.8428E-02	8.4751E-04	1.5260E-03
250.00	-1.5168E-04	1.8803E-02	8.0945E-04	1.5116E-03
240.00	-1.4888E-04	1.9197E-02	7.7205E-04	1.4955E-03
230.00	-1.4598E-04	1.9611E-02	7.3529E-04	1.4777E-03
220.00	-1.4297E-04	2.0045E-02	6.9919E-04	1.4585E-03
210.00	-1.3987E-04	2.0500E-02	6.6373E-04	1.4379E-03
200.00	-1.3667E-04	2.0974E-02	6.2893E-04	1.4160E-03
190.00	-1.3337E-04	2.1468E-02	5.9478E-04	1.3930E-03
180.00	-1.2997E-04	2.1982E-02	5.6129E-04	1.3690E-03
170.00	-1.2647E-04	2.2516E-02	5.2844E-04	1.3442E-03
160.00	-1.2287E-04	2.3071E-02	4.9624E-04	1.3186E-03
150.00	-1.1916E-04	2.3645E-02	4.6470E-04	1.2924E-03
140.00	-1.1536E-04	2.4239E-02	4.3381E-04	1.2657E-03
130.00	-1.1146E-04	2.4853E-02	4.0357E-04	1.2387E-03
120.00	-1.0746E-04	2.5487E-02	3.7398E-04	1.2115E-03
110.00	-1.0336E-04	2.6141E-02	3.4504E-04	1.1844E-03
100.00	-9.9157E-05	2.6815E-02	3.1675E-04	1.1576E-03
90.00	-9.4855E-05	2.7509E-02	2.8912E-04	1.1313E-03
80.00	-9.0454E-05	2.8224E-02	2.6214E-04	1.1059E-03
70.00	-8.5953E-05	2.8958E-02	2.3580E-04	1.0819E-03
60.00	-8.1351E-05	2.9712E-02	2.1012E-04	1.0601E-03

Figure 1

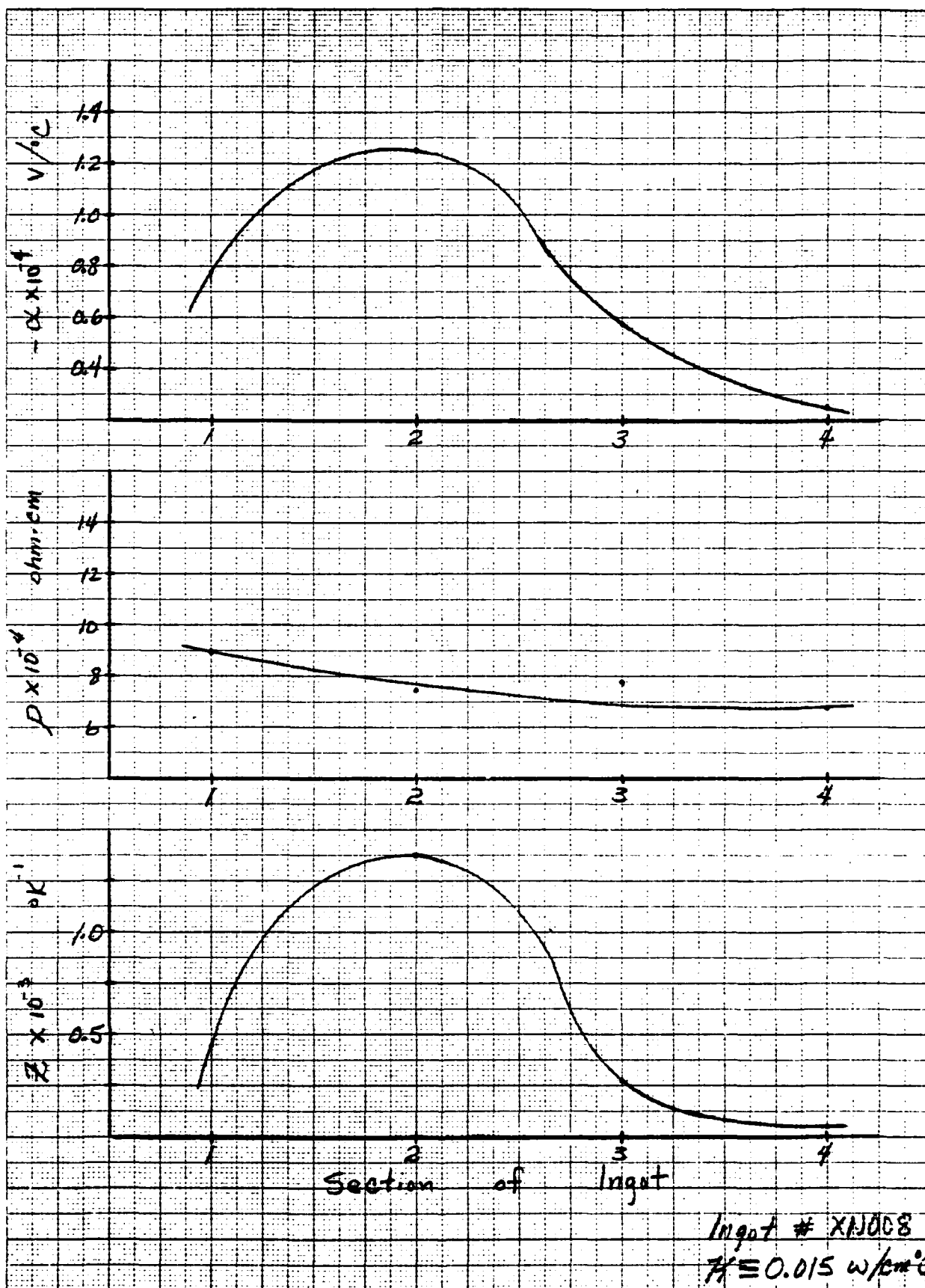


Figure 2

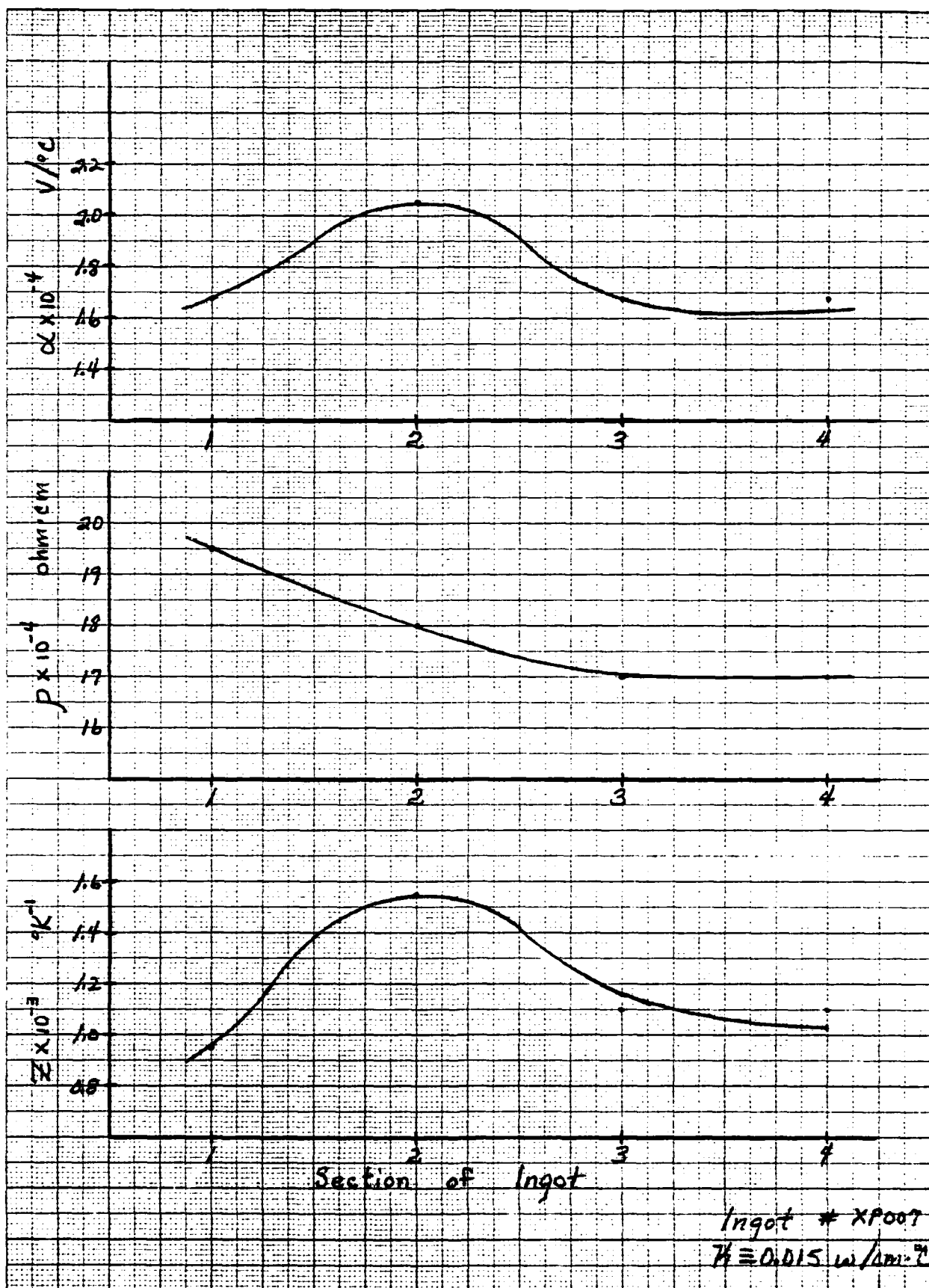


Figure 3

10 Millimeters to the Centimeter

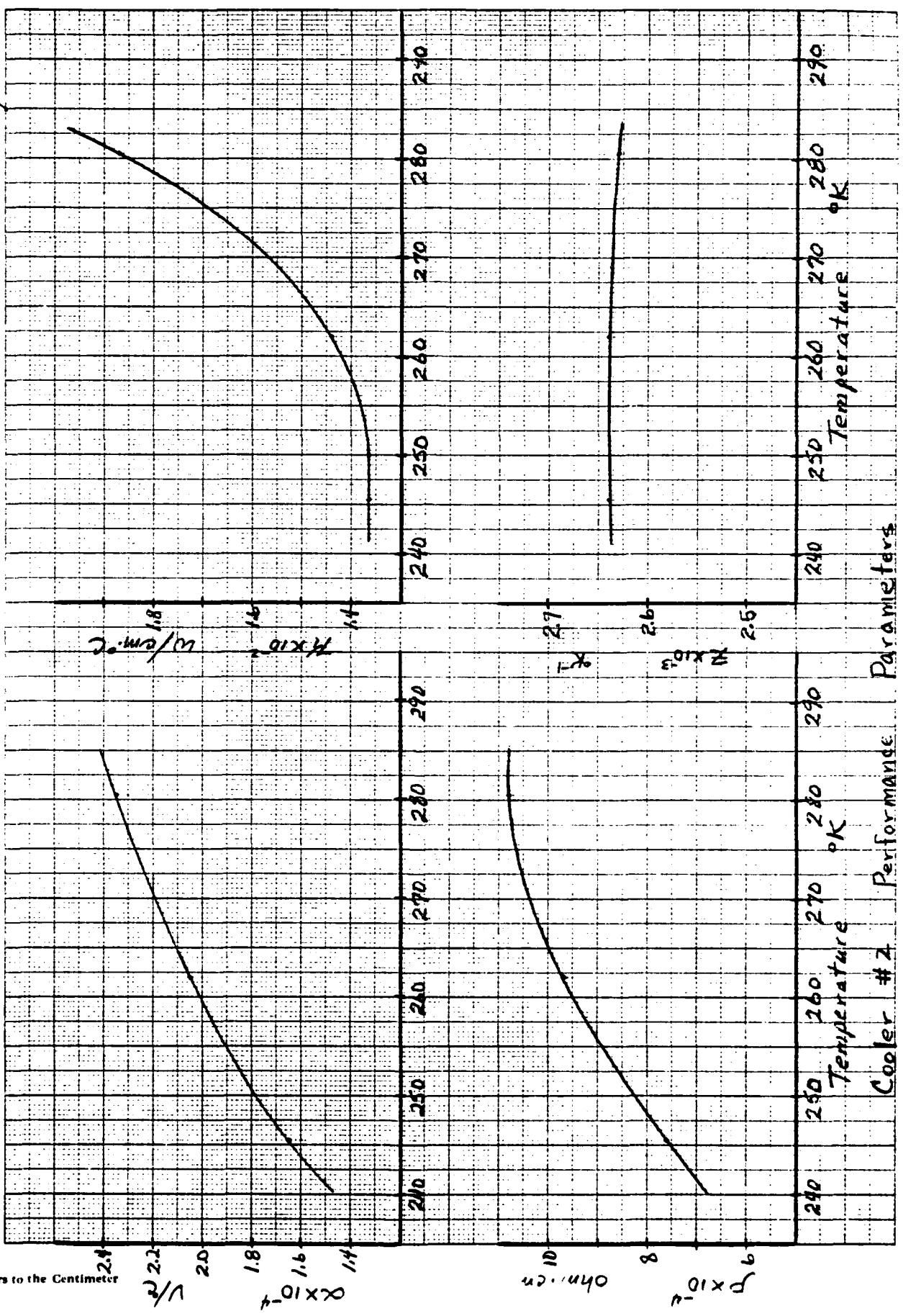


Figure 1

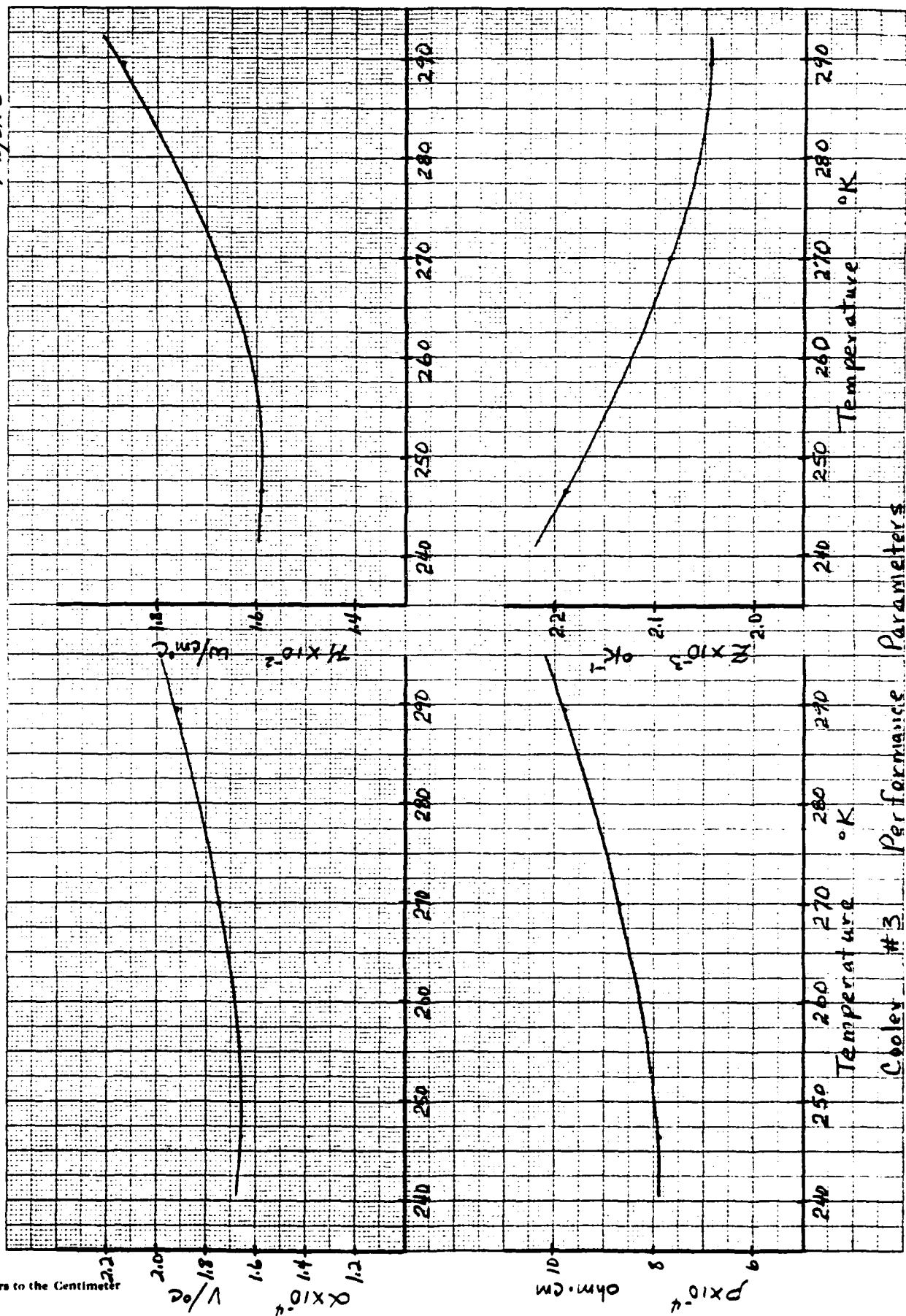


Figure 5

10 Millimeters to the Centimeter

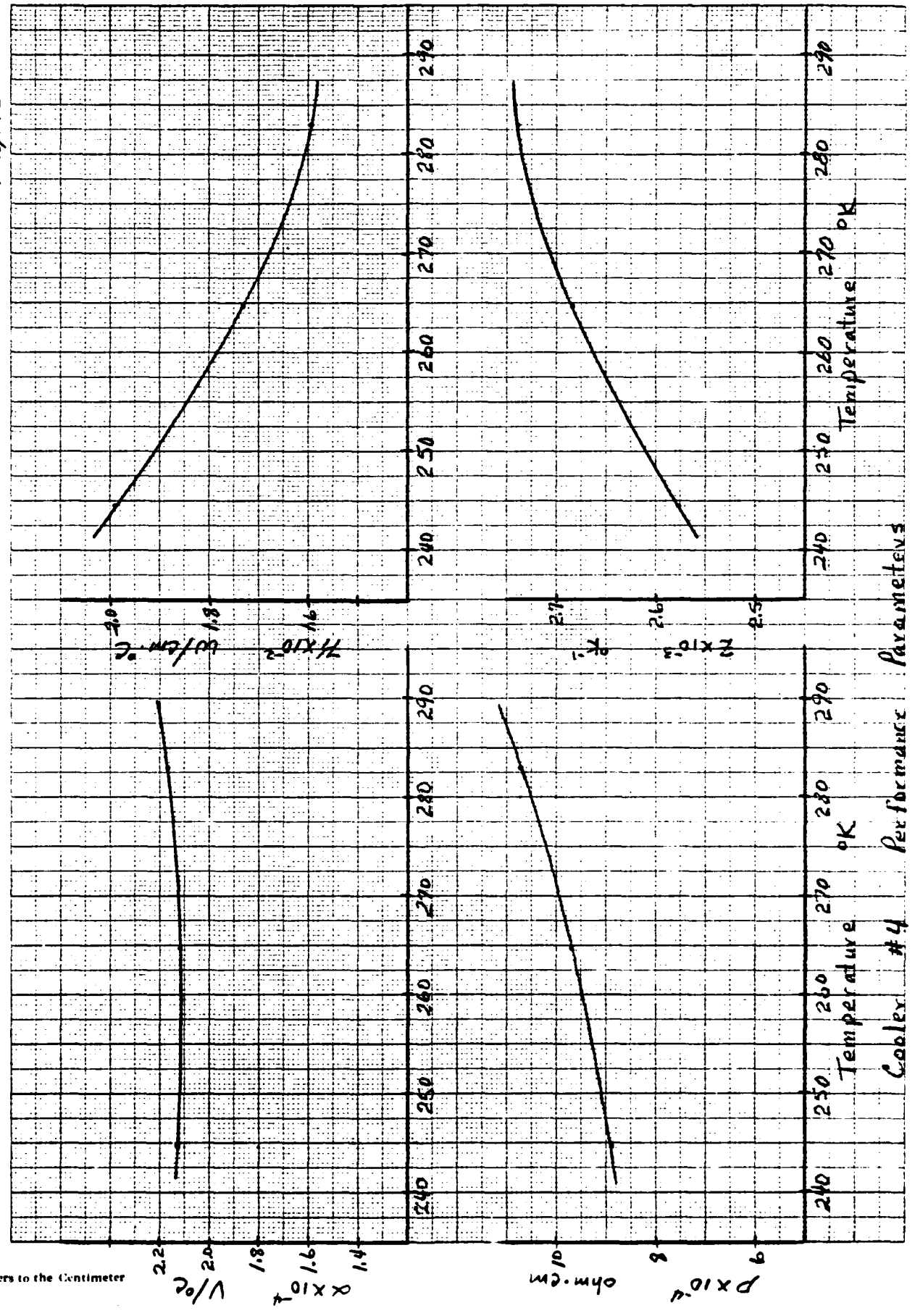


Figure 6

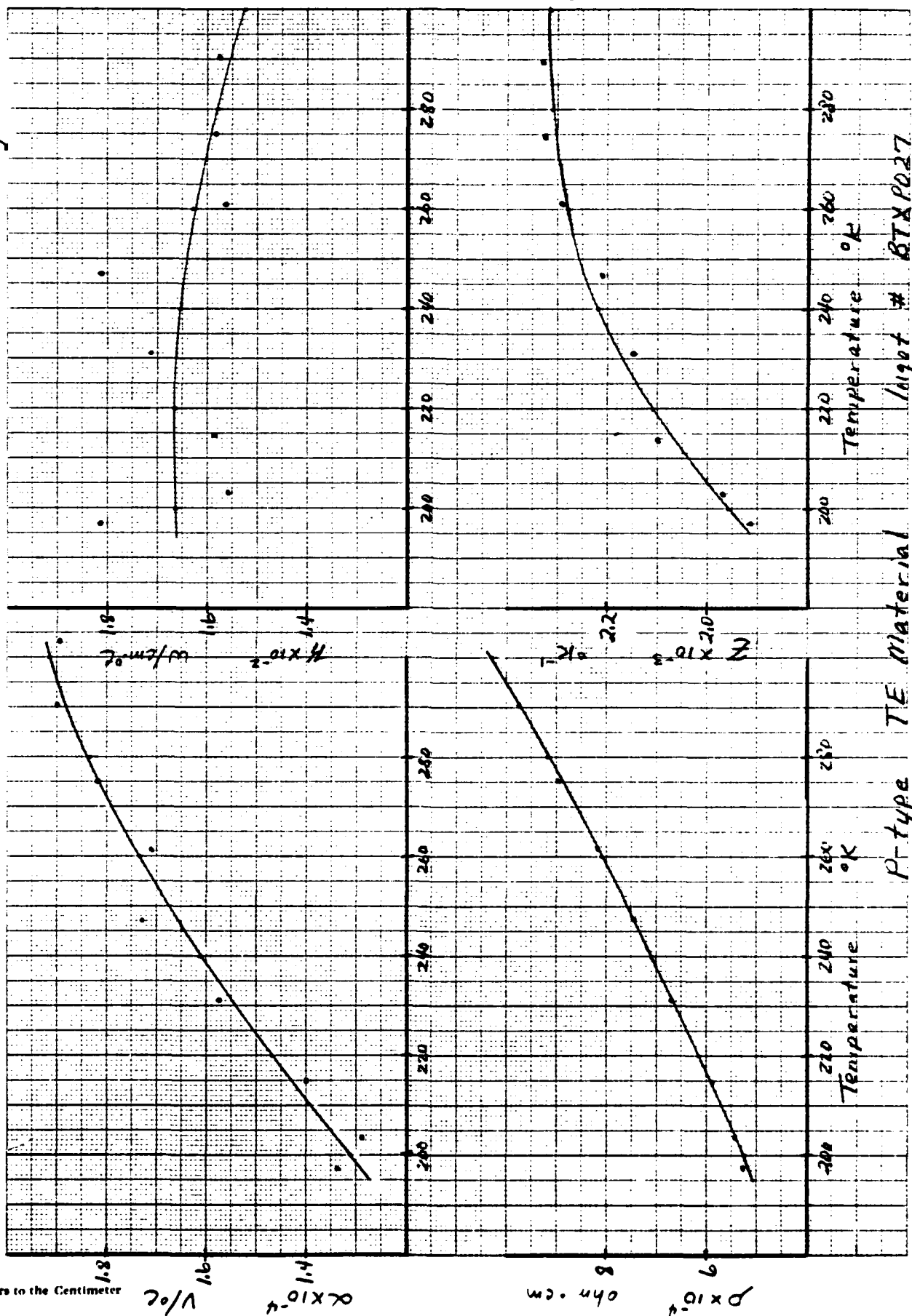
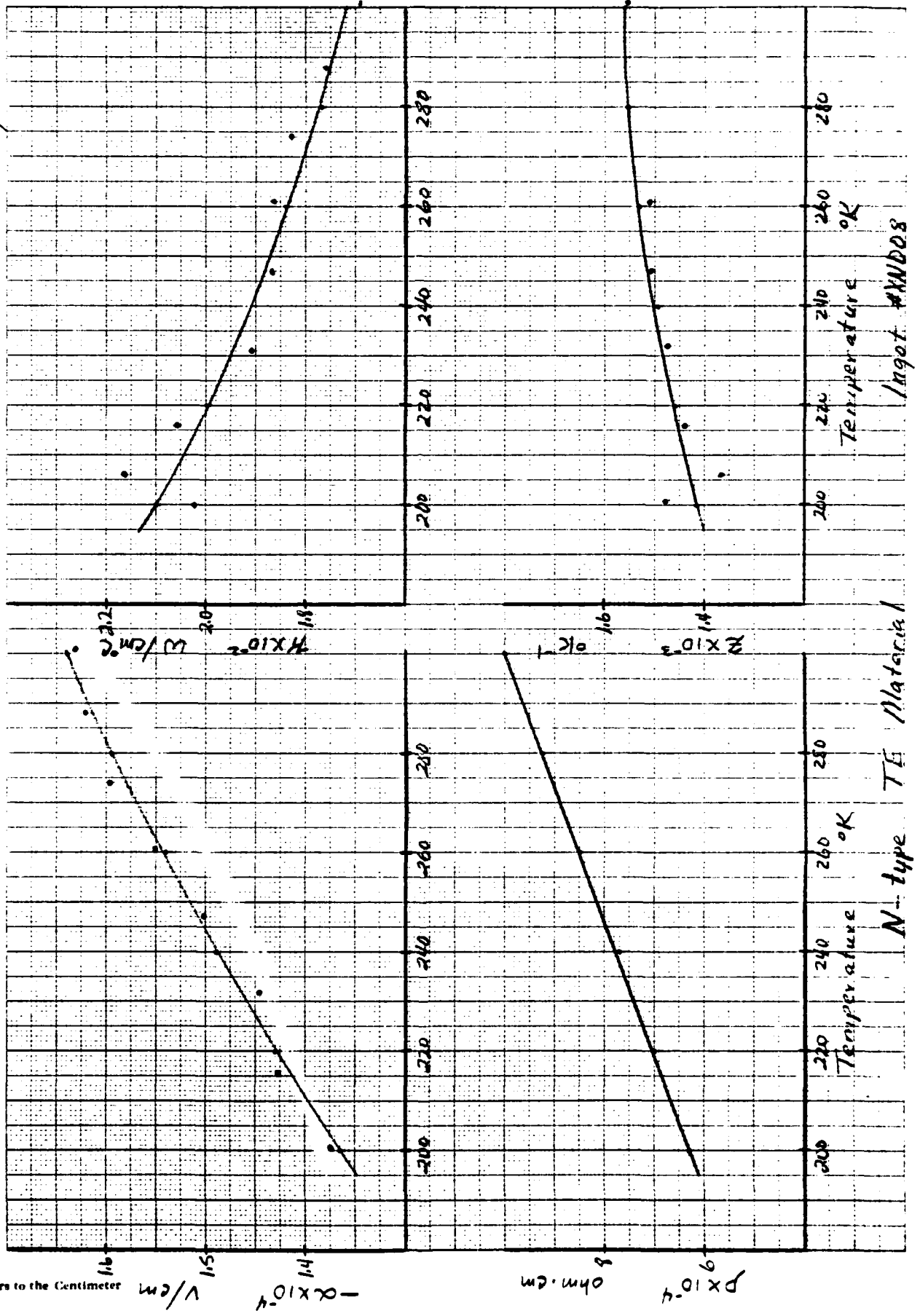
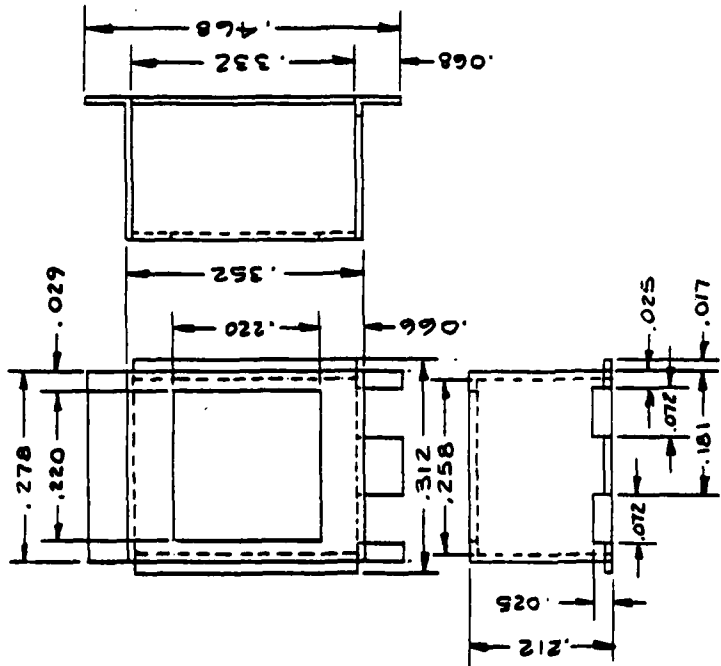


Figure 1



10 Millimeters to the Centimeter



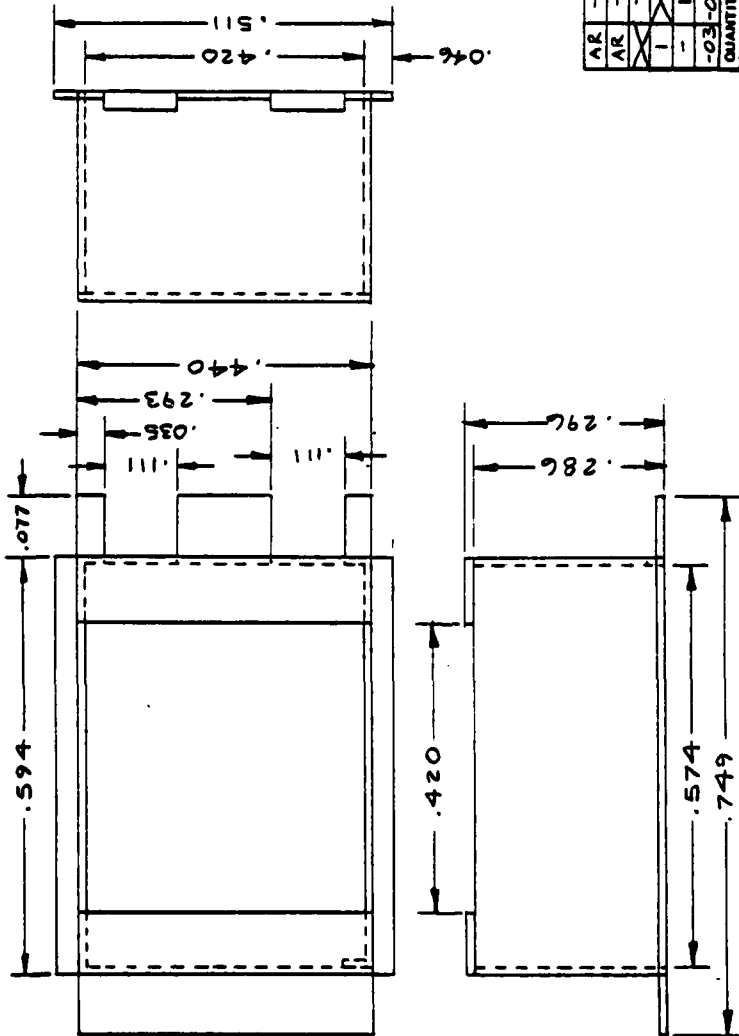
NOTES

1. FABRICATE PART FROM POLISHED COPPER, .010 THK.
2. FINISH : 25 MICRO INCH GOLD PLATE.
3. AFTER GOLD PLATING SOLDER ALL SEAMS FROM INSIDE PART, USING ITEMS 1 & 2.

	ITEM	PART OR IDENTIFYING NO.	DESCRIPTION
AR -	-	1781-05	FLUX
AR -	-	1260-07	SOLDER
AR -	-	2798-03	PART AS SHOWN
I -	X	2798-02	PART W/FINISH
-	-	2798-01	PART MACHINED
-R3	-02	-001	NOMENCLATURE OR DESCRIPTION

[illegible]

REVISIONS		
LTR	DESCRIPTION	DATE
A	CHG PER ECN 0098, MATL: AUM: M	1/5/74
		APPROVED
		88



NOTES:

1. FABRICATE PART FROM POLISHED COPPER, .010 THK.
2. FINISH: 25 MICRO INCHS GOLD PLATE.
3. AFTER GOLD PLATING SOLDER ALL SEAMS FROM THE INSIDE OF PART, USING ITEMS 1 & 2.

AR	2	1781-05	FLUX
AR	1	1260-07	SOLDER
1	1	2800-03	PART, AS SHOWN
1	1	2800-02	PART, -01 W/ FINISH
1	1	2800-01	PART, MACHINED
03-02-01	1		PART OR IDENTIFYING NO.
QUANTITY REQ	ITEM	CODE IDENT NO.	NOMENCLATURE OR DESCRIPTION

LIST OF MATERIALS OR PARTS LIST	
MARLOW INDUSTRIES, INC. 1021 S JUPITER RD., GARLAND, TEXAS 75042, 214-944 2371	
SHIELD SP 1104	
SIZE B 55686	SCALE A
QUANTITY REQ 2800	SHEET 1 OF 1

NEXT ASSEMBLY 2803	USED ON SP 1104
UNLESS OTHERWISE SPECIFIED TOLERANCES: PLACE DEC 3 PLACE DEC 3, 0005 ANGLES: 10° 30° 45° 60° 75° 90° 105° 120° 135° 150° 165° 180° HOLE TOLERANCE PER AND HOLE: 10° 30° 45° 60° 75° 90° 105° 120° 135° 150° 165° 180° SURFACE FINISH: 100 MICRO INCHES MAX MATERIAL: 25 MICRO INCHES GOLD PLATE FINISH: 25 MICRO INCHES GOLD PLATE ALL DIM. IN INCHES UNLESS NOTED OTHERWISE ALL DIM. IN MILLIMETERS UNLESS NOTED OTHERWISE DIM. IN PARENTHESIS ARE FOR REFERENCE ONLY DIM. IN SQUARE BRACKETS ARE FOR REFERENCE ONLY DIM. IN CIRCLES ARE FOR REFERENCE ONLY DIM. IN TRIANGLES ARE FOR REFERENCE ONLY DIM. IN DIAMOND SHAPES ARE FOR REFERENCE ONLY DIM. IN OVALS ARE FOR REFERENCE ONLY DIM. IN PARALLELOGRAMS ARE FOR REFERENCE ONLY DIM. IN RECTANGLES ARE FOR REFERENCE ONLY DIM. IN TRAPEZOIDES ARE FOR REFERENCE ONLY DIM. IN KITES ARE FOR REFERENCE ONLY DIM. IN CIRCLES ARE FOR REFERENCE ONLY DIM. IN TRIANGLES ARE FOR REFERENCE ONLY DIM. IN DIAMOND SHAPES ARE FOR REFERENCE ONLY DIM. IN OVALS ARE FOR REFERENCE ONLY DIM. IN PARALLELOGRAMS ARE FOR REFERENCE ONLY DIM. IN RECTANGLES ARE FOR REFERENCE ONLY DIM. IN TRAPEZOIDES ARE FOR REFERENCE ONLY DIM. IN KITES ARE FOR REFERENCE ONLY	

RELEASED

MM 89 829

UNLESS OTHERWISE SPECIFIED

TOLERANCES ON

3 PLACE DEC

2.52

3 PLACE DEC

2.50

ANGLES

MACHINED

20° 15'

FORMED

21°

SHEARED

20° 30'

HOLE TOLERANCE PER AND 10087

SURFACE ROUGHNESS PER USAS-845.1 125

MACHINED SURFACE FINISH

DIMENSIONING & TOLERANCING PER USAS-Y14.5

ECCENTRICITY BETWEEN ANY DIA(S) ON THE

SAME CENTERLINE SHALL NOT EXCEED .010

TOTAL INDICATOR READING

ALL DIM IN INCHES & INCLUDE APPLIED FINISH

WELD SYMBOLS PER USAS-Y32.3

RIVET CODE PER NAS 623

THREADS PER MIL-S-7742

MARK PER MIL-STD-130

REMOVE ALL BURRS AND SHARP EDGES

REVISIONS

LTR

DESCRIPTION

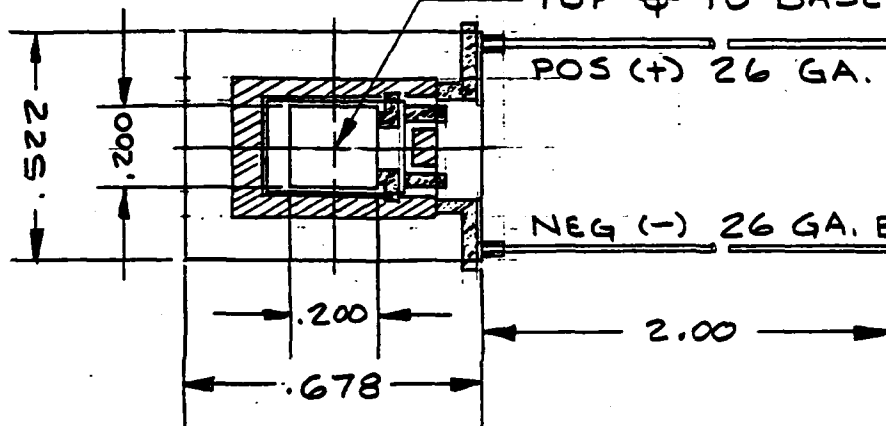
DATE

APPROVED

TOP ϕ TO BASE .015 TIR

POS (+) 26 GA. BUSS

NEG (-) 26 GA. BUSS



// A .005

.470

A \square .005

QTY REQD	ITEM	CODE IDENT NO.	PART OR IDENTIFYING NO.	NOMENCLATURE OR DESCRIPTION
----------	------	----------------	-------------------------	-----------------------------

NEXT ASSY	USED ON	DESIGNED BY	DATE
		APPR'D BY	12-11-77
		CK'D BY	
		DRN'G BY	M. NEWLAND 11-22-77
		DESIGN BY	

MARLOW INDUSTRIES, INC.

1021 JUPITER RD. GARLAND, TEXAS 75042, 214-494-2521

PRODUCT SPECIFICATION
SP 1102SIZE
A CODE IDENT #
55686SCALE:
2.5:1

REV.

SHEET
1 of 4

RELEASED

MAR 30 1979

2761

AD-A083 225

MARLOW INDUSTRIES INC GARLAND TEX
HIGH EFFICIENCY, LOW POWER THERMOELECTRIC COOLERS. (U)
1979

F/G 13/1

DAAK70-78-C-0016

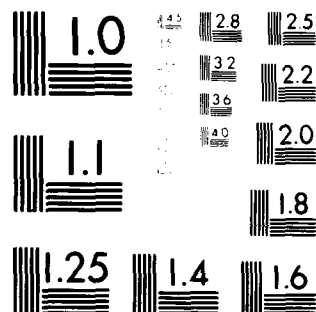
NL

UNCLASSIFIED

2 19 2

AD-A083 225

END
DATE
FILMED
5-80
DTIC



MICROCOPY RESOLUTION TEST CHART
NATIONAL BUREAU OF STANDARDS-1963-A

MATERIAL LIST

-05	-04	-03	-02	-01	ITEM	PART NUMBER	DESCRIPTION
				X		2761-01	COOLER, SP1102
				1	1	2791-01	CERAMIC, BASE
				1	2	2792-01	CERAMIC, 2ND
				1	3	2764-01	CERAMIC, 3RD
				1	4	2765-01	CERAMIC, 4TH
				1	5	2766-01	CERAMIC, TOP
				211	6	1181-02	TAB
				14	7	1826-02	TAB, SPECIAL
				106	8	2789-01	ELEMENT 'P'
				106	9	2789-02	ELEMENT 'N'
				AR	10	1260-07	SOLDER, 138°C
				AR	11	1781-01	FLUX, ELEM ASSY
				AR	12	1781-06	FLUX, TINNING
				AR	13	1774-03	WIRE, BUSS, 26 GA
				1	14	2336-02	MATRIX, 1ST STG
				1	15	2337-02	MATRIX, 2ND STG
				1	16	2338-02	MATRIX, 3RD STG
				1	17	2793-02	MATRIX, 4TH STG

NOTES:

1. FABRICATE PER ASSY. PROCESS 1823
2. TEST PER TEST PROC. 1486 REF TEST SPEC.
3. INSPECT PER WORKMANSHIP STD'S. 1023

TEST SPEC:

AT TEST:

I =

V =

TH =

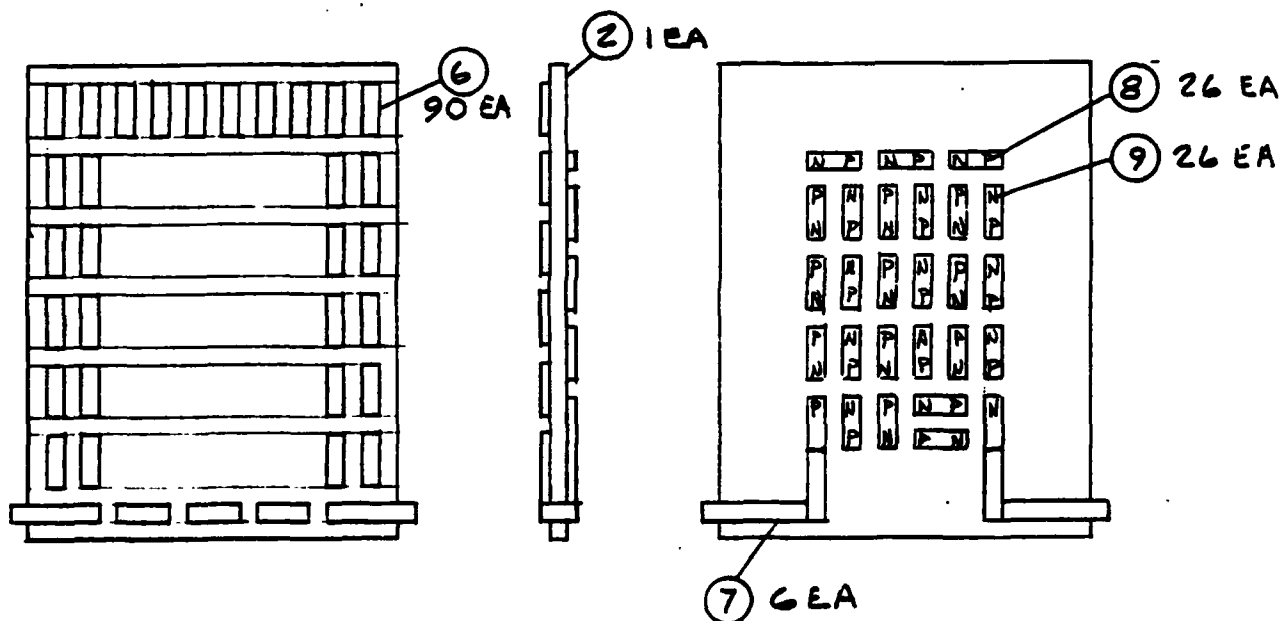
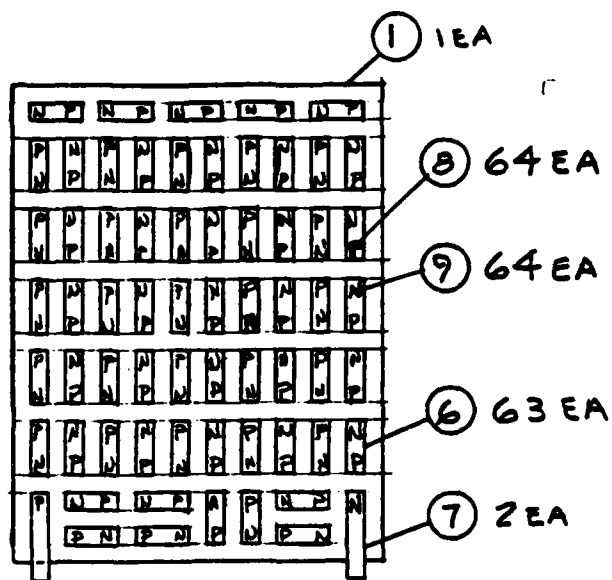
TC =

A.C. RESIST:

HI-POT TEST:

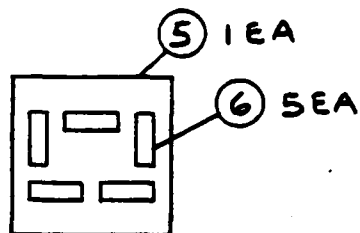
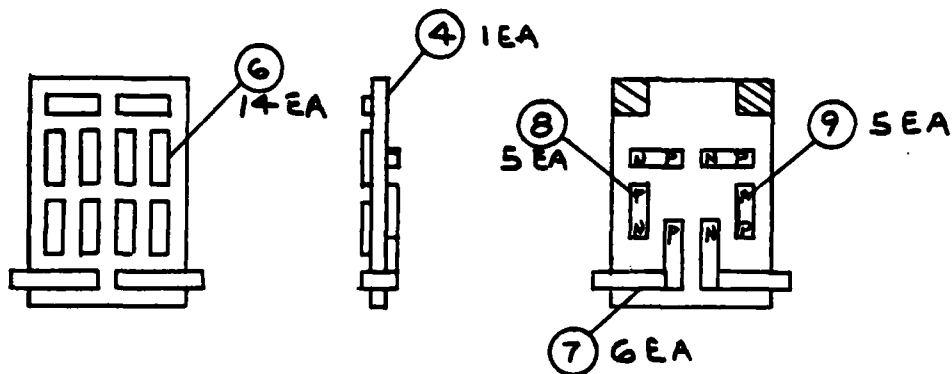
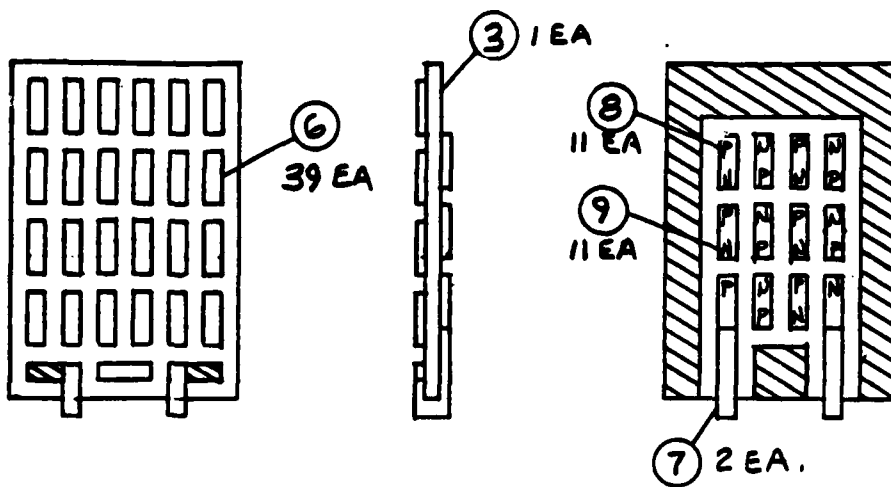
SP 1102

SIZE A	CODE IDENT # 55688	2761
SCALE: N/A	REV.	SHEET 2 OF 4



SP1102

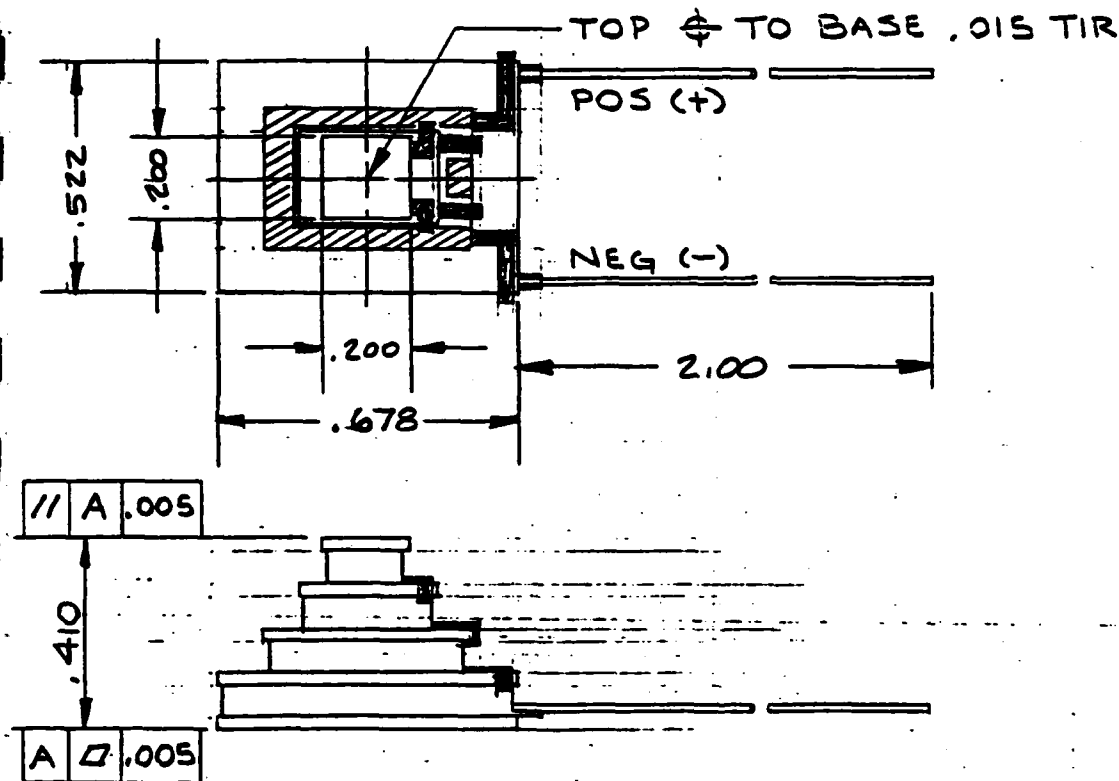
SIZE	CODE IDENT #	2761	
A	55688		
SCALE:	NONE	REV.	SHEET 3 OF 4



SP 1102

SIZE	CODE IDENT #		
A	55688	2761	
SCALE:	NONE	REV.	SHEET 4 of 4

UNLESS OTHERWISE SPECIFIED			REVISIONS			
TOLERANCES ON: 3 PLACE DEC 2.07 3 PLACE DEC 2.07 ANGLES MACHINED FORMED SHEARED 20° 15° 21° 20° 30° HOLE TOLERANCE PER AND 10087 SURFACE ROUGHNESS PER USAS-46.1 125 MACHINED SURFACE FINISH DIMENSIONING & TOLERANCING PER USAS-V14.6 ECCENTRICITY BETWEEN ANY DIA/ON THE SAME CENTERLINE SHALL NOT EXCEED .010 TOTAL INDICATOR READING ALL DIA IN INCHES & INCLUDE APPLIED FINISH WELD SYMBOLS PER USAS-V32.3 RIVET CODE PER NAS 623 THREADS PER MIL-S-7742 MARK PER MIL-STD-130 REMOVE ALL BURRS AND SHARP EDGES			LTR	DESCRIPTION	DATE	APPROVED
			A	CHK DIM .522 TO .678 ECN 0088	1-17-79	<i>[Signature]</i>



NEXT ASSY		USED ON		QTY REQD	ITEM	CODE IDENT NO.	PART OR IDENTIFYING NO.	NOMENCLATURE OR DESCRIPTION
							MARLOW INDUSTRIES, INC. 1021 JUPITER RD. GARLAND, TEXAS 75042, 214-494-2521	
							PRODUCT SPECIFICATION SP 1103	
							RELEASED MAR 30 1979	
							SIZE A CODE IDENT # 55686 SCALE: 2.5:1 REV. A SHEET 1 of 4	

MATERIAL LIST

	-05	-04	-03	-02	-01	ITEM	PART NUMBER	DESCRIPTION
					X		2762-01	COOLER, SP 1103
					1	1	1225-01	CERAMIC, BASE
					1	2	1228-01	CERAMIC, 2ND
					1	3	2764-01	CERAMIC, 3RD
					1	4	2765-01	CERAMIC, 4TH
					1	5	2766-01	CERAMIC, TOP
					211	6	1181-02	TAB
					14	7	1826-02	TAB, SPECIAL
					106	8	1990-01	ELEMENT 'P'
					106	9	1990-02	ELEMENT 'N'
					AR	10	1260-07	SOLDER, 138°C
					AR	11	1781-01	FLUX, ELEM ASSY
					AR	12	1781-06	FLUX, TINNING
					AR	13	1774-03	WIRE, BUSS, 26 GA
					1	14	1825-02	MATRIX, 1ST STG
					1	15	1828-02	MATRIX, 2ND STG
					1	16	1828-02	MATRIX, 3RD STG
					1	17	2795-02	MATRIX, 4TH STG

NOTES:

1. FABRICATE PER ASSY. PROCESS 1823
2. TEST PER TEST PROC. 1486 REF TEST SPEC.
3. INSPECT PER WORKMANSHIP STD'S. 1023

TEST SPEC:

ΔT TEST:

I =

V =

TH =

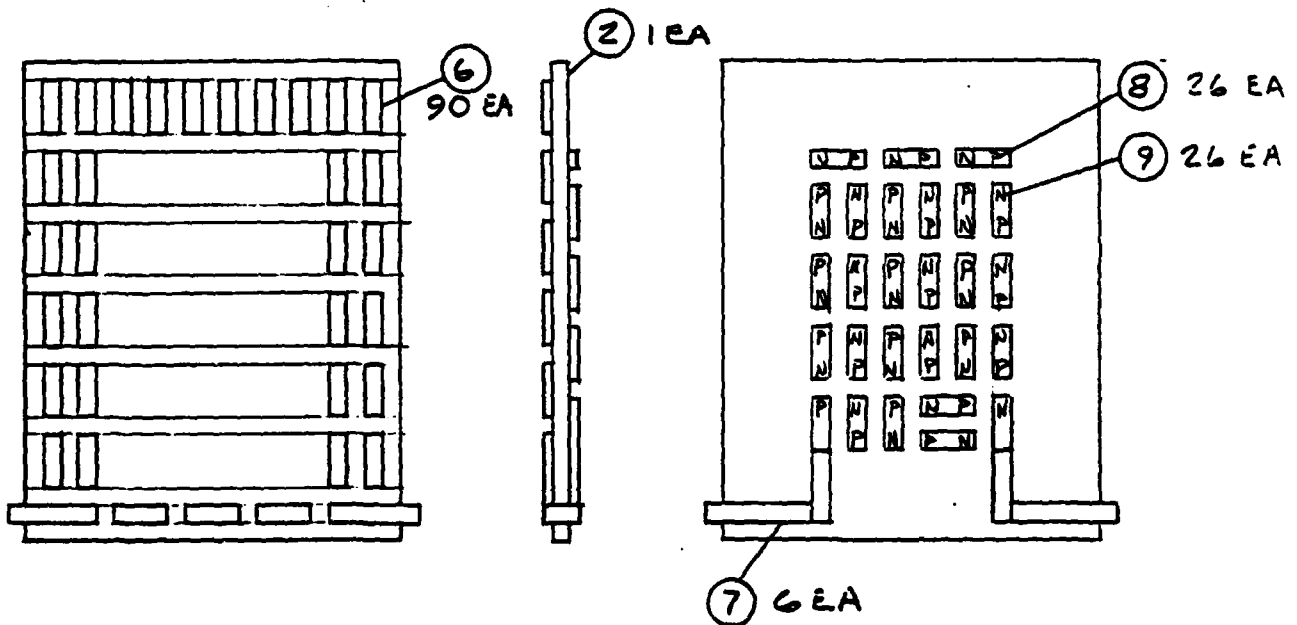
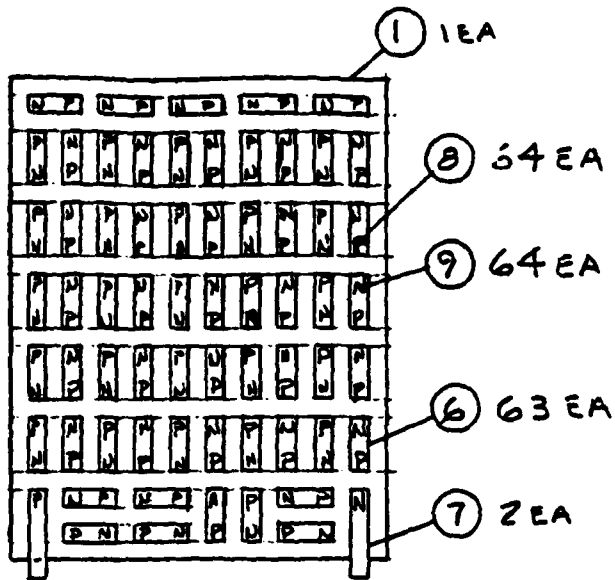
TC =

A.C. RESIST:

HI-POT TEST:

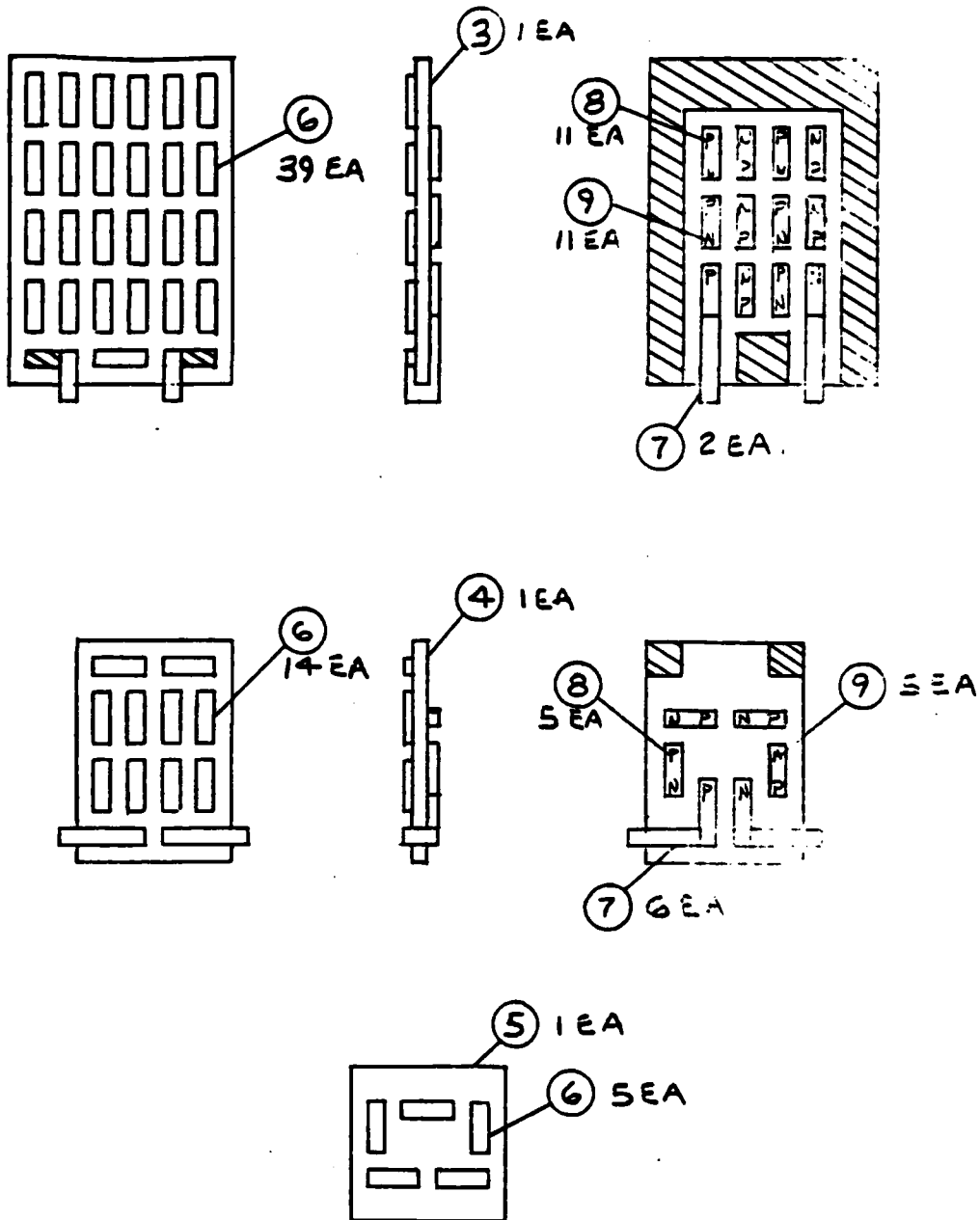
SP 1103

SIZE	CODE IDENT #	
A	55688	2762
SCALE:	N/A	REV. A
		SHEET 2 OF 4



SP1103

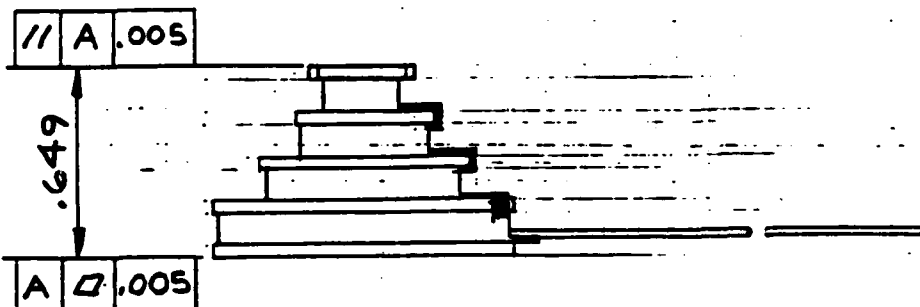
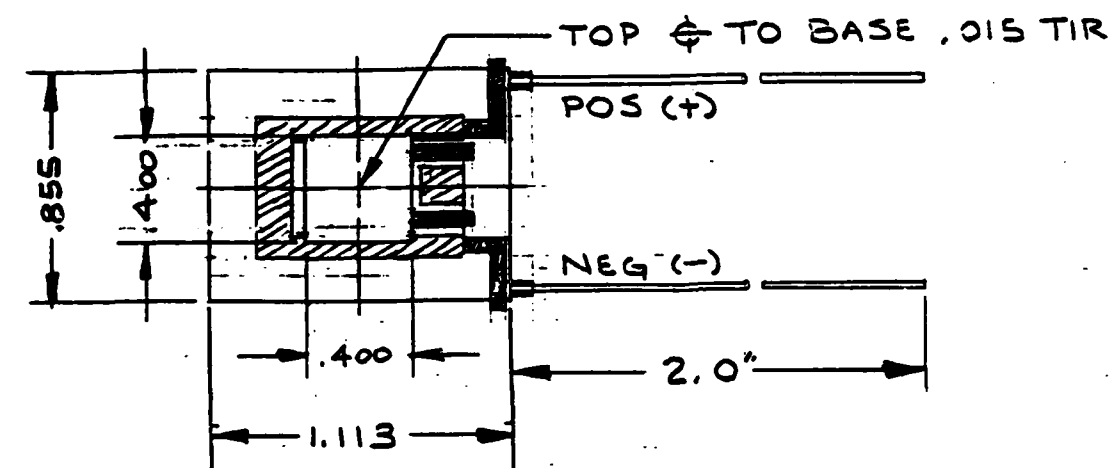
SIZE	CODE IDENT #		
A	55686	2762	
SCALE: NONE	REV. A	SHEET	3 of 4



SP 1103

SIZE	CODE IDENT #	2762	
A	55688		
SCALE	NONE	REV: A	SHEET: 4 OF 4

UNLESS OTHERWISE SPECIFIED		REVISIONS			
		LTR	DESCRIPTION	DATE	APPROVED
TOLERANCES ON: 3 PLACE DEC 3 PLACE DEC 2.00 2.010 ANGLES MACHINED FORMED SHEARED 10° 10' 2.1° 20° 30'		A	CHG PER GCN 0075	1/9/79	DB
HOLE TOLERANCE PER ANSI 100B7 SURFACE ROUGHNESS PER UNAS-945.1 125 MACHINED SURFACE FINISH ✓ DIMENSIONING & TOLERANCING PER UNAS-V14.6 ECCENTRICITY BETWEEN ANY DIAGON THE SAME CENTERLINE SHALL NOT EXCEED .010 TOTAL INDICATOR READINGS ALL DIM. IN INCHES & INCLUDE APPLIED FINISH					
WELD SYMBOLS PER UNAS-V32.3 RIVET CODES PER UNAS-823 THREADS PER MIL-S-7742 MARKS PER MIL-STD-130 REMOVE ALL BURRS AND SHARP EDGES					

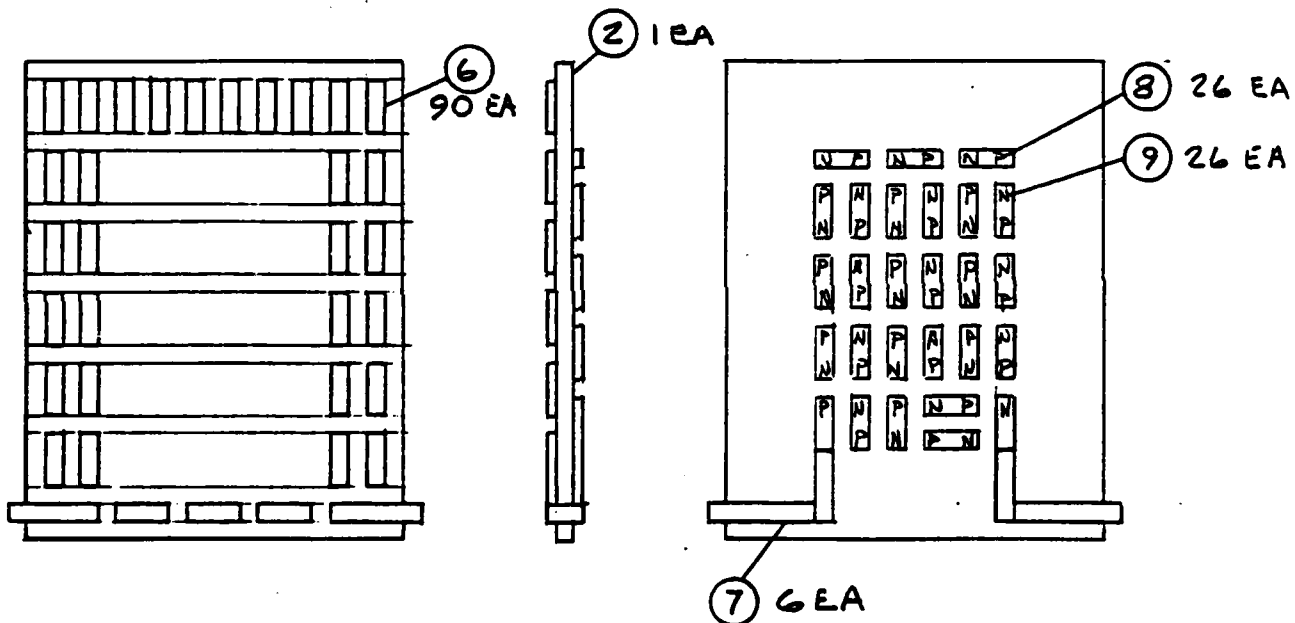
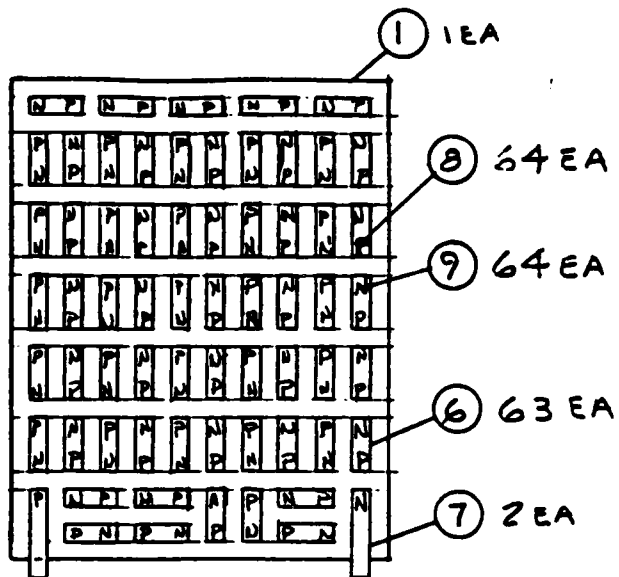


		QTY REQD		ITEM	CODE IDENT NO.	PART OR IDENTIFYING NO.	NOMENCLATURE OR DESCRIPTION
NEXT ASSY	USED ON						
		APPR BY	J	2-11-77			
		CHK BY					
		DRY BY	M NEWLAND	11-28-78			
		DESIGN BY					
RELEASED				SIZE A	CODE IDENT # 55686	2763	
MAR 30 1979				SCALE: NONE	REV. A	SHEET 1 OF 4	

MATERIAL LIST							
-05	-04	-03	-02	-01	ITEM	PART NUMBER	DESCRIPTION
				X		2763-01	COOLER, SP1104
				1	1	1126-01	CERAMIC, BASE
				1	2	1127-01	CERAMIC, 2ND
				1	3	2776-01	CERAMIC, 3RD
				1	4	2777-01	CERAMIC, 4TH
				1	5	2778-01	CERAMIC, TOP
				215	6	1009-02	TAB
				12	7	1111-02	TAB, SPECIAL
				106	8	2790-01	ELEMENT 'P'
				106	9	2790-02	ELEMENT 'N'
				AR	10	1260-07	SOLDER, 138°C
				AR	11	1781-01	FLUX, ELEM ASSY
				AR	12	1781-06	FLUX, TINNING
				AR	13	1774-04	WIRE, BUSS 26 GA.
				1	14	2796-02	MATRIX.

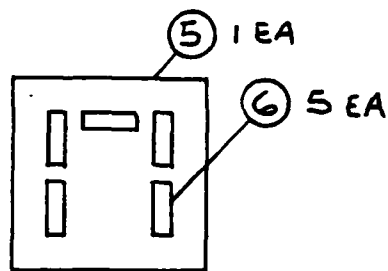
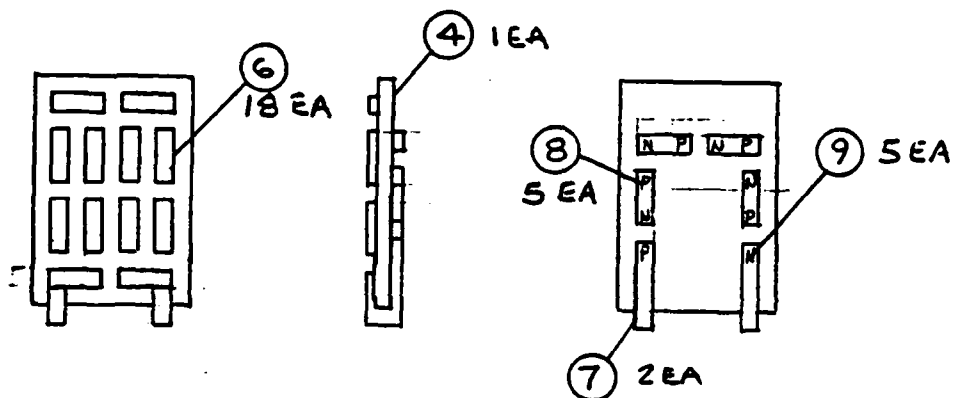
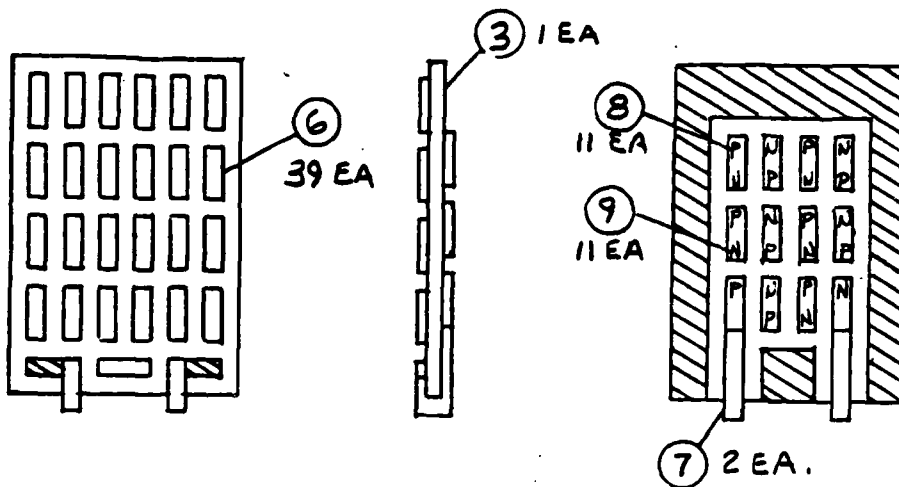
1. FABRICATE PER ASSY. PROCESS 1823
2. TEST PER TEST PROC. 1486 REF TEST SPEC.
3. INSPECT PER WORKMANSHIP STD'S. 1023

SIZE A	CODE IDENT # 55688	2763	
SCALE: N/A		REV. A	SHEET 2 of 4



SP1104

SIZE	CODE IDENT #	2763	
A	55688		
SCALE:	NONE	REV. A	SHEET 3 OF 4



SP 1104

SIZE	CODE IDENT #	2763	
A	55688		
SCALE:	NONE	REV. A	SHEET 4 of 4

UNLESS OTHERWISE SPECIFIED		REVISIONS			
		LTR	DESCRIPTION	DATE	APPROVED
TOLERANCES ON 2 PLACE DEC 3 PLACE DEC ± .02 ± .010 ANGLES MACHINED FORMED SHEARED ± 0° 15' ± 1° ± 0° 30'					
HOLE TOLERANCE PER ANSI 11.1 SURFACE ROUGHNESS PER MIL-STD-113 MACHINED SURFACE FINISH DIMENSIONING & TOLERANCING PER ASME Y14.5 ECCENTRICITY BETWEEN ANY DIAMETER ON THE SAME CENTRAL LINE SHALL NOT EXCEED .010 TOTAL INDICATOR READING ALL DIM. IN INCHES & INCLUDE APPLIED FINISH WELD SYMBOLS PER ASME Y32.3 RIVET CODE PER NAS 623 THREADS PER MIL-STD-20 MARK PER MIL-STD-130 REMOVE ALL BURRS AND SHARP EDGES					

OPERATIONAL AND ENVIRONMENTAL TEST PROCEDURE

NEXT ASS'Y		USED ON		QTY REQD	ITEM	CODE IDENT NO.	PART OR IDENTIFYING NO.	NOMENCLATURE OR DESCRIPTION
								MARLOW INDUSTRIES, INC. 1021 JUPITER RD. GARLAND, TEXAS 75042, 214-494-2521 <div style="text-align: center; font-size: 2em;">PRELIMINARY</div>
				SIZE A	CODE IDENT # 55686	2898		
				SCALE:	REV.	SHEET 1 OF 7		

OPERATIONAL AND ENVIRONMENTAL TEST PROCEDURE

SP 1102, SP 1103, SP 1104

- 1.0 The purposes of the test procedure are to determine the internal and external performance characteristics of the three types of coolers designed and fabricated under this program and to conduct environmental testing of these coolers which were designed for operation in rugged environmental conditions.
- 2.0 Electrical Performance Testing
 - 2.1 Mounting Cooler(s)
 - 2.1.1 Mount the cooler(s) to be tested on a copper test base using 96°C solder (MI Dwg. No. 1260-05) and Alpha 200L flux (MI Dwg. No. 1781-06).
 - 2.1.2 Attach the power leads to the test base terminals using 138°C solder, MI Dwg. No. 1260-07 and Alpha 200L flux MI Dwg. No. 1781-06.
 - 2.1.3 Mount a .001" Cu-constantan thermocouple on the top surface of the cooler using the solder and flux referenced in Section 2.1 above. Attach the thermocouple leads to the test terminals using the same materials.
 - 2.1.4 Mount a .003" Cu-constantan thermocouple on the test base adjacent to the cooler base and attach the leads to the test base terminals using the same materials referenced in Section 2.1.2.
 - 2.1.5 Thoroughly rinse the cooler-test base (CTB) assembly in hot water (60°C) and dry with compressed air.
 - 2.2 AC Resistance/Hy-Pot Testing
 - 2.2.1 Measure the AC Resistance of the cooler and record the reading on the traveler.

- 2.2.2 Measure the Hy-Pot resistance from the leads to the test base (>100 megohms at 500 volts).
- 2.3 Thermal Performance Test
 - 2.3.1 Mount the cooler-test base (CTB) assembly(s) on a cooler test jig per MI Dwg. No. 2248 and connect the power and thermocouple leads to the CTB terminals.
 - 2.3.2 Mount the cooler test jig on the test console and mount the heat exchanger on the cooler test jig.
 - 2.3.3 Connect the power thermocouple electrical plug, turn ON the vacuum system and set CTB temperature at $25 \pm 2^{\circ}\text{C}$.
 - 2.3.4 Turn ON power to cooler and set the input voltage of the first test cooler to $6.00 \pm .01$ volts.
 - 2.3.5 Allow the cooler cold plate temperature to stabilize and record the following data on the traveler:
 - a. Serial number of cooler assembly
 - b. Base temperature ($25 \pm 2^{\circ}\text{C}$)
 - c. Cold side temperature
 - d. Input voltage
 - e. Input current
 - f. Vacuum ($<10^{-4}$ torr)
 - 2.3.6 Repeat steps 2.3.4 and 2.3.5 for all cooler assemblies on test jig.
 - 2.3.7 Turn OFF power supply, allow vacuum chamber to reach atmosphere pressure, disconnect electrical plug and remove cooler test base (CTB) assemblies from test jig.
- 3.0 VIBRATION AND SHOCK TESTS
 - 3.1 Mount the CTB assemblies on the shock and vibration test adapter plate.
 - 3.2 Bolt the adapter plate to the vibration test stand.

- 3.3 Attach an acceleration sensor to the adapter plate.
- 3.4 Perform the vibration test under the following conditions:
- Frequency Range - 10 - 300 Hz
 - Amplitude - 2.5g peak
 - Sweep Rate - Logarithmic sweep from 10 Hz to 3000Hz and back to 10 Hz within a 30-minute period
 - Axes - 3 orthogonal, one sweep per minute
- 3.5 Remove the adapter plate from the vibration test stand and bolt to the shock test stand.
- 3.6 Perform the mechanical shock test under the following conditions
- No. of impacts - 6 in each direction and amplitude
 - Axes - 3 orthogonal, both directions
 - Amplitudes - half sine wave pulses, of 500 g's peak value with a duration of 1.0 millisecond measured between the 10% values of peak amplitude. Half sine wave pulses of 140 ± 10 g's peak value with a duration of 9 milliseconds $\pm 10\%$.
- 3.7 Remove the adapter plate from the vibration test stand and remove the CTB assemblies from the adapter plate.
- 4.0 THERMAL PERFORMANCE TEST
- 4.1 Repeat Section 2.3 above.
- 5.0 HIGH TEMPERATURE TESTS
- 5.1 Place the CTB assemblies in an oven with the temperature stabilized at 85°C and allow to remain for 48 hours.
- 5.2 Remove from the oven and repeat Section 2.3 for each cooler.

6.0 LOW TEMPERATURE TEST

- 6.1 Select one CTB assembly of each type and mount the assembly in a test vacuum chamber, ST 1018 Modified.
- 6.2 Connect power and thermocouple leads to the CTB assembly.
- 6.3 Coat the O-ring gasket for the test vacuum chamber with a thin layer of vacuum grease, install in annular groove and mount the cover on the test vacuum chamber.
- 6.4 Place the test vacuum chamber in a cold chamber, exhaust the system and back fill with argon.
- 6.5 Stabilize the cold chamber at -60°C and allow to remain for 24 hours.
- 6.6 Raise the cold chamber temperature to -40°C and evacuate the test chamber.
- 6.7 Turn ON the power supplies to the cooler and adjust for proper values.
- 6.8 As soon as operating conditions stabilize, read and record T_H , T_c , I_n , and V .
- 6.9 Turn OFF power and vacuum and remove test vacuum chamber from cold chamber.
- 6.10 Remove CTB assembly(s) from test vacuum chamber(s).

7.0 TEMPERATURE SHOCK TESTS

- 7.1 Stabilize oven temperature at 70°C and cold chamber temperature at -60°C .
- 7.2 Place CTB assemblies in cold chamber and allow to remain for four hours.
- 7.3 Remove assemblies from cold chamber, place in oven within five minutes and allow to remain for four hours.
- 7.4 Remove assemblies from oven and place in cold chamber within five minutes.
- 7.5 Repeat steps 7.2 and 7.3 for a total of three cycles.
- 7.6 Remove CTB assemblies from oven and repeat Section 2.3 for each cooler.

8.0 TE COOLER TESTS

8.1 COP Tests

8.1.1 Take two CTB assemblies of each type of cooler and mount a heat load resistor on the cold plate of each cooler.

8.1.2 Mount a .001" Cu-constantan thermocouple on a metallized pad on each of the intermediate ceramics of one cooler of each type and attach voltage measurement leads to each stage of the cooler.

8.1.3 Mount one of the CTB assemblies from Section 8.1.2 on a vacuum test fixture and connect the power, voltage and thermocouple leads from the CTB terminals to the test fixture feed throughs.

8.1.4 Attach the heat exchanger to the vacuum test fixture and mount the assembly on the test console.

8.1.5 Connect the power, voltage and thermocouple leads from the test fixture to the test equipment and attach the temperature controller water lines to the heat exchanger.

8.1.6 Turn ON the vacuum system and set the CTB base temperature at $25 \pm 2^{\circ}\text{C}$.

8.1.7 Set the cooler power voltage at $6.00 \pm .01$ volts and the resistor heat load at the nominal value.

8.1.8 Turn ON the power supply and allow the cooler cold plate temperature to stabilize.

8.1.9 Measure and record the following data:

- a. Base temperature
- b. Temperature for each intermediate stage
- c. Cold side temperature
- d. Input Voltage
- e. Voltage for each stage
- f. Input current
- g. Heat load

- 8.1.10 Set the resistor heat load at zero and repeat Sections 8.8 and 8.9.
- 8.1.11 Set the resistor heat load to 200% of nominal value and repeat Sections 8.8 and 8.9.
- 8.1.12 Turn OFF power supplies, disconnect leads, remove vacuum and remove test fixture from test console.
- 8.1.13 Repeat Sections 8.1.3 to 8.1.12 for each of the other two cooler types.
- 8.2 Cooler characteristics with heat load
 - 8.2.1 Mount a CTB assembly with heat load resistor on a vacuum test fixture and connect the power and thermocouple leads from the CTB terminals to the test fixture feed throughs.
 - 8.2.2 Attach the heat exchanger to the vacuum test fixture and mount the assembly on the test console.
 - 8.2.3 Connect the power and thermocouple leads from the test fixture to the test equipment and attach the temperature controller water lines to the heat exchanger.
 - 8.2.4 Turn ON the vacuum system and set the CTB base temperature at $25 \pm 2^{\circ}\text{C}$.
 - 8.2.5 Set the cooler power supply voltage at $6.00 \pm .01$ volts and resistor heat load at nominal value.
 - 8.2.6 Turn ON power supply and record time for cold plate temperature to reach 193°K .
 - 8.2.7 Allow the cooler cold plate temperature to stabilize and record the following data on the traveler.
 - a. Base temperature
 - b. Cold side temperature
 - c. Input voltage
 - d. Input current
 - e. Heat load
 - f. Vacuum ($<10^{-4}$ torr)

- 8.2.8 Set the resistor heat load at zero and repeat Section 8.9.
- 8.2.9 Set the resistor heat load to 200% of nominal value and repeat Section 8.9.
- 8.2.10 Set the resistor heat load at the nominal value and set the cooler input voltage to $1 \pm .01$ volt and repeat Section 8.9.
- 8.2.11 Increase the cooler volts in steps of 1 volts, repeating Section 8.9 at each step until the cooler cold plate temperature increases with higher voltage.
- 8.2.12 Turn OFF power supplies, allow vacuum chamber to reach atmosphere pressure, disconnect electrical connections and remove cooler test base assembly from test jig.
- 8.2.13 Repeat Section 8.2.1 to 8.2.12 for each of the other two cooler test base assemblies.
- 8.3 Cooler performance with radiation shield and heat load.
 - 8.3.1 Install the proper radiation shield on each of the test coolers used in Section 8.2.
 - 8.3.2 Perform the tests listed in Sections 8.2.1 to 8.2.8 and 8.2.12 on each of the three cooler types with the radiation shield installed.
- 8.4 Calculate radiation heat load per unit area vs. cold surface temperature.
- 9.0 INSPECTION (Q.C.)
- 9.1 Inspect per MI Workmanship Standards, Dwg. No. 1023 and the cooler Product Specification.

COMPONENT EVALUATION REPORT

☒ Cedar Rapids, Iowa
☐ Dallas, Texas
☐ Newport Beach, Calif.
☐ Toronto, Ontario

DATE RECEIVED 4-26-78		DATE COMPLETED 4-28-78	PURPOSE OF TEST	COLLINS PART NOS. None	REV. _____
REPORT WRITTEN BY A. C. Walker <i>A.C. Walker</i>		ENGINEERING INFORMATION		TR NO.	
REPORT APPROVED BY B. T. Ward <i>B.T. Ward</i>		MANUFACTURER QUALIFICATION		ET #805028	
TEST REQUESTED BY Marlow, Ind.		PRODUCTION LOT ACCEPTANCE		PART NAME Cooler Assy.	
NO. OF SAMPLES One (1)		ADDITIONAL SOURCE		MFG'R & CODE IDENT NO.	
MFG'R DATE CODE Unk.		X OTHER Contract		Marlow, Ind.	
		CONTRACT NO. PO#3309		MFG'RS PART NO.	
		EP 36-2014		UNK.	

SUMMARY OF RESULTS

Test No.	Name of Test or Environment	No. Tested	No. Failed	Remarks
1.	Vibration	1	0	
2.	Shock	1	0	


APPROVAL STATUS

COMPONENT APPLICATION ENGINEERING		REFERENCE:	
<input type="checkbox"/> APPROVED <input type="checkbox"/> DISAPPROVED <input type="checkbox"/> ENGINEERING INFO <input type="checkbox"/> PENDING		P.O. #3309	
CAL STATUS		EQUIPMENT CHECKOUT: <input type="checkbox"/> APPROVED	
		<input checked="" type="checkbox"/> NOT REQ'D <input type="checkbox"/> DISAPPROVED	
REMARKS		PROJ ENGR SIGNATURE	
		DATE	
		QUALITY INSPECTION ACCEPTABLE	
		Q.A. ENGR SIGNATURE	
COMP. APPL. ENGINEER		DATE	
MILITARY/CUSTOMER WITNESS (IF REQUIRED)		DATE	
		PAGE 1 OF 4 PAGES	

074-8143-100 (12-74)

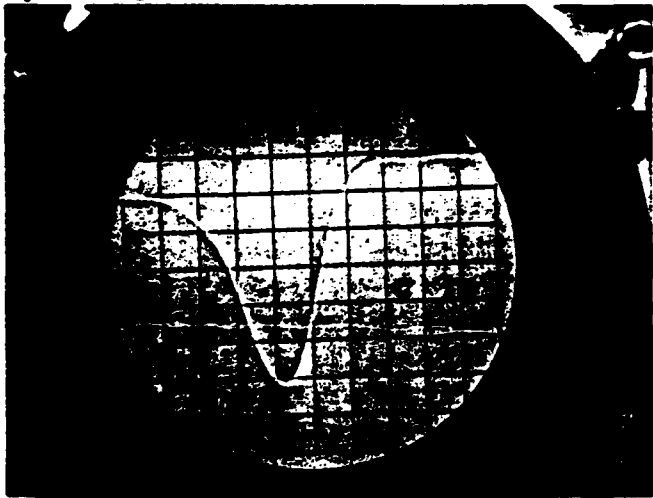
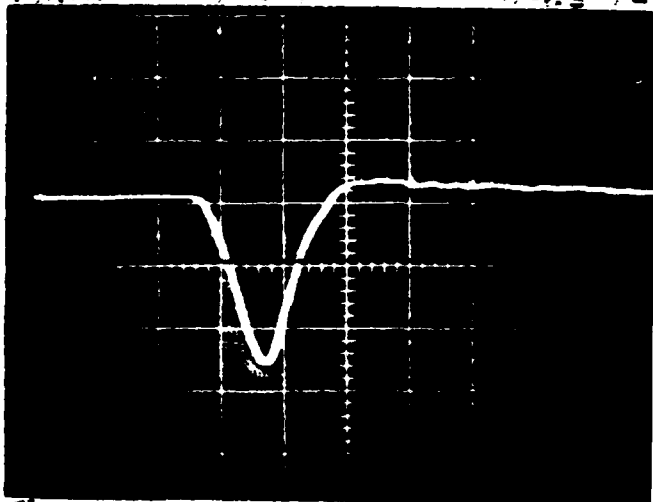
COMPONENT TEST REPORT CONTINUATION SHEET

REPORT NO ET #805028
SHEET 2 OF 4 SHEETS

ORD OF TEST	TEST PERFORMED	NO IN TEST	NO OF DISC	REMARKS OR TYPE OF DISCREPANCY
1.	Vibration: As per MIL-STD-810C; Method 514.2, except frequency range is 10 to 3500 hertz with a constant 2.5G input. Scanning speed is up and back down in the above mentioned frequency range in twenty (20) minutes. Nine sweeps in each of two axes, (vertical and major horz), for a total of eighteen (18) sweeps or six (6) hours. 	1	0	
1.1	Vibration: As in Test No. 1, except input is 0.10 inch DA or 50G's (which ever is the lesser), for a total of six (6) sweeps or two (2) hours.	1	0	

COMPONENT TEST REPORT CONTINUATION SHEET

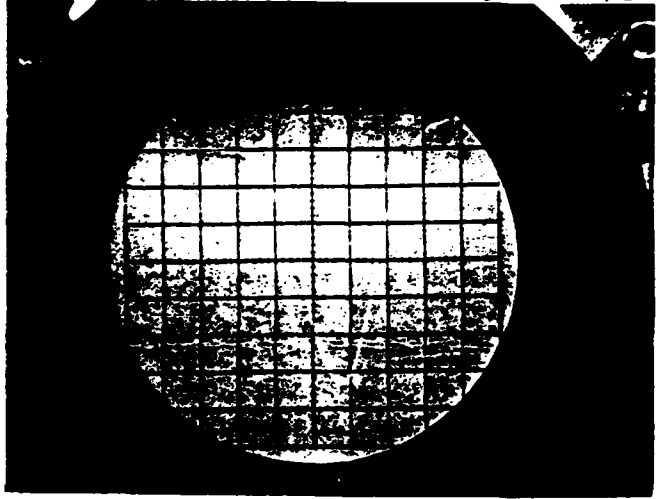
REPORT NO. ET # 805028
SHEET 3 OF 4 SHEETS

ORD OF TEST	TEST PERFORMED	NO IN TEST	NO OF DISC	REMARKS OR TYPE OF DISCREPANCY
2.	Shock: As per MIL-STD-883A; Method 2002.1; Test con- dition A, except number of impacts is six (6) in each direction of three (3) mutually perpendicular axes for a total of thirty (30) impacts. See shock photo under remarks.	1	0	<p>NEFLON INC. 4-27-79</p>  <p>.2 G/CM HORIZ. - 100 G/CM VERT.</p>
2.1	Shock: As per MIL-STD-810C; Method 516.2; Procedure IV; except number of im- pacts is the same as in Test number 2. See shock photo under remarks.	1	0	<p>NEFLON INC. 4-29-79</p>  <p>3 G/CM HORIZ. - 20 G/CM VERT.</p>

074-5713-300

COMPONENT TEST REPORT CONTINUATION SHEET

REPORT NO ET # 805028
SHEET 4 OF 4 SHEETS

ORD OF TEST	TEST PERFORMED	NO IN TEST	NO OF DISC	REMARKS OR TYPE OF DISCREPANCY
2.2	<p>Shock:</p> <p>As in Test No.2, except number of impacts is two (2) in each direction of three (3) mutually perpendicular axes for a total of twelve (12). See shock photo under remarks for impact level and pulse duration.</p>			<p>MARLOW IND. 4-28-79</p>  <p>1/1000 SEC. - 500 G/SEC. TEST.</p>

074-5713-300

COMPONENT EVALUATION REPORT

☐ Cedar Rapids, Iowa
☒ Dallas, Texas
☐ Newport Beach, Calif.
☐ Toronto, Ontario

DATE RECEIVED 1-23-79		DATE COMPLETED 1-25-79	PURPOSE OF TEST	COLLINS PART NOS None	REV <u> </u>
REPORT WRITTEN BY A. C. Walker		ENGINEERING INFORMATION		TR NO ET #901013	
REPORT APPROVED BY B. T. Ward		MANUFACTURER QUALIFICATION		PART NAME Cooler	
TEST REQUESTED BY Marlow Ind		PRODUCTION LOT ACCEPTANCE		MFG'R & CODE IDENT NO. Marlow Ind.	
NO. OF SAMPLES 15 (5 ea. PN)		ADDITIONAL SOURCE		MFG'RS PART NO. SP 1102/1103/1104	
MFG'R DATE CODE NONE		CONTRACT NO. PO # 4300			
		EP 36-2014			

SUMMARY OF RESULTS

Test Number	Name of Test or Environment	Number Tested	Number Failed	Remarks
1	Vibration	15	--	
2	Shock	15	--	

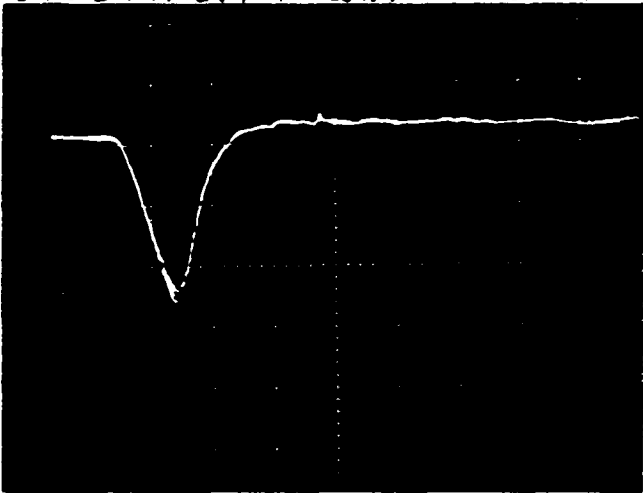
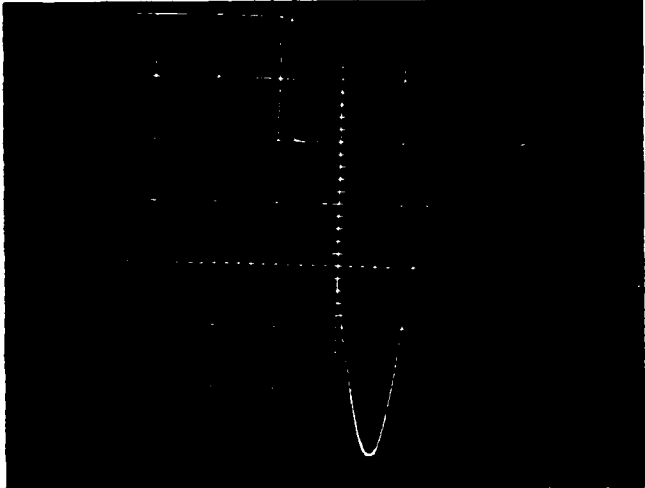
APPROVAL STATUS

COMPONENT APPLICATION ENGINEERING		REFERENCE:	
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CAL STATUS	IDEP	EQUIPMENT CHECKOUT: <input type="checkbox"/> APPROVED	
REMARKS		<input checked="" type="checkbox"/> NOT REQ'D <input type="checkbox"/> DISAPPROVED PROJ ENGR SIGNATURE DATE	
		QUALITY INSPECTION ACCEPTABLE	
		Q.A. ENGR SIGNATURE	
COMP. APPL. ENGINEER	DATE		
MILITARY/CUSTOMER WITNESS (IF REQUIRED)	DATE		
		PAGE 1 OF 2 PAGES	

074-8143-100 (12-74)

COMPONENT TEST REPORT CONTINUATION SHEET

REPORT NO FT #901013SHEET 2 OF 2 SHEETS

ORD OF TEST	TEST PERFORMED	NO IN TEST	NO OF DISC	REMARKS OR TYPE OF DISCREPANCY
1.	Vibration: Input Level is a constant 2.5 G's. Frequency Range is 10 to 3000 Hertz. 30 minutes in each of three mutually perpendicular planes for a total of 90 minutes per Marlow instructions.	15	-	
2.	Mechanical Shock: as per Marlow Instructions, Para., 3.6 (See Calibration Photo in Remarks Column).	15	-	<p>CALIBRATION (MARLOW) 1-23-79</p>  <p>5MS/CM HORIZ. 50G/CM VERT.</p>
2.1	Mechanical Shock: As Per Marlow Instructions, Para., 3.6 (See Calibration Photo in Remarks Column).	15	-	<p>CALIBRATION (MARLOW) 1-25-79</p>  <p>5MS/CM HORIZ. 100G/CM VERT.</p>

074-5713-300

Drawing No. 2454

THERMOELECTRIC MATERIAL GROWTH PROCEDURE

1.0 Scope

The following describes the procedure to be followed to produce thermoelectric material in the form of rods 12.5 millimeters in diameter.

2.0 References

2.1 The following process, tests, and control documents are included in this specification by reference.

Drawing 1454 - Wafers - Procedure for sawing

Drawing 1455 - Elements - Procedure for dicing

Drawing MI 1060 - Product Specification

Drawing 1486 - Procedure for testing thermoelectric coolers

Drawing 1110 - Diffusion Barrier - Procedure for coating thermoelectric material.

3.0 Procedures

3.1 Cleaning of quartz tubes.

3.1.1 Caution: Gloves must be worn when using hydrofluoric acid

3.1.2 Prepare a cleaning solution of 10% hydrofluoric acid and deionized water by volume, and carefully pour the solution in the squirt bottle labeled 10% HF.

3.1.3 While rotating the quartz tube, pour a portion of the 10% HF through the tube for several revolutions.

3.1.4 Rinse the tube for approximately 2 minutes with deionized water.

- 3.1.4 Dry the tube with the HG - 501 Heater.
- 3.2 Preparing quartz tube.
- 3.2.1 Caution: Protective dark glasses must be worn when using the torch.
- 3.2.2 Fasten hydrogen-oxygen torch to bench. Light and adjust flame. Light hydrogen first, then add oxygen as needed.
- 3.2.3 Heat the center of the quartz tube by rotating the tube over the flame.
- 3.2.4 As the quartz gets soft, simultaneously twist and gently pull the two sections of the tube apart so that there are two tubes with sealed ends.
- 3.2.5 With the torch, form each tube so that the walls converge to form a 30° angle at the tip.
- 3.2.6 Allow tube to cool to room temperature.
- 3.3 Measure material and place in tube.
- 3.3.1 Select a sequential ingot serial number, starting with XP000 for p-type material or XN000 for n-type material, and all material growth data or comments or traveler 2454-01.
- 3.3.2 The amount of each raw material, in grams, required for each type of material is listed below.*

	P-Type	N-Type
Bismuth	15.70	48.47
Tellurium	55.79	46.86
Antimony	27.44	3.14
Selenium	1.04	1.53

*Typical Composition

- 3.3.3 Turn ON the Model 1202 Sartories Balance and turn OFF the laminar flow vent hood. Use weighing paper during all weighing operations.
- 3.3.4 Attach the quartz tube to the tube stand and fit the special funnel on the top of tube.

- 3.3.5 The raw material should be added to the tube in the order; dopant, selenium, antimony, tellurium, and then bismuth.
- 3.3.6 Weigh out the pre-specified amount of the raw material and then carefully transfer the material to the quartz tube. Record all required data on traveler 2454-01.
- 3.4 Evacuate tube and seal.
 - 3.4.1 Remove tube from weighing station and attach tube to the vacuum station with O-ring and compression seal.
 - 3.4.2 Evacuate tube.
 - 3.4.3 Close off vacuum valve after thirty minutes.
 - 3.4.4 With the torch, carefully melt the contents of the tube to compact the material into the bottom of the tube.
 - 3.4.5 After the material has solidified, re-evacuate the tube for at least 30 min.
 - 3.4.6 When the tube of material is cool enough to hold with the hand, close vacuum valve and use the torch to seal the tube about 2 inches above the top of the material. Seal the tube in the same manner as in step 3.2.4.
 - 3.4.7 After sealing, inspect the tube and material for cracks or abnormalities. Record all required data on traveler 2454-01.
- 3.5 Alloy the Ingot.
 - 3.5.1 Set the rocker furnace temperature at 625°C and set the rocker speed at 15-20 cycles per minute.
 - 3.5.2 When the oven is at equilibrium, place the tube in the oven and allow to rock for 2 hours. Record all data on traveler 2454-01.
 - 3.5.3 Turn OFF the rocker motor and quickly remove the ingot from the oven. Lay the tube on the asbestos sheet in the horizontal position.
- 3.6 Grow Crystal.

- 3.6.1 Place the sealed ingot in the ingot holder and attach the ingot holder to the crystal drive arm.
- 3.6.2 Set the furnace temperature so that it is just above the hot zone of the furnace.
- 3.6.3 Lower the ingot into the furnace so that it is just above the hot zone of the furnace.
- 3.6.4 Place covers around the top of the furnace.
- 3.6.5 With the motor control switch at 28* on the dial, place the directional switch in the down position.
- 3.6.6 Check all thermocouple connections for proper connections with the chart recorder.
- 3.6.7 Let the ingot slowly drop through the furnace undisturbed until the temperature of the ingot is below 500°C. This will take approximately 48 hours.
- 3.6.8 Record all required data on traveler 2454-01.
- 3.7 Remove ingot and record weight.
 - 3.7.1 Remove ingot by detaching ingot holder from crystal drive arm and remove holder from furnace.
 - 3.7.2 Remove ingot from tube by breaking glass with pliers.
 - 3.7.3 Weigh the ingot on the balance and record data on traveler 2454-01.
- 3.8 Calculate Resistivity (ρ) and Seebeck Coefficient (α).
 - 3.8.1 Attach the alligator clips to the current leads of the Keithly 503 HC milliohmmeter to the ends of the ingot. Attach voltage leads to the special two point probe.
 - 3.8.2 Measure the resistance at half inch intervals down the length of the ingot. Roll the ingot 120° and repeat step 3.8.2.

*Typical setting

3.8.3 Roll the ingot another 120° and repeat step 3.8.2.

3.8.4 Calculate the average electrical resistivity by the equation:

$$\rho = RA/L$$

where

ρ is the electrical resistivity

R is the measured resistance

A is the cross sectional area

L is the distance between the probes

Record all data on traveler 2454-02.

3.8.5 With the galvanometer, check and record the value of the deflection at half inch intervals down the length of the ingot. Calibrate the galvanometer with a standard piece of p or n type thermoelectric material.

$$\alpha \text{ (std p)} = 220 \text{ Micro volts/}^{\circ}\text{C}$$

$$\alpha \text{ (std n)} = 200 \text{ Micro volts/}^{\circ}\text{C}$$

$$\frac{\text{galvanometer reading (standard)}}{220 \text{ Micro volts/}^{\circ}\text{C}} = \frac{\text{galvanometer reading}}{\alpha \text{ (sample)}}$$

3.8.6 Roll the ingot 120° and repeat step 3.8.5.

3.8.7 Roll the ingot another 120° and repeat step 3.8.5.

3.8.8 Calculate the average Seebeck Coefficient for the ingot and record all data on traveler 2454-03.

3.9 Select and cut ingot for single couple test cooler.

3.9.1 Send two ingots, one p-type and one n-type, to the saw room to be cut in 1 inch long 12 millimeter sections.

3.10 Build two element coolers using these sections.

3.10.1 Tin the ends of each section with 138°C solder, 1260-07 and zinc chloride flux 1781-01.

3.10.2 Solder the n-type section to the right side of the special two element cooler ceramic.

- 3.10.3 Solder the p-type section to the left side of the special two element cooler ceramic.
- 3.10.4 Solder the special top copper strip across the top of the two elements.
- 3.10.5 Solder a red lead wire to the n-type side of ceramic.
- 3.10.6 Solder a black lead wire to the p-type side of the ceramic.
- 3.11 Attach the current leads of the Keithly AC Milliohmeter to the leads of the cooler.
 - 3.11.2 With the voltage leads, measure and record the resistance of each element of the cooler. Clip the voltage leads to the bottom and top tabs close to the element to be measured. Record the data on traveler 2454-04.
- 3.12 Test cooler for cooling effect.
 - 3.12.1 Attach the current leads of the test station to the red and black leads of the cooler and apply maximum current to cooler.
 - 3.12.2 Attach a thermocouple to the top of the test cooler and measure cooling effect. Record all data on traveler 2454-04.
- 3.13 Wafer best section for MI 1060 coolers.
 - 3.13.1 Select the best element pair of the ingots and send to saw room for wafering per process 1454.
 - 3.13.2 Cut the ingot sections into .060 thick wafers.
- 3.14 Coat wafers.
 - 3.14.1 Coat wafer per process 1110 with the current adjusted to .3 amps for 10 wafers.
- 3.15 Dice wafers for 1060 coolers.
 - 3.15.1 Send wafers to saw room for dicing per process 1455.
 - 3.15.2 Dice the wafers into .057 X .057 inch elements.

- 3.16 Build MI 1060 coolers.
- 3.16.1 Build MI 1060 coolers per product spec MI 1060 with n and p-type elements of grown material lot.
- 3.16.2 Build MI 1060 coolers as in 3.16.1 except use p-type elements from standard stock with the elements of grown n-type.
- 3.16.3 Build MI 1060 cooler as in 3.16.1 except use n-type elements from standard stock with the elements of grown p-type.
- 3.16.4 Build an MI 1060 cooler using standard stock.
- 3.17 Test coolers for maximum cold side temperature.
- 3.17.1 Place MI 1060 coolers in vacuum housing and test per process 1486.
- 3.17.2 While holding the hot side temperature at room temperature (27°C) increase the current by one amp increments until the maximum cold side temperature is passed and record the information.
- 3.17.4 Repeat test procedure with hot side temperature at 0°C.
- 3.17.5 Repeat test procedure with hot side temperature at 50°C.
- 3.18 Analyze data.
- 3.18.1 Using the HP-67 calculator, compute the values of figure-of-merit, alpha, rho, kappa and average temperature.
- 3.18.2 Plot data for figure-of-merit, alpha, rho, and kappa.